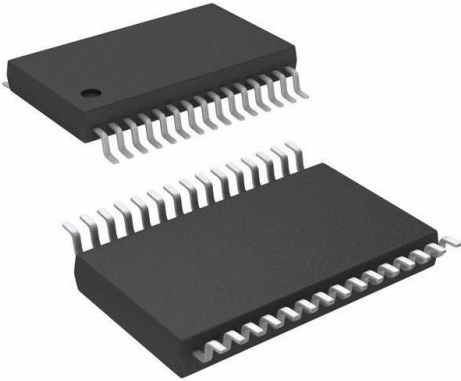


ADS7951SBDBT Datasheet

www.digi-electronics.com



ADS7951SBDBT

<https://www.DiGi-Electronics.com>

| | |
|------------------------------|---|
| DiGi Electronics Part Number | ADS7951SBDBT-DG |
| Manufacturer | Texas Instruments |
| Manufacturer Product Number | ADS7951SBDBT |
| Description | IC ADC 12BIT SAR 30TSSOP |
| Detailed Description | 12 Bit Analog to Digital Converter 8 Input 1 SAR 30-TSSOP |



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

ADS7951SBDBT

Series:

microPOWER™

Number of Bits:

12

Number of Inputs:

8

Data Interface:

SPI

Ratio - S/H:ADC:

1:1

Architecture:

SAR

Voltage - Supply, Analog:

2.7V ~ 5.25V

Features:

-

Package / Case:

30-TFSOP (0.173", 4.40mm Width)

Mounting Type:

Surface Mount

Manufacturer:

Texas Instruments

Product Status:

Active

Sampling Rate (Per Second):

1M

Input Type:

Single Ended

Configuration:

MUX-S/H-ADC

Number of A/D Converters:

1

Reference Type:

External

Voltage - Supply, Digital:

1.7V ~ 5.25V

Operating Temperature:

-40°C ~ 125°C

Supplier Device Package:

30-TSSOP

Base Product Number:

ADS7951

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

2 (1 Year)

ECCN:

EAR99

ADS79xx Pin Compatible, 12-, 10-, 8-Bit, 1-MSPS, 16-, 12-, 8-, 4-Channel, Single-Ended, Serial Interface ADCs

1 Features

- 1-MHz Sample Rate Serial Devices
- Product Family of 12-, 10-, 8-Bit Resolution
- Zero Latency
- 20-MHz Serial Interface
- Analog Supply Range: 2.7 to 5.25 V
- I/O Supply Range: 1.7 to 5.25 V
- Two SW Selectable Unipolar, Input Ranges: 0 to V_{REF} and 0 to $2 \times V_{REF}$
- Auto and Manual Modes for Channel Selection
- 4-, 8-Channel Devices and 12-, 16-Channel Devices Share the Same Footprint
- Two Programmable Alarm Levels per Channel
- Four Individually Configurable GPIOs in TSSOP Package: One GPIO in VQFN Package
- Typical Power Dissipation: 14.5 mW (+VA = 5 V, +VBD = 3 V) at 1 MSPS
- Power-Down Current (1 μ A)
- Input Bandwidth (47 MHz at 3 dB)
- 38-, 30-Pin TSSOP and 32-, 24-Pin VQFN Packages

2 Applications

- PLC/IPC
- Optical Line Card Monitoring
- Medical Instrumentation
- Digital Power Supplies
- Multi-Channel, General-Purpose Signal Monitoring
- High-Speed Data Acquisition Systems
- High-Speed Closed-Loop Systems

3 Description

The ADS79xx is a 12-, 10-, 8-bit pin compatible multichannel analog-to-digital converter family. The device comparison table shows all twelve devices from this product family.

The devices include a capacitor based SAR A/D converter with inherent sample and hold.

The devices accept a wide analog supply range from 2.7 V to 5.25 V. Very low power consumption makes these devices suitable for battery-powered and isolated power-supply applications.

A wide 1.7-V to 5.25-V I/O supply range facilitates a glueless interface with the most commonly used digital hosts. The serial interface is controlled by \overline{CS} and SCLK for easy connection with microprocessors and DSP.

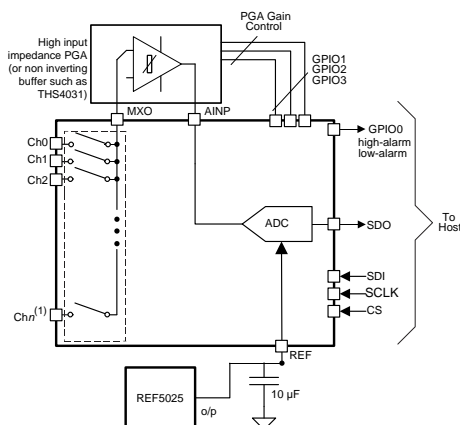
The input signal is sampled with the falling edge of \overline{CS} . It uses SCLK for conversion, serial data output, and reading serial data in. The devices allow auto sequencing of preselected channels or manual selection of a channel for the next conversion cycle.

There are two software selectable input ranges (0 V to V_{REF} and 0 V to $2 \times V_{REF}$), individually configurable GPIOs (four in case of the TSSOP and one on the VQFN package devices), and two programmable alarm thresholds per channel. These features make the devices suitable for most data acquisition applications.

The devices offer an attractive power-down feature. This is extremely useful for power saving when the device is operated at lower conversion speeds.

The 16-, 12-channel devices from this family are available in a 38-pin TSSOP and 32 pin VQFN package and the 4/8-channel devices are available in a 30-pin TSSOP and 24 pin VQFN packages.

Detailed Block Diagram



Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|------------|-------------------|
| ADS79xx | TSSOP (30) | 7.80 mm x 4.40 mm |
| | VQFN (24) | 4.00 mm x 4.00 mm |
| | TSSOP (38) | 9.70 mm x 4.40 mm |
| | VQFN (32) | 5.00 mm x 5.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



Table of Contents

| | | | | | |
|----------|---|-----------|-----------|---|-----------|
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| 2 | Applications | 1 | 8.1 | Overview | 28 |
| 3 | Description | 1 | 8.2 | Functional Block Diagram | 29 |
| 4 | Revision History | 2 | 8.3 | Feature Description | 29 |
| 5 | Device Comparison Table | 5 | 8.4 | Device Functional Modes | 29 |
| 6 | Pin Configuration and Functions | 5 | 8.5 | Programming | 41 |
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| 7.1 | Absolute Maximum Ratings | 10 | 9.1 | Application Information | 46 |
| 7.2 | ESD Ratings | 10 | 9.2 | Typical Applications | 48 |
| 7.3 | Recommended Operating Conditions | 10 | 10 | Power Supply Recommendations | 51 |
| 7.4 | Thermal Information: TSSOP | 11 | 11 | Layout | 52 |
| 7.5 | Thermal Information: VQFN | 11 | 11.1 | Layout Guidelines | 52 |
| 7.6 | Electrical Characteristics: ADS7950, ADS7951, ADS7952, ADS7953 | 12 | 11.2 | Layout Examples | 52 |
| 7.7 | Electrical Characteristics, ADS7954, ADS7955, ADS7956, ADS7957 | 14 | 12 | Device and Documentation Support | 54 |
| 7.8 | Electrical Characteristics, ADS7958, ADS7959, ADS7960, ADS7961 | 15 | 12.1 | Documentation Support | 54 |
| 7.9 | Timing Requirements | 17 | 12.2 | Related Links | 54 |
| 7.10 | Typical Characteristics (All ADS79xx Family Devices) | 20 | 12.3 | Receiving Notification of Documentation Updates | 54 |
| 7.11 | Typical Characteristics (12-Bit Devices Only) | 21 | 12.4 | Community Resources | 54 |
| 7.12 | Typical Characteristics (12-Bit Devices Only) | 27 | 12.5 | Trademarks | 54 |
| | | | 12.6 | Electrostatic Discharge Caution | 55 |
| | | | 12.7 | Glossary | 55 |
| | | | 13 | Mechanical, Packaging, and Orderable Information | 55 |

4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision B (July 2015) to Revision C

Page

| | |
|---|----|
| • Changed 0 to 2.5 V and 0 to 5 V to 0 to V_{REF} and 0 to $2 \times V_{REF}$ in <i>Input Range Features</i> bullet | 1 |
| • Changed <i>GPIO Features</i> bullet | 1 |
| • Changed <i>Optical Line Card Monitoring</i> and <i>Multi-Channel, General-Purpose Signal Monitoring</i> Applications bullets | 1 |
| • Changed (0 V to 2.5 V and 0 V to 5 V) to (0 V to V_{REF} and 0 V to $2 \times V_{REF}$) in <i>Description</i> section | 1 |
| • Deleted <i>Companion Products</i> table | 5 |
| • Changed RGE to RHB for two 32-pin VQFN pin diagrams | 5 |
| • Added 30-pin DBT package | 5 |
| • Changed I/O column of <i>Pin Functions: TSSOP Packages</i> table to show full definition instead of abbreviation | 6 |
| • Added <i>active low</i> to definition of \overline{CS} pin in <i>Pin Functions: TSSOP Packages</i> table | 7 |
| • Changed pin name and description of Alarm pin in <i>Pin Functions: TSSOP Packages</i> table | 7 |
| • Added settings to description of Range pin in <i>Pin Functions: TSSOP Packages</i> table: added (1) to high and (0) to low | 7 |
| • Added <i>active low</i> to description of CS pin in <i>Pin Functions: VQFN Packages</i> table | 8 |
| • Changed pin name and description of Alarm pin in <i>Pin Functions: VQFN Packages</i> table | 9 |
| • Changed value of <i>Input current to any pin except supply pins</i> row from ± 10 mA (max) to -10 mA (min) and 10 mA (max) in <i>Absolute Maximum Ratings</i> table | 10 |
| • Changed $VBD = 1.7$ V to 5.25 V to $VBD = 1.7$ V to +VA in condition statement | 12 |
| • Changed minimum specification from -1 LSB to -0.99 LSB in first row of <i>Differential linearity</i> parameter | 12 |
| • Added <i>input</i> to <i>Reference input resistance</i> parameter name | 13 |
| • Changed maximum specification from <i>FFC Hex</i> to <i>4092 LSB</i> in <i>Alarm Setting</i> parameters | 13 |
| • Changed unit from <i>Numbers</i> to <i>Conversion</i> in <i>Invalid conversions after power up or reset</i> parameter | 13 |
| • Changed $VBD = 1.7$ V to 5.25 V to $VBD = 1.7$ V to +VA in condition statement | 14 |

Revision History (continued)

| | |
|--|----|
| • Added <i>input</i> to <i>Reference input resistance</i> parameter name | 14 |
| • Changed maximum specification from <i>FFC Hex</i> to <i>4092 LSB</i> in <i>Alarm Setting</i> parameters | 14 |
| • Changed <i>VBD = 1.7 V</i> to <i>5.25 V</i> to <i>VBD = 1.7 V</i> to <i>+VA</i> in condition statement | 15 |
| • Added <i>input</i> to <i>Reference input resistance</i> parameter name | 16 |
| • Changed maximum specification from <i>FF Hex</i> to <i>255 LSB</i> in <i>Alarm Setting</i> parameters | 16 |
| • Changed unit from <i>Numbers</i> to <i>Conversion</i> in <i>Invalid conversions after power up or reset</i> parameter | 16 |
| • Changed <i>REF</i> and <i>GND</i> pins to <i>REFP</i> and <i>REFM</i> pins in the <i>Reference</i> section | 29 |
| • Added <i>Example Manual Mode Timing Diagram</i> figure and corresponding text to <i>Operating in Manual Mode</i> section | 33 |
| • Added <i>Example Auto-1 Mode Timing Diagram</i> figure and corresponding text to the <i>Operating in Auto-1 Mode</i> section | 35 |
| • Added <i>Example Auto-2 Mode Timing Diagram</i> figure and corresponding text to the <i>Operating in Auto-2 Mode</i> section | 39 |
| • Changed <i>2.5V</i> to V_{REF} in first DI06 row and <i>5V</i> to $2xV_{REF}$ in second DI06 row | 40 |
| • Changed binary code from <i>0001 1111 1111</i> to <i>0011 1111 1111</i> in Full scale row of <i>Ideal Input Voltages for 10-Bit Devices and Digital Output Codes for 10-Bit Devices (ADS7954/55/56/57)</i> table | 41 |
| • Changed <i>10-Bit</i> to <i>8-Bit</i> in title of <i>Ideal Input Voltages for 8-Bit Devices and Digital Output Codes for 8-Bit Devices (ADS7958/59/60/61)</i> table | 42 |
| • Changed <i>Application Diagram for an Unbuffered MXO</i> figure note | 48 |
| • Changed <i>Recommended Layout</i> figure title to <i>Recommended Layout for the TSSOP Packaged Device</i> | 52 |
| • Added <i>Recommended Layout for the VQFN Packaged Device</i> figure | 53 |

Changes from Revision A (April 2010) to Revision B

Page

| | |
|--|---|
| • Added <i>ESD Ratings</i> table, <i>Feature Description</i> section, <i>Device Functional Modes, Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section | 1 |
|--|---|

Changes from Original (June 2008) to Revision A

Page

| | |
|---|----|
| • Added QFN information to <i>Features</i> | 1 |
| • Added QFN information to <i>Description</i> | 1 |
| • Changed <i>VEE</i> to <i>AGND</i> and <i>VCC</i> to <i>+VA</i> on 38-pin TSSOP pinout | 5 |
| • Added QFN pinout | 5 |
| • Added QFN pinout | 5 |
| • Added QFN pinout | 6 |
| • Added QFN pinout | 6 |
| • Added terminal functions for QFN packages | 8 |
| • Changed ADS7950/4/8 QFN package MXO pin from 7 to 3 | 8 |
| • Added $V_{REF} = 2.5\text{ V} \pm 0.1\text{ V}$ to <i>Electrical Characteristics</i> , ADS7950/51/52/53 | 12 |
| • Added while $2V_{REF} \leq +VA$ to full-scale input span range 2 test conditions | 12 |
| • Added while $2V_{REF} \leq +VA$ to Absolute input range span range 2 test conditions | 12 |
| • Added Total unadjusted error (TUE) specification | 12 |
| • Changed reference voltage at REFP min and max values | 13 |
| • Added Note to <i>Electrical Characteristics</i> , ADS7950/51/52/53 | 13 |
| • Added $V_{REF} = 2.5\text{ V} \pm 0.1\text{ V}$ to <i>Electrical Characteristics</i> , ADS7954/55/56/57 test conditions | 14 |
| • Added while $2V_{REF} \leq +VA$ to full-scale input span range 2 test conditions | 14 |
| • Added while $2V_{REF} \leq +VA$ to full-scale input span range 2 test conditions | 14 |

**ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955
ADS7956, ADS7957, ADS7958, ADS7959, ADS7960, ADS7961**

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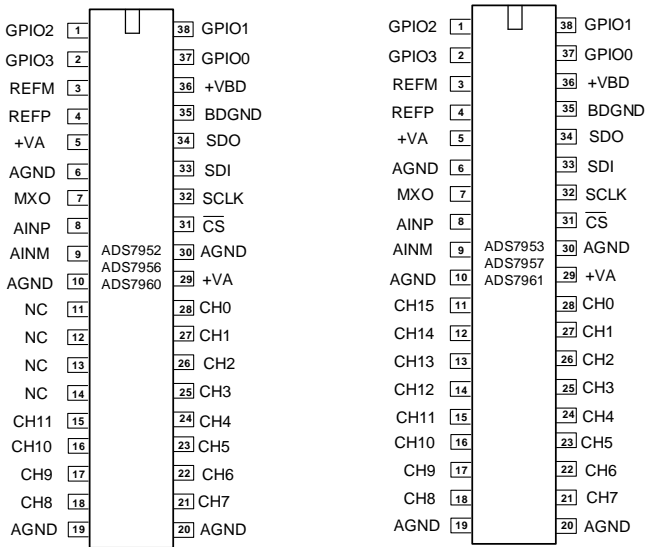
- Changed V_{ref} reference voltage at REFP min value from 2.49 V to 2.0 V 14
- Changed V_{ref} reference voltage at REFP max value from 2.51 V to 3.0 V 14
- Added $V_{ref} = 2.5\text{ V} \pm 0.1\text{ V}$ to *Electrical Characteristics*, ADS7958/59/60/61 test conditions..... 15
- Added while $2V_{REF} \leq +VA$ to full-scale input span range 2 test conditions 15
- Added while $2V_{REF} \leq +VA$ to full-scale input span range 2 test conditions 15
- Changed V_{ref} reference voltage at REFP min value from 2.49 V to 2.0 V 16
- Changed V_{ref} reference voltage at REFP max value from 2.51 V to 3.0 V 16
- Changed t_{su1} values from max to min..... 17
- Changed t_{su2} values from max to min..... 17
- Added TOTAL UNADJUSTED ERROR (TUE Max) graph..... 25
- Added TOTAL UNADJUSTED ERROR (TUE Min) graph..... 25
- Changed GPIO pins description 28
- Added device powerdown through GPIO in the case of the TSSOP packaged devices 28
- Added note to [Table 1](#) 33
- Added note to [Table 2](#) 36
- Added note to [Table 5](#) 40
- Added note to Programming GPIO Registers description 42
- Added QFN information to [Table 11](#) 43
- Changed DI12 = 1? from No or No to Yes or No in [Figure 59](#)..... 44
- Added note to [Figure 60](#) 46

5 Device Comparison Table

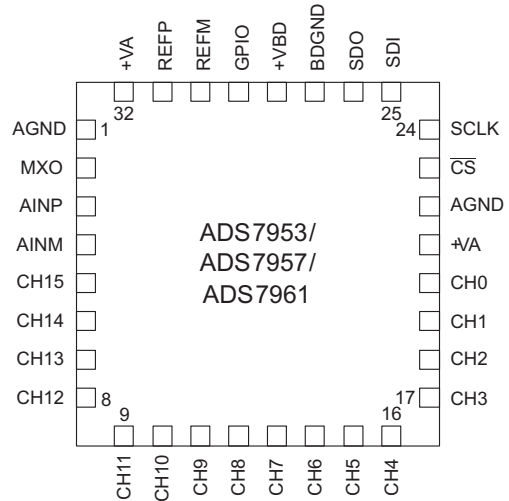
| NUMBER OF CHANNELS | RESOLUTION | | |
|--------------------|------------|---------|---------|
| | 12 BIT | 10 BIT | 8 BIT |
| 16 | ADS7953 | ADS7957 | ADS7961 |
| 12 | ADS7952 | ADS7956 | ADS7960 |
| 8 | ADS7951 | ADS7955 | ADS7959 |
| 4 | ADS7950 | ADS7954 | ADS7958 |

6 Pin Configuration and Functions

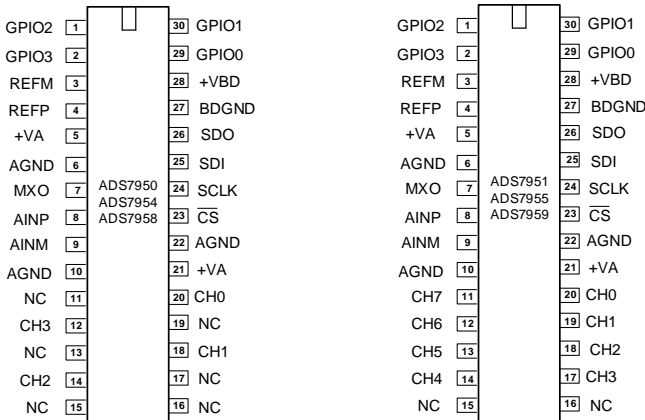
**DBT Package
38-Pin TSSOP
Top View**



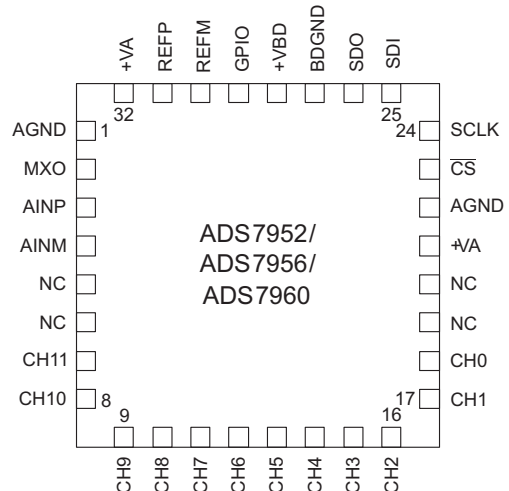
**RHB Package
32-Pin VQFN
Top View**



**DBT Package
30-Pin TSSOP
Top View**



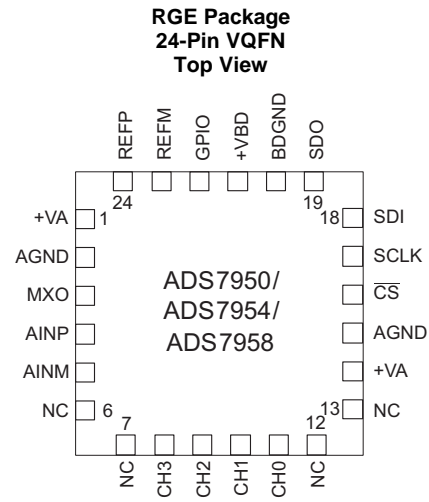
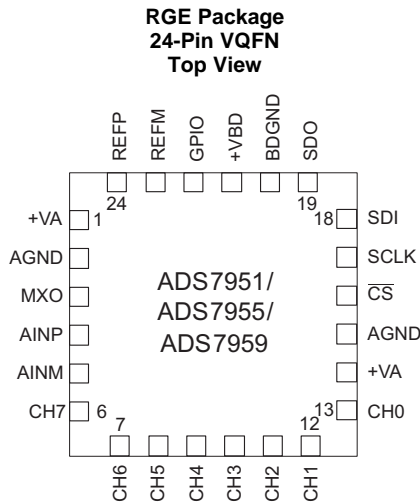
**RHB Package
32-Pin VQFN
Top View**



**ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955
ADS7956, ADS7957, ADS7958, ADS7959, ADS7960, ADS7961**

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Pin Functions: TSSOP Packages

| NAME | PIN | | | | I/O | DESCRIPTION |
|-------------------------|-------------------------------|-------------------------------|-------------------------------|-------------------------------|---------------|--------------------------------|
| | ADS7953 ADS7957 ADS7961 | ADS7952 ADS7956 ADS7960 | ADS7951 ADS7955 ADS7959 | ADS7950 ADS7954 ADS7958 | | |
| REFERENCE | | | | | | |
| REFP | 4 | 4 | 4 | 4 | Analog input | Reference input |
| REFM | 3 | 3 | 3 | 3 | Analog input | Reference ground |
| ADC ANALOG INPUT | | | | | | |
| AINP | 8 | 8 | 8 | 8 | Analog input | ADC input signal |
| AINM | 9 | 9 | 9 | 9 | Analog input | ADC input ground |
| MULTIPLEXER | | | | | | |
| MXO | 7 | 7 | 7 | 7 | Analog output | Multiplexer output |
| Ch0 | 28 | 28 | 20 | 20 | Analog input | Analog channel for multiplexer |
| Ch1 | 27 | 27 | 19 | 18 | Analog input | Analog channel for multiplexer |
| Ch2 | 26 | 26 | 18 | 14 | Analog input | Analog channel for multiplexer |
| Ch3 | 25 | 25 | 17 | 12 | Analog input | Analog channel for multiplexer |
| Ch4 | 24 | 24 | 14 | — | Analog input | Analog channel for multiplexer |
| Ch5 | 23 | 23 | 13 | — | Analog input | Analog channel for multiplexer |
| Ch6 | 22 | 22 | 12 | — | Analog input | Analog channel for multiplexer |
| Ch7 | 21 | 21 | 11 | — | Analog input | Analog channel for multiplexer |
| Ch8 | 18 | 18 | — | — | Analog input | Analog channel for multiplexer |
| Ch9 | 17 | 17 | — | — | Analog input | Analog channel for multiplexer |

Pin Functions: TSSOP Packages (continued)

| NAME | PIN | | | | I/O | DESCRIPTION |
|---|-------------------------------|-------------------------------|-------------------------------|-------------------------------|----------------|---|
| | ADS7953 ADS7957 ADS7961 | ADS7952 ADS7956 ADS7960 | ADS7951 ADS7955 ADS7959 | ADS7950 ADS7954 ADS7958 | | |
| Ch10 | 16 | 16 | — | — | Analog input | Analog channel for multiplexer |
| Ch11 | 15 | 15 | — | — | Analog input | Analog channel for multiplexer |
| Ch12 | 14 | — | — | — | Analog input | Analog channel for multiplexer |
| Ch13 | 13 | — | — | — | Analog input | Analog channel for multiplexer |
| Ch14 | 12 | — | — | — | Analog input | Analog channel for multiplexer |
| Ch15 | 11 | — | — | — | Analog input | Analog channel for multiplexer |
| DIGITAL CONTROL SIGNALS | | | | | | |
| \overline{CS} | 31 | 31 | 23 | 23 | Digital input | Chip-select input pin; active low |
| SCLK | 32 | 32 | 24 | 24 | Digital input | Serial clock input pin |
| SDI | 33 | 33 | 25 | 25 | Digital input | Serial data input pin |
| SDO | 34 | 34 | 26 | 26 | Digital output | Serial data output pin |
| GENERAL-PURPOSE INPUTS/OUTPUTS⁽¹⁾ | | | | | | |
| GPIO0 | 37 | 37 | 29 | 29 | Digital I/O | General-purpose input or output |
| Alarm | | | | | Digital output | Active high alarm output. For configuration, see the Programming section. |
| GPIO1 | 38 | 38 | 30 | 30 | Digital I/O | General-purpose input or output |
| Low alarm | | | | | Digital output | Active high output indicating low alarm |
| GPIO2 | 1 | 1 | 1 | 1 | Digital I/O | General-purpose input or output |
| Range | | | | | Digital input | Selects ADC input range: High (1) -> Range 2 (0 to 2xV _{REF}) / Low (0) -> Range 1 (0 to V _{REF}) |
| GPIO3 | 2 | 2 | 2 | 2 | Digital I/O | General-purpose input or output |
| \overline{PD} | | | | | Digital input | Active low power-down input |
| POWER SUPPLY AND GROUND | | | | | | |
| +VA | 5, 29 | 5, 29 | 5, 21 | 5, 21 | — | Analog power supply |
| AGND | 6, 10, 19, 20, 30 | 6, 10, 19, 20, 30 | 6, 10, 22 | 6, 10, 22 | — | Analog ground |
| +VBD | 36 | 36 | 28 | 28 | — | Digital I/O supply |
| BDGND | 35 | 35 | 27 | 27 | — | Digital ground |
| NC PINS | | | | | | |
| — | — | 11, 12, 13, 14 | 15, 16 | 11, 13, 15, 16, 17, 19 | — | Pins internally not connected, do not float these pins, connect these pins to ground |

(1) These pins have programmable dual functionality. See [Table 12](#) for functionality programming.

**ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955
ADS7956, ADS7957, ADS7958, ADS7959, ADS7960, ADS7961**

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Pin Functions: VQFN Packages

| PIN NAME | PIN | | | | I/O | DESCRIPTION |
|--------------------------------|-------------------------------|-------------------------------|-------------------------------|-------------------------------|---------------|--------------------------------------|
| | ADS7953 ADS7957 ADS7961 | ADS7952 ADS7956 ADS7960 | ADS7951 ADS7955 ADS7959 | ADS7950 ADS7954 ADS7958 | | |
| REFERENCE | | | | | | |
| REFP | 31 | 31 | 24 | 24 | Analog input | Reference input |
| REFM | 30 | 30 | 23 | 23 | Analog input | Reference ground |
| ADC ANALOG INPUT | | | | | | |
| AINP | 3 | 3 | 4 | 4 | Analog input | ADC input signal |
| AINM | 4 | 4 | 5 | 5 | Analog input | ADC input ground |
| MULTIPLEXER | | | | | | |
| MXO | 2 | 2 | 3 | 3 | Analog output | Multiplexer output |
| Ch0 | 20 | 18 | 13 | 11 | Analog input | Analog-input channel for multiplexer |
| Ch1 | 19 | 17 | 12 | 10 | Analog input | Analog-input channel for multiplexer |
| Ch2 | 18 | 16 | 11 | 9 | Analog input | Analog-input channel for multiplexer |
| Ch3 | 17 | 15 | 10 | 8 | Analog input | Analog-input channel for multiplexer |
| Ch4 | 16 | 14 | 9 | — | Analog input | Analog-input channel for multiplexer |
| Ch5 | 15 | 13 | 8 | — | Analog input | Analog-input channel for multiplexer |
| Ch6 | 14 | 12 | 7 | — | Analog input | Analog-input channel for multiplexer |
| Ch7 | 13 | 11 | 6 | — | Analog input | Analog-input channel for multiplexer |
| Ch8 | 12 | 10 | — | — | Analog input | Analog-input channel for multiplexer |
| Ch9 | 11 | 9 | — | — | Analog input | Analog-input channel for multiplexer |
| Ch10 | 10 | 8 | — | — | Analog input | Analog-input channel for multiplexer |
| Ch11 | 9 | 7 | — | — | Analog input | Analog-input channel for multiplexer |
| Ch12 | 8 | — | — | — | Analog input | Analog-input channel for multiplexer |
| Ch13 | 7 | — | — | — | Analog input | Analog-input channel for multiplexer |
| Ch14 | 6 | — | — | — | Analog input | Analog-input channel for multiplexer |
| Ch15 | 5 | — | — | — | Analog input | Analog-input channel for multiplexer |
| DIGITAL CONTROL SIGNALS | | | | | | |
| \overline{CS} | 23 | 23 | 16 | 16 | Digital input | Chip-select input pin; active low |
| SCLK | 24 | 24 | 17 | 17 | Digital input | Serial clock input pin |
| SDI | 25 | 25 | 18 | 18 | Digital input | Serial data input pin |

Pin Functions: VQFN Packages (continued)

| PIN NAME | PIN | | | | I/O | DESCRIPTION |
|---|-------------------------------|-------------------------------|-------------------------------|-------------------------------|----------------|---|
| | ADS7953 ADS7957 ADS7961 | ADS7952 ADS7956 ADS7960 | ADS7951 ADS7955 ADS7959 | ADS7950 ADS7954 ADS7958 | | |
| SDO | 26 | 26 | 19 | 19 | Digital output | Serial data output pin |
| GENERAL-PURPOSE INPUT/OUTPUT⁽¹⁾ | | | | | | |
| GPIO0 | 29 | 29 | 22 | 22 | Digital I/O | General purpose input or output |
| Alarm | | | | | Digital output | Active high alarm output. For configuration, see the Programming section. |
| POWER SUPPLY AND GROUND | | | | | | |
| +VA | 21, 32 | 21, 32 | 1, 14 | 1, 14 | — | Analog power supply |
| AGND | 1, 22 | 1, 22 | 2, 15 | 2, 15 | — | Analog ground |
| +VBD | 28 | 28 | 21 | 21 | — | Digital I/O supply |
| BDGND | 27 | 27 | 20 | 20 | — | Digital ground |
| NC PINS | | | | | | |
| — | — | 5, 6, 19, 20 | — | 6, 7, 12, 13 | — | Pins internally not connected, do not float these pins, connect these pins to ground |

(1) This pin has programmable dual functionality. See [Table 12](#) for functionality programming.

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾⁽²⁾

| | MIN | MAX | UNIT |
|---|------|----------|------|
| AINP or CHn to AGND | -0.3 | VA +0.3 | V |
| +VA to AGND, +VBD to BDGND | -0.3 | 7 | V |
| Digital input voltage to BDGND | -0.3 | 7 | V |
| Digital output to BDGND | -0.3 | VA + 0.3 | V |
| Input current to any pin except supply pins | -10 | 10 | mA |
| Operating temperature | -40 | 125 | °C |
| Junction temperature (T _J Max) | | 150 | °C |
| Storage temperature (T _{stg}) | -65 | 150 | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) DBT packaged versions of ADS79xx family devices are rated for MSL2 260°C per the JSTD-020 specifications and the RGE and RHB packaged versions of ADS79xx family devices are rated for MSL3 260C per JSTD-020 specifications

7.2 ESD Ratings

| | | VALUE | UNIT |
|--|--|-------|------|
| V _(ESD) Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ±2000 | V |
| | Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | ±500 | |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | | MIN | NOM | MAX | UNIT |
|---------------------|-----------------------------|-----|-----|--------------------|------|
| V _(+VA) | Analog power-supply voltage | 2.7 | 3.3 | 5.25 | V |
| V _(+VBD) | Digital I/O-supply voltage | 1.7 | 3.3 | V _(+VA) | V |
| V _(REF) | Reference voltage | 2 | 2.5 | 3 | V |
| f _(SCLK) | SCLK frequency | | | 20 | MHz |
| T _A | Operating temperature range | -40 | | 125 | °C |

7.4 Thermal Information: TSSOP

| THERMAL METRIC ⁽¹⁾ | | ADS795x | | UNIT |
|-------------------------------|--|-------------|-------------|------|
| | | DBT (TSSOP) | DBT (TSSOP) | |
| | | 38 PINS | 30 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 83.6 | 89.8 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 29.8 | 22.9 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 44.7 | 43.1 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 2.9 | 0.8 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 44.1 | 42.5 | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance | n/a | n/a | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Thermal Information: VQFN

| THERMAL METRIC ⁽¹⁾ | | ADS7953, ADS7957, ADS7961 | | UNIT |
|-------------------------------|--|---------------------------|------------|------|
| | | RHB (VQFN) | RGE (VQFN) | |
| | | 32 PINS | 24 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 40.6 | 36.9 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 32.1 | 39.3 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 13.1 | 14.7 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 0.8 | 0.7 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 13 | 14.8 | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance | 5.7 | 5.6 | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

**ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955
ADS7956, ADS7957, ADS7958, ADS7959, ADS7960, ADS7961**

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7.6 Electrical Characteristics: ADS7950, ADS7951, ADS7952, ADS7953

$V_A = 2.7\text{ V to }5.25\text{ V}$, $V_{BD} = 1.7\text{ V to }+V_A$, $V_{REF} = 2.5\text{ V} \pm 0.1\text{ V}$, $T_A = -40^\circ\text{C to }125^\circ\text{C}$, $f_{\text{sample}} = 1\text{ MHz}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------------------|-------------------------------------|-------|------------|--------------------------|--------------------|
| ANALOG INPUT | | | | | |
| Full-scale input span ⁽¹⁾ | Range 1 | 0 | | V_{REF} | V |
| | Range 2 while $2xV_{REF} \leq +V_A$ | 0 | | $2 \times V_{REF}$ | |
| Absolute input range | Range 1 | -0.2 | | $V_{REF} + 0.2$ | V |
| | Range 2 while $2xV_{REF} \leq +V_A$ | -0.2 | | $2 \times V_{REF} + 0.2$ | |
| Input capacitance | | | 15 | | pF |
| Input leakage current | $T_A = 125^\circ\text{C}$ | | 61 | | nA |
| SYSTEM PERFORMANCE | | | | | |
| Resolution | | | 12 | | Bits |
| No missing codes | ADS795XSB ⁽²⁾ | 12 | | | Bits |
| | ADS795XS ⁽²⁾ | 11 | | | |
| Integral linearity | ADS795XSB ⁽²⁾ | -1 | ± 0.5 | 1 | LSB ⁽³⁾ |
| | ADS795XS ⁽²⁾ | -1.5 | ± 0.75 | 1.5 | |
| Differential linearity | ADS795XSB ⁽²⁾ | -0.99 | ± 0.5 | 1 | LSB |
| | ADS795XS ⁽²⁾ | -2 | ± 0.75 | 1.5 | |
| Offset error ⁽⁴⁾ | | -3.5 | ± 1.1 | 3.5 | LSB |
| Gain error | Range 1 | -2 | ± 0.2 | 2 | LSB |
| | Range 2 | | ± 0.2 | | |
| Total unadjusted error (TUE) | | | ± 2 | | LSB |
| SAMPLING DYNAMICS | | | | | |
| Conversion time | 20 MHz SCLK | | | 800 | ns |
| Acquisition time | | 325 | | | ns |
| Maximum throughput rate | 20 MHz SCLK | | | 1 | MHz |
| Aperture delay | | | 5 | | ns |
| Step response | | | 150 | | ns |
| Overvoltage recovery | | | 150 | | ns |

- (1) Ideal input span; does not include gain or offset error.
(2) ADS795X, where X indicates 0, 1, 2, or 3.
(3) LSB means least significant bit.
(4) Measured relative to an ideal full-scale input.

Electrical Characteristics: ADS7950, ADS7951, ADS7952, ADS7953 (continued)

VA = 2.7 V to 5.25 V, VBD = 1.7 V to +VA, VREF = 2.5 V ± 0.1 V, TA = –40°C to 125°C, f_{sample} = 1 MHz (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|---------------------------------|------------|------|------------|
| DYNAMIC CHARACTERISTICS | | | | | |
| Total harmonic distortion ⁽⁵⁾ | 100 kHz | | –82 | | dB |
| Signal-to-noise ratio | 100 kHz, ADS795XSB ⁽²⁾ | 70 | 71.7 | | dB |
| | 100 kHz, ADS795XS ⁽²⁾ | 70 | 71.7 | | |
| Signal-to-noise + distortion | 100 kHz, ADS795XSB ⁽²⁾ | 69 | 71.3 | | dB |
| | 100 kHz, ADS795XS ⁽²⁾ | 68 | 71.3 | | |
| Spurious free dynamic range | 100 kHz | | 84 | | dB |
| Small signal bandwidth | At –3 dB | | 47 | | MHz |
| Channel-to-channel crosstalk | Any off-channel with 100 kHz, Full-scale input to channel being sampled with DC input (isolation crosstalk). | | –95 | | dB |
| | From previously sampled to channel with 100 kHz, Full-scale input to channel being sampled with DC input (memory crosstalk). | | –85 | | |
| EXTERNAL REFERENCE INPUT | | | | | |
| V _{REF} reference voltage at REFP ⁽⁶⁾ | | 2 | 2.5 | 3 | V |
| Reference input resistance | At f _{sample} = 1 MHz | | 100 | | kΩ |
| ALARM SETTING | | | | | |
| High threshold range | | 0 | | 4092 | LSB |
| Low threshold range | | 0 | | 4092 | LSB |
| DIGITAL INPUT/OUTPUT | | | | | |
| Logic family | CMOS | | | | |
| Logic level | V _{IH} | | 0.7*(+VBD) | | V |
| | V _{IL} | +VBD = 5 V | | 0.8 | |
| | V _{IL} | +VBD = 3 V | | 0.4 | |
| | V _{OH} | At I _{source} = 200 μA | +VBD-0.2 | | |
| | V _{OL} | At I _{sink} = 200 μA | 0.4 | | |
| Data format MSB first | | | MSB First | | |
| POWER SUPPLY REQUIREMENTS | | | | | |
| +VA supply voltage | | 2.7 | 3.3 | 5.25 | V |
| +VBD supply voltage | | 1.7 | 3.3 | 5.25 | V |
| Supply current (normal mode) | At +VA = 2.7 to 3.6 V and 1 MHz throughput | | 1.8 | | mA |
| | At +VA = 2.7 to 3.6 V static state | | 1.05 | | |
| | At +VA = 4.7 to 5.25 V and 1 MHz throughput | | 2.3 | 3 | |
| | At +VA = 4.7 to 5.25 V static state | | 1.1 | 1.5 | |
| Power-down state supply current | | | 1 | | μA |
| +VBD supply current | +VA = 5.25 V, f _s = 1MHz | | 1 | | mA |
| Power-up time | | | | 1 | μs |
| Invalid conversions after power up or reset | | | | 1 | Conversion |

(5) Calculated on the first nine harmonics of the input frequency.

(6) Device is designed to operate over V_{REF} = 2 V to 3 V. However one can expect lower noise performance at V_{ref} < 2.4 V. This is due to SNR degradation resulting from lowered signal range.

**ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955
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7.7 Electrical Characteristics, ADS7954, ADS7955, ADS7956, ADS7957

+VA = 2.7 V to 5.25 V, +VBD = 1.7 V to +VA, V_{REF} = 2.5 V ± 0.1 V, T_A = –40°C to 125°C, f_{sample} = 1 MHz (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---|-------|------|--------------------------|--------------------|
| ANALOG INPUT | | | | | |
| Full-scale input span ⁽¹⁾ | Range 1 | 0 | | V _{REF} | V |
| | Range 2 while 2xV _{REF} ≤ +VA | 0 | | 2*V _{REF} | |
| Absolute input range | Range 1 | –0.20 | | V _{REF} +0.20 | V |
| | Range 2 while 2xV _{REF} ≤ +VA | –0.20 | | 2*V _{REF} +0.20 | |
| Input capacitance | | | 15 | | pF |
| Input leakage current | T _A = 125°C | | 61 | | nA |
| SYSTEM PERFORMANCE | | | | | |
| Resolution | | | 10 | | Bits |
| No missing codes | | 10 | | | Bits |
| Integral linearity | | –0.5 | ±0.2 | 0.5 | LSB ⁽²⁾ |
| Differential linearity | | –0.5 | ±0.2 | 0.5 | LSB |
| Offset error ⁽³⁾ | | –1.5 | ±0.5 | 1.5 | LSB |
| Gain error | Range 1 | –1 | ±0.1 | 1 | LSB |
| | Range 2 | | ±0.1 | | |
| SAMPLING DYNAMICS | | | | | |
| Conversion time | 20 MHz SCLK | | | 800 | ns |
| Acquisition time | | 325 | | | ns |
| Maximum throughput rate | 20 MHz SCLK | | | 1 | MHz |
| Aperture delay | | | 5 | | ns |
| Step response | | | 150 | | ns |
| Overvoltage recovery | | | 150 | | ns |
| DYNAMIC CHARACTERISTICS | | | | | |
| Total harmonic distortion ⁽⁴⁾ | 100 kHz | | –80 | | dB |
| Signal-to-noise ratio | 100 kHz | 60 | | | dB |
| Signal-to-noise + distortion | 100 kHz | 60 | | | |
| Spurious free dynamic range | 100 kHz | | 82 | | dB |
| Full power bandwidth | At –3 dB | | 47 | | MHz |
| Channel-to-channel crosstalk | Any off-channel with 100 kHz, Full-scale input to channel being sampled with DC input. | | –95 | | dB |
| | From previously sampled to channel with 100 kHz, Full-scale input to channel being sampled with DC input. | | –85 | | |
| EXTERNAL REFERENCE INPUT | | | | | |
| V _{REF} reference voltage at REFP | | 2 | 2.5 | 3 | V |
| Reference input resistance | f _{sample} = 1 MHz | | 100 | | kΩ |
| ALARM SETTING | | | | | |
| High threshold range | | 000 | | 4092 | LSB |
| Low threshold range | | 000 | | 4092 | LSB |

- (1) Ideal input span; does not include gain or offset error.
(2) LSB means least significant bit.
(3) Measured relative to an ideal full-scale input.
(4) Calculated on the first nine harmonics of the input frequency.

Electrical Characteristics, ADS7954, ADS7955, ADS7956, ADS7957 (continued)

+VA = 2.7 V to 5.25 V, +VBD = 1.7 V to +VA, $V_{REF} = 2.5 V \pm 0.1 V$, $T_A = -40^\circ C$ to $125^\circ C$, $f_{sample} = 1 MHz$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|-----------------------------|------------|------|------|------------|
| DIGITAL INPUT/OUTPUT | | | | | | |
| Logic family | | CMOS | | | | |
| Logic level | V_{IH} | | 0.7*(+VBD) | | | V |
| | V_{IL} | +VBD = 5 V | | | 0.8 | |
| | V_{IL} | +VBD = 3 V | | | 0.4 | |
| | V_{OH} | At $I_{source} = 200 \mu A$ | +VBD-0.2 | | | |
| | V_{OL} | At $I_{sink} = 200 \mu A$ | 0.4 | | | |
| Data format MSB first | | | MSB First | | | |
| POWER SUPPLY REQUIREMENTS | | | | | | |
| +VA supply voltage | | | 2.7 | 3.3 | 5.25 | V |
| +VBD supply voltage | | | 1.7 | 3.3 | 5.25 | V |
| Supply current (normal mode) | At +VA = 2.7 to 3.6 V and 1MHz throughput | | | 1.8 | | mA |
| | At +VA = 2.7 to 3.6 V static state | | | 1.05 | 1 | |
| | At +VA = 4.7 to 5.25 V and 1 MHz throughput | | | 2.3 | 3 | |
| | At +VA = 4.7 to 5.25 V static state | | | 1.1 | 1.5 | |
| Power-down state supply current | | | | 1 | | μA |
| +VBD supply current | | +VA = 5.25V, $f_s = 1 MHz$ | | 1 | | mA |
| Power-up time | | | | | 1 | μs |
| Invalid conversions after power up or reset | | | | | 1 | Conversion |

7.8 Electrical Characteristics, ADS7958, ADS7959, ADS7960, ADS7961

+VA = 2.7 V to 5.25 V, +VBD = 1.7 V to +VA, $V_{REF} = 2.5 V \pm 0.1 V$, $T_A = -40^\circ C$ to $125^\circ C$, $f_{sample} = 1 MHz$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------------------|------------------------------------|---------------------|-------|-----------|-------------------|--------------------|
| ANALOG INPUT | | | | | | |
| Full-scale input span ⁽¹⁾ | Range 1 | | 0 | | V_{REF} | V |
| | Range 2 while $2xV_{REF} \leq +VA$ | | 0 | | $2*V_{REF}$ | |
| Absolute input range | Range 1 | | -0.20 | | $V_{REF} + 0.2$ | V |
| | Range 2 while $2xV_{REF} \leq +VA$ | | -0.20 | | $2*V_{REF} + 0.2$ | |
| Input capacitance | | | | 15 | | pF |
| Input leakage current | | $T_A = 125^\circ C$ | | 61 | | nA |
| SYSTEM PERFORMANCE | | | | | | |
| Resolution | | | | 8 | | Bits |
| No missing codes | | | 8 | | | Bits |
| Integral linearity | | | -0.3 | ± 0.1 | 0.3 | LSB ⁽²⁾ |
| Differential linearity | | | -0.3 | ± 0.1 | 0.3 | LSB |
| Offset error ⁽³⁾ | | | -0.5 | ± 0.2 | 0.5 | LSB |
| Gain error | Range 1 | | -0.6 | ± 0.1 | 0.6 | LSB |
| | Range 2 | | | ± 0.1 | | |

(1) Ideal input span; does not include gain or offset error.

(2) LSB means least significant bit.

(3) Measured relative to an ideal full-scale input.

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Electrical Characteristics, ADS7958, ADS7959, ADS7960, ADS7961 (continued)

+VA = 2.7 V to 5.25 V, +VBD = 1.7 V to +VA, V_{REF} = 2.5 V ± 0.1 V, T_A = –40°C to 125°C, f_{sample} = 1 MHz (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|---------------------------------|------------|------|------------|
| SAMPLING DYNAMICS | | | | | |
| Conversion time | 20 MHz SCLK | | | 800 | ns |
| Acquisition time | | 325 | | | ns |
| Maximum throughput rate | 20 MHz SCLK | | | 1 | MHz |
| Aperture delay | | | 5 | | ns |
| Step response | | | 150 | | ns |
| Overshoot recovery | | | 150 | | ns |
| DYNAMIC CHARACTERISTICS | | | | | |
| Total harmonic distortion ⁽⁴⁾ | 100 kHz | | –75 | | dB |
| Signal-to-noise ratio | 100 kHz | 49 | | | dB |
| Signal-to-noise + distortion | 100 kHz | 49 | | | |
| Spurious free dynamic range | 100 kHz | | –78 | | dB |
| Full power bandwidth | At –3 dB | | 47 | | MHz |
| Channel-to-channel crosstalk | Any off-channel with 100 kHz, Full-scale input to channel being sampled with DC input. | | –95 | | dB |
| | From previously sampled to channel with 100 kHz, Full-scale input to channel being sampled with DC input. | | –85 | | |
| EXTERNAL REFERENCE INPUT | | | | | |
| V _{REF} reference voltage at REFP | | 2 | 2.5 | 3 | V |
| Reference input resistance | f _{sample} = 1 MHz | | 100 | | kΩ |
| ALARM SETTING | | | | | |
| High threshold range | | 000 | | 255 | LSB |
| Low threshold range | | 000 | | 255 | LSB |
| DIGITAL INPUT/OUTPUT | | | | | |
| Logic family | CMOS | | | | |
| Logic level | V _{IH} | | 0.7*(+VBD) | | V |
| | V _{IL} | +VBD = 5 V | | 0.8 | |
| | V _{IL} | +VBD = 3 V | | 0.4 | |
| | V _{OH} | At I _{source} = 200 μA | +VBD-0.2 | | |
| | V _{OL} | At I _{sink} = 200 μA | 0.4 | | |
| Data format | | | MSB First | | |
| POWER SUPPLY REQUIREMENTS | | | | | |
| +VA supply voltage | | 2.7 | 3.3 | 5.25 | V |
| +VBD supply voltage | | 1.7 | 3.3 | 5.25 | V |
| Supply current (normal mode) | At +VA = 2.7 to 3.6 V and 1 MHz throughput | | 1.8 | | mA |
| | At +VA = 2.7 to 3.6 V static state | | 1.05 | | |
| | At +VA = 4.7 to 5.25 V and 1 MHz throughput | | 2.3 | 3 | |
| | At +VA = 4.7 to 5.25 V static state | | 1.1 | 1.5 | |
| Power-down state supply current | | | 1 | | μA |
| +VBD supply current | +VA = 5.25V, f _s = 1MHz | | 1 | | mA |
| Power-up time | | | | 1 | μs |
| Invalid conversions after power up or reset | | | | 1 | Conversion |

(4) Calculated on the first nine harmonics of the input frequency.

7.9 Timing Requirements

All specifications typical at -40°C to 125°C , $+V_A = 2.7\text{ V}$ to 5.25 V (unless otherwise specified)⁽¹⁾⁽²⁾ (see [Figure 1](#), [Figure 2](#), [Figure 3](#), and [Figure 4](#))

| | | MIN | NOM | MAX | UNIT |
|-------------------|---|--------------|-----|-----|------|
| t_{conv} | Conversion time | +VBD = 1.8 V | | 16 | SCLK |
| | | +VBD = 3 V | | 16 | |
| | | +VBD = 5 V | | 16 | |
| t_q | Minimum quiet sampling time needed from bus 3-state to start of next conversion | +VBD = 1.8 V | 40 | | ns |
| | | +VBD = 3 V | 40 | | |
| | | +VBD = 5 V | 40 | | |
| t_{d1} | Delay time, $\overline{\text{CS}}$ low to first data (DO–15) out | +VBD = 1.8 V | | 38 | ns |
| | | +VBD = 3 V | | 27 | |
| | | +VBD = 5 V | | 17 | |
| $t_{\text{su}1}$ | Setup time, $\overline{\text{CS}}$ low to first rising edge of SCLK | +VBD = 1.8 V | 8 | | ns |
| | | +VBD = 3 V | 6 | | |
| | | +VBD = 5 V | 4 | | |
| t_{d2} | Delay time, SCLK falling to SDO next data bit valid | +VBD = 1.8 V | | 35 | ns |
| | | +VBD = 3 V | | 27 | |
| | | +VBD = 5 V | | 17 | |
| t_{h1} | Hold time, SCLK falling to SDO data bit valid | +VBD = 1.8 V | 7 | | ns |
| | | +VBD = 3 V | 5 | | |
| | | +VBD = 5 V | 3 | | |
| t_{d3} | Delay time, 16 th SCLK falling edge to SDO 3-state | +VBD = 1.8 V | | 26 | ns |
| | | +VBD = 3 V | | 22 | |
| | | +VBD = 5 V | | 13 | |
| $t_{\text{su}2}$ | Setup time, SDI valid to rising edge of SCLK | +VBD = 1.8 V | 2 | | ns |
| | | +VBD = 3 V | 3 | | |
| | | +VBD = 5 V | 4 | | |
| t_{h2} | Hold time, rising edge of SCLK to SDI valid | +VBD = 1.8 V | 12 | | ns |
| | | +VBD = 3 V | 10 | | |
| | | +VBD = 5 V | 6 | | |
| t_{w1} | Pulse duration $\overline{\text{CS}}$ high | +VBD = 1.8 V | 20 | | ns |
| | | +VBD = 3 V | 20 | | |
| | | +VBD = 5 V | 20 | | |
| t_{d4} | Delay time $\overline{\text{CS}}$ high to SDO 3-state | +VBD = 1.8 V | | 24 | ns |
| | | +VBD = 3 V | | 21 | |
| | | +VBD = 5 V | | 12 | |
| t_{wh} | Pulse duration SCLK high | +VBD = 1.8 V | 20 | | ns |
| | | +VBD = 3 V | 20 | | |
| | | +VBD = 5 V | 20 | | |
| t_{wl} | Pulse duration SCLK low | +VBD = 1.8 V | 20 | | ns |
| | | +VBD = 3 V | 20 | | |
| | | +VBD = 5 V | 20 | | |
| | Frequency SCLK | +VBD = 1.8 V | | 20 | MHz |
| | | +VBD = 3 V | | 20 | |
| | | +VBD = 5 V | | 20 | |

(1) 1.8V specifications apply from 1.7 V to 1.9 V, 3 V specifications apply from 2.7 V to 3.6 V, 5 V specifications apply from 4.75 V to 5.25 V.

(2) With 50-pF load

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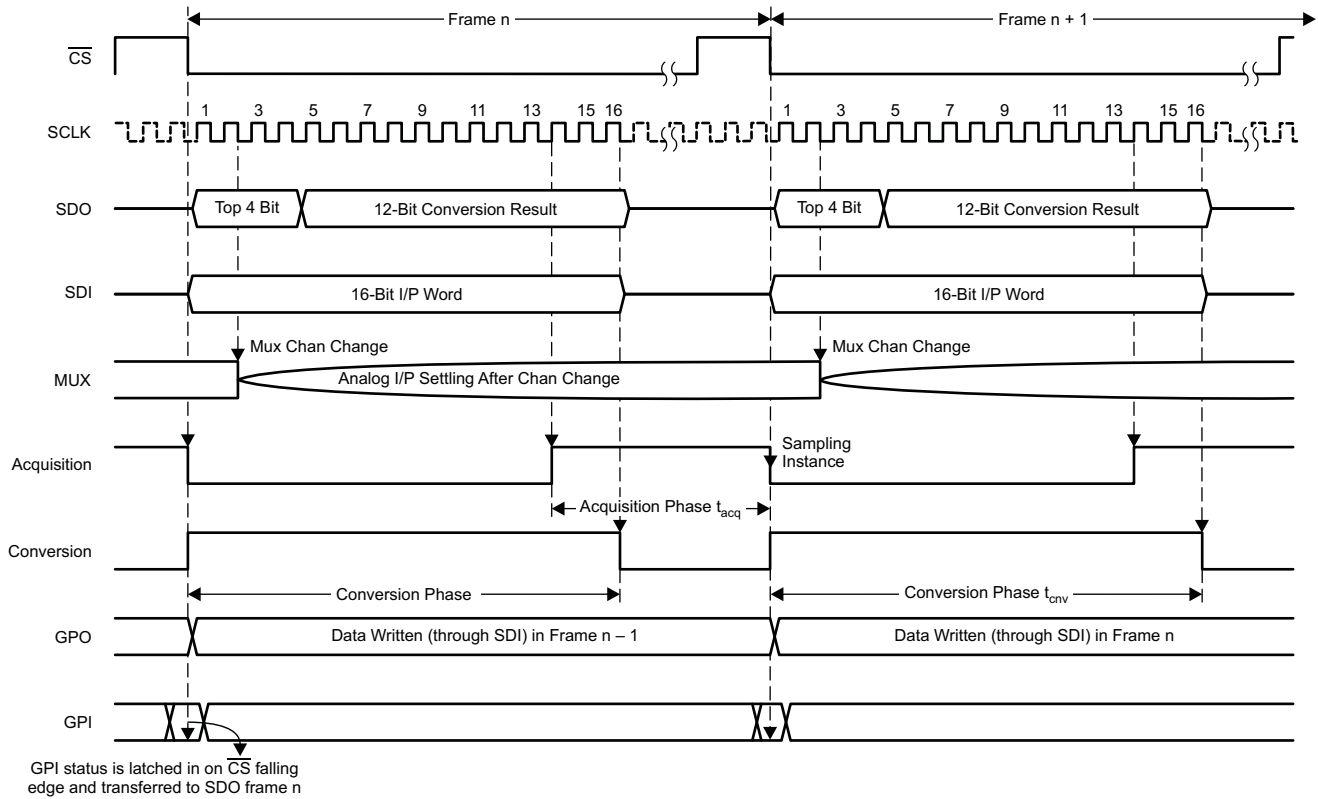


Figure 1. Device Operation Timing Diagram

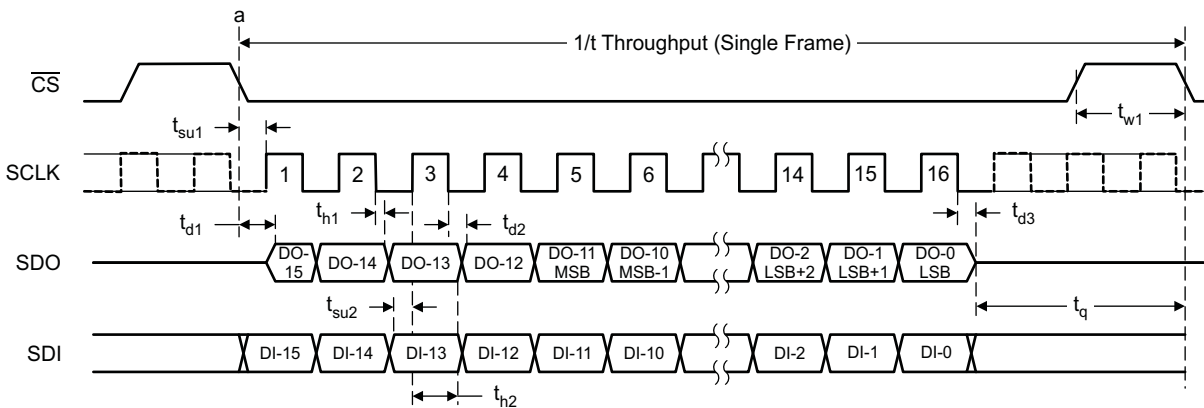


Figure 2. Serial Interface Timing Diagram for 12-Bit Devices (ADS7950/51/52/53)

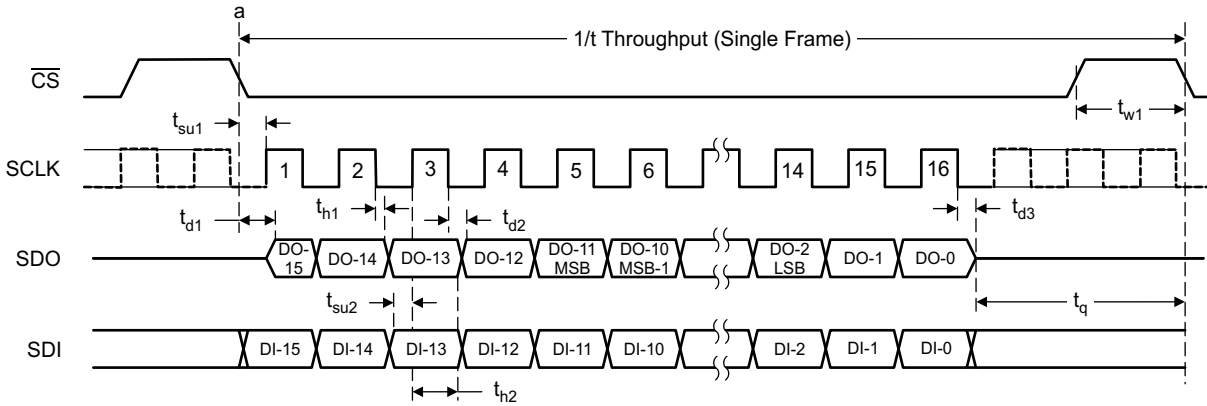


Figure 3. Serial Interface Timing Diagram for 10-Bit Devices (ADS7954/55/56/57)

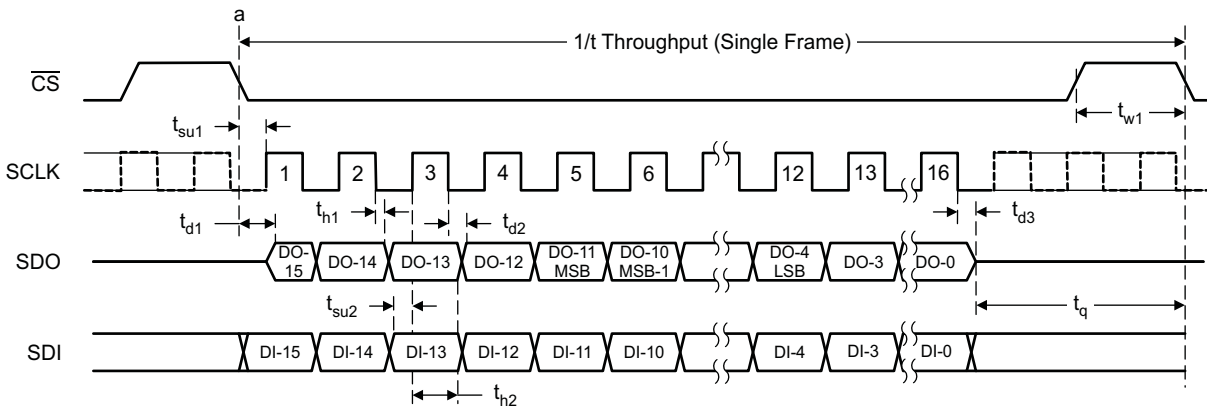


Figure 4. Serial Interface Timing Diagram for 8-Bit Devices (ADS7958/59/60/61)

7.10 Typical Characteristics (All ADS79xx Family Devices)

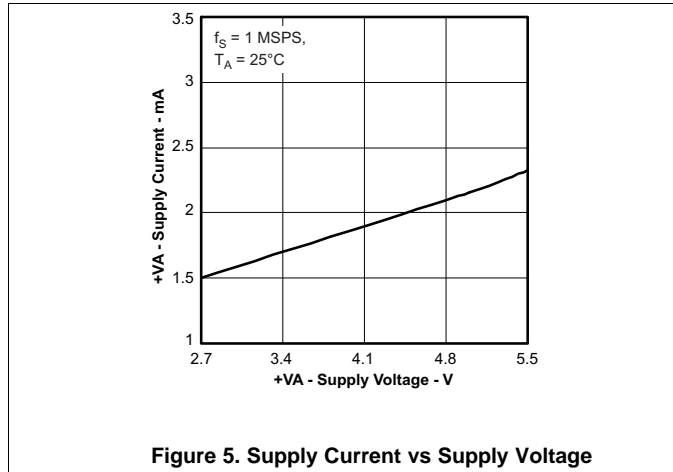


Figure 5. Supply Current vs Supply Voltage

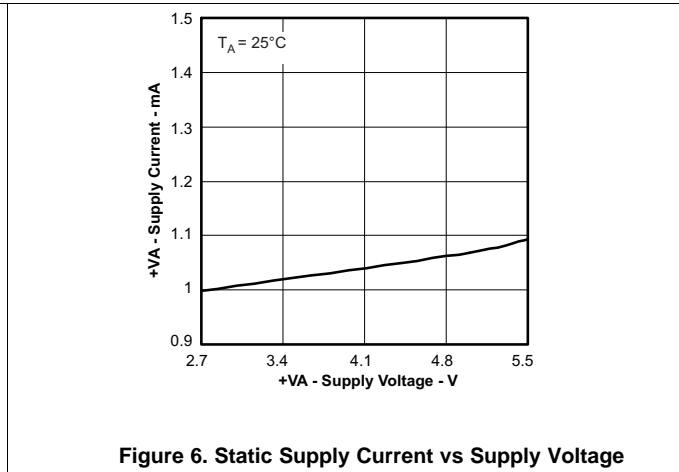


Figure 6. Static Supply Current vs Supply Voltage

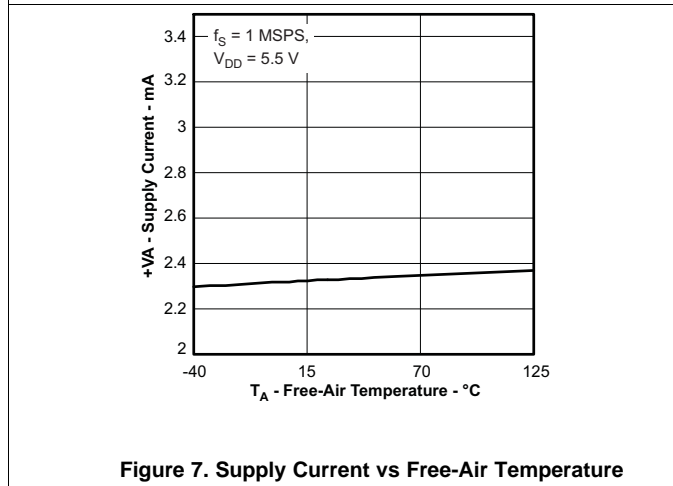


Figure 7. Supply Current vs Free-Air Temperature

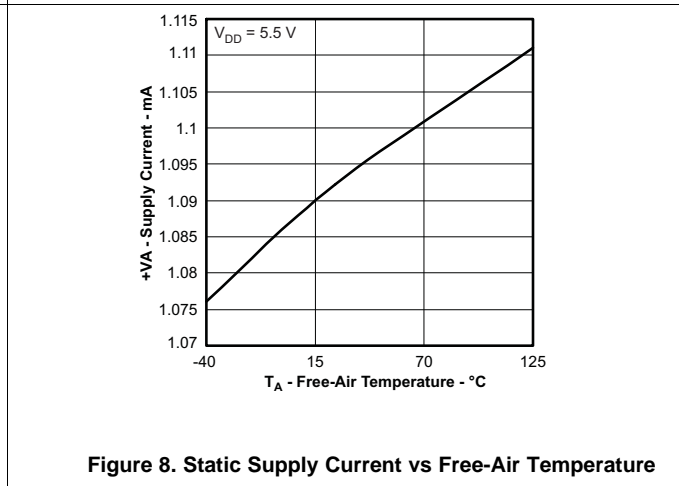


Figure 8. Static Supply Current vs Free-Air Temperature

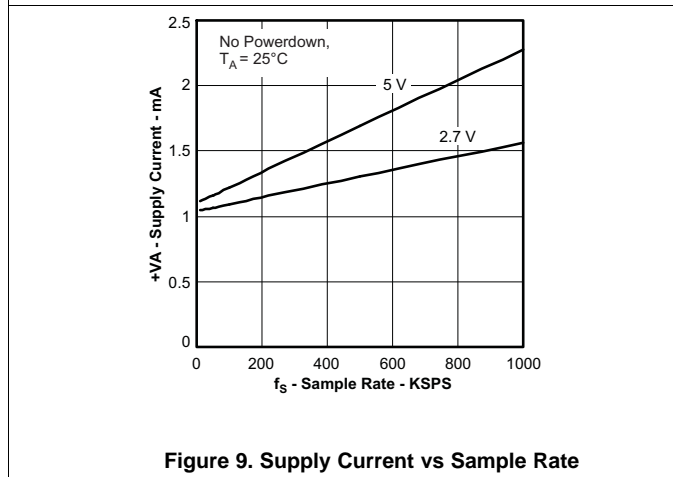


Figure 9. Supply Current vs Sample Rate

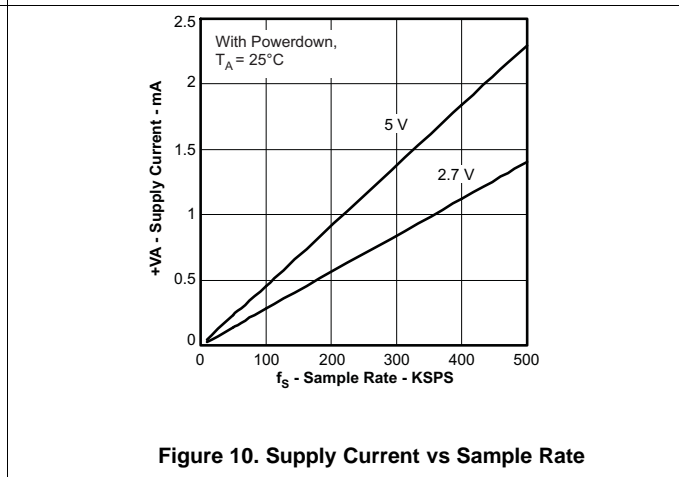


Figure 10. Supply Current vs Sample Rate

7.11 Typical Characteristics (12-Bit Devices Only)

Variations for 10-bit and 8-bit devices are too small to be illustrated through the characteristic curves

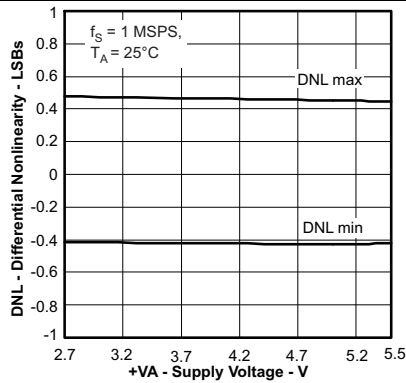


Figure 11. Differential Nonlinearity vs Supply Voltage

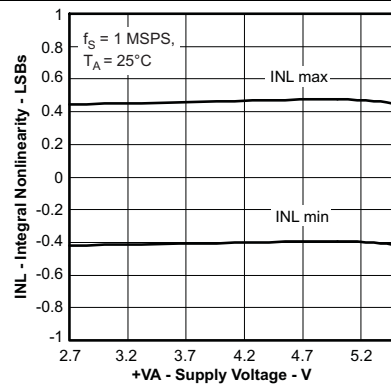


Figure 12. Integral Nonlinearity vs Supply Voltage

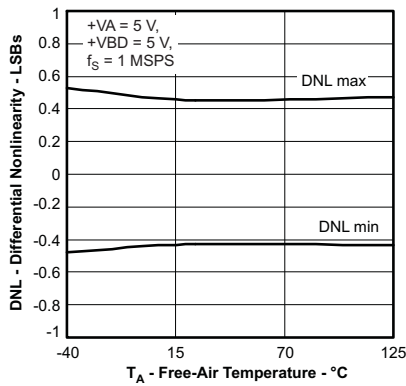


Figure 13. Differential Nonlinearity vs Free-Air Temperature

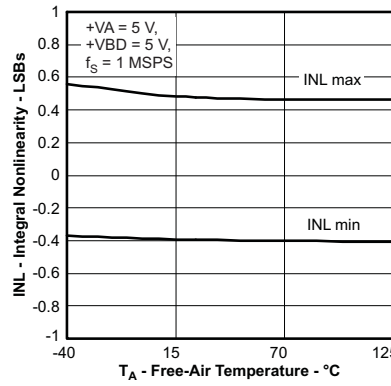


Figure 14. Integral Nonlinearity vs Free-Air Temperature

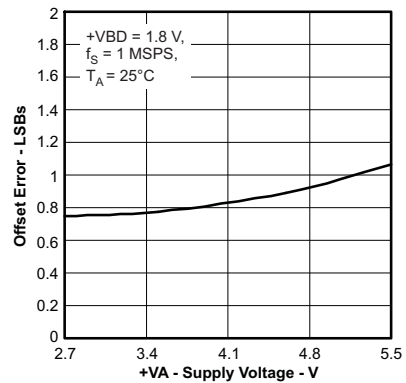


Figure 15. Offset Error vs Supply Voltage

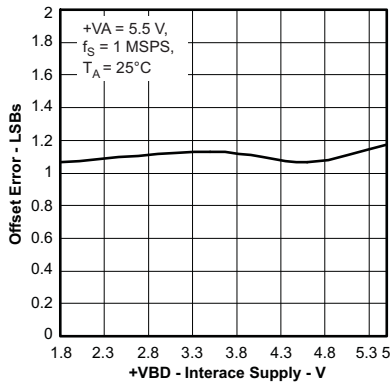


Figure 16. Offset Error vs Interface Supply Voltage

Typical Characteristics (12-Bit Devices Only) (continued)

Variations for 10-bit and 8-bit devices are too small to be illustrated through the characteristic curves

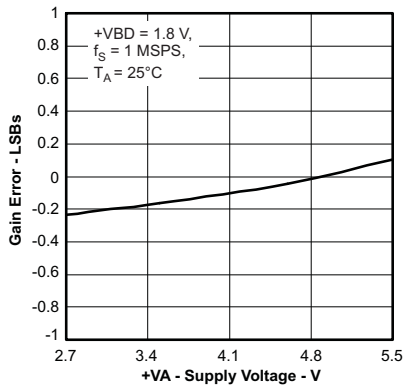


Figure 17. Gain Error vs Supply Voltage

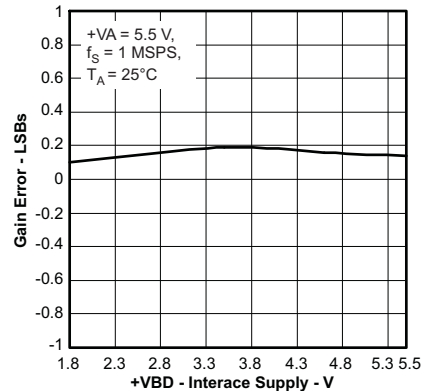


Figure 18. Gain Error vs Interface Supply Voltage

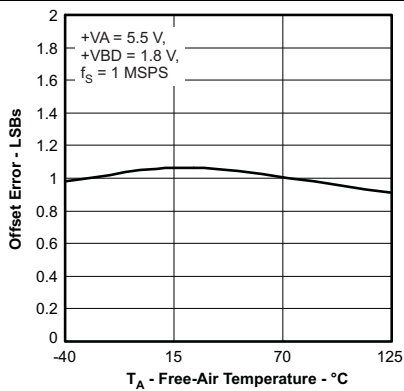


Figure 19. Offset Error vs Free-Air Temperature

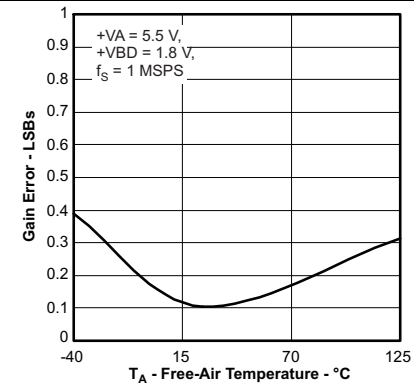


Figure 20. Gain Error vs Free-Air Temperature

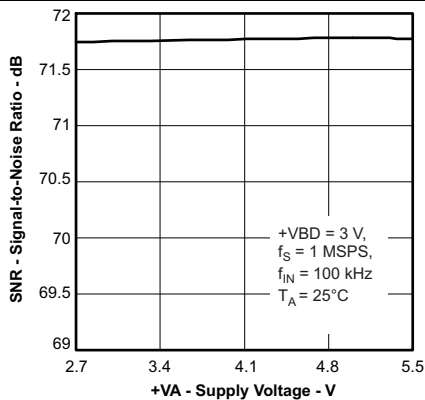


Figure 21. Signal-to-Noise Ratio vs Supply Voltage

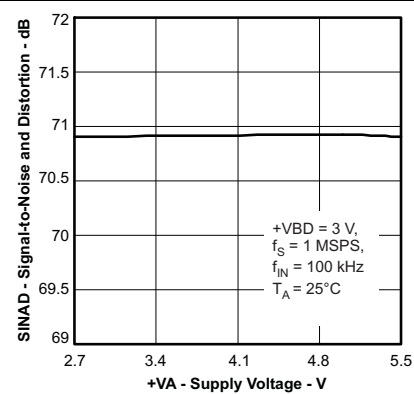


Figure 22. Signal-to-Noise + Distortion vs Supply Voltage

Typical Characteristics (12-Bit Devices Only) (continued)

Variations for 10-bit and 8-bit devices are too small to be illustrated through the characteristic curves

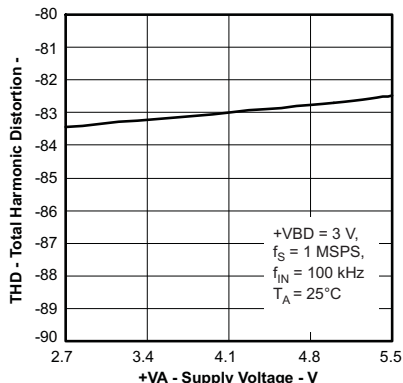


Figure 23. Total Harmonic Distortion vs Supply Voltage

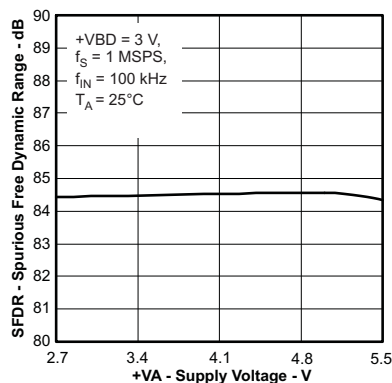


Figure 24. Spurious Free Dynamic Range vs Supply Voltage

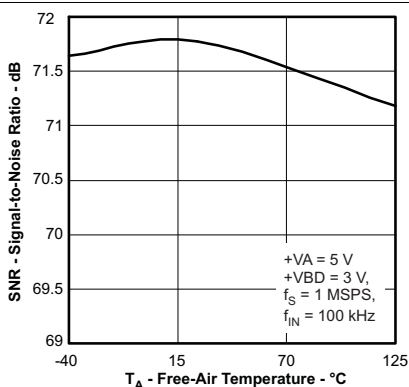


Figure 25. Signal-To-Noise Ratio vs Free-Air Temperature

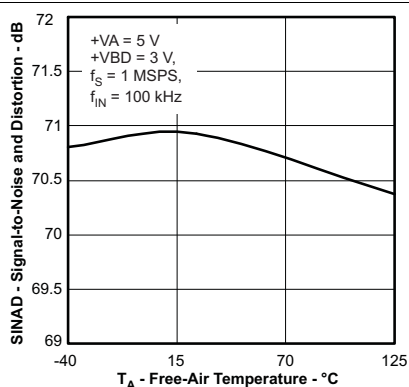


Figure 26. Signal-to-Noise + Distortion vs Free-Air Temperature

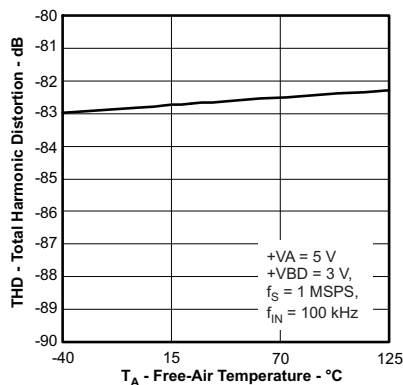


Figure 27. Total Harmonic Distortion vs Free-Air Temperature

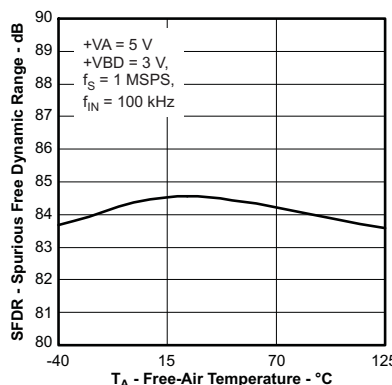


Figure 28. Spurious Free Dynamic Range vs Free-Air Temperature

Typical Characteristics (12-Bit Devices Only) (continued)

Variations for 10-bit and 8-bit devices are too small to be illustrated through the characteristic curves

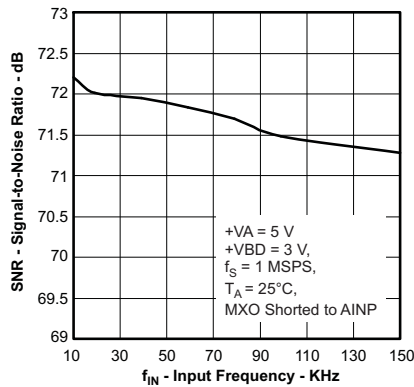


Figure 29. Signal-to-Noise Ratio vs Input Frequency

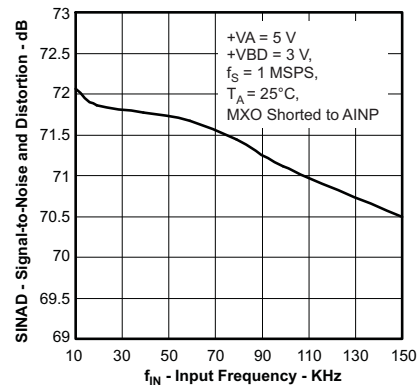


Figure 30. Signal-to-Noise + Distortion vs Input Frequency

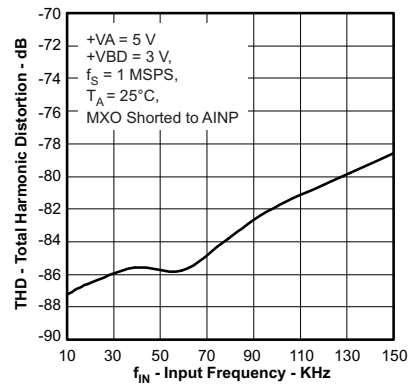


Figure 31. Total Harmonic Distortion vs Input Frequency

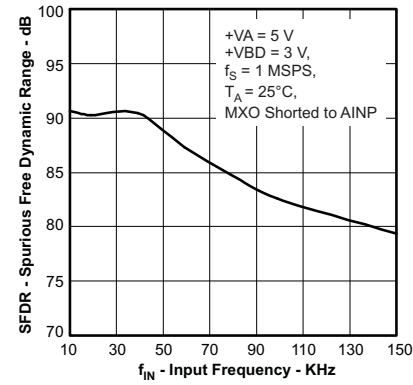


Figure 32. Spurious Free Dynamic Range vs Input Frequency

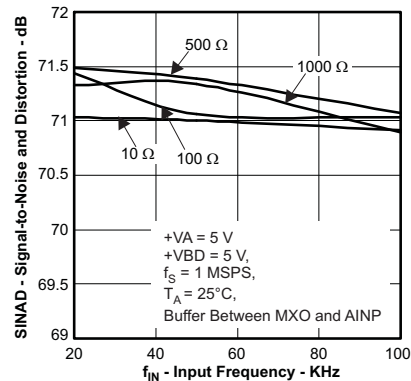


Figure 33. Signal-to-Noise + Distortion vs Input Frequency (Across Different Source Resistance Values)

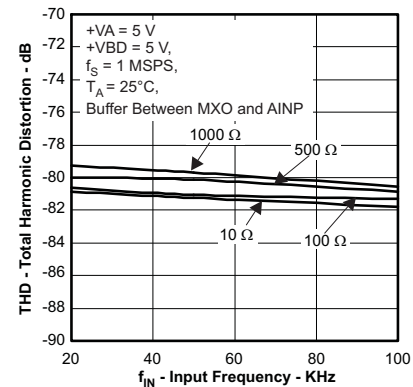


Figure 34. Total Harmonic Distortion vs Input Frequency (Across Different Source Resistance Values)

Typical Characteristics (12-Bit Devices Only) (continued)

Variations for 10-bit and 8-bit devices are too small to be illustrated through the characteristic curves

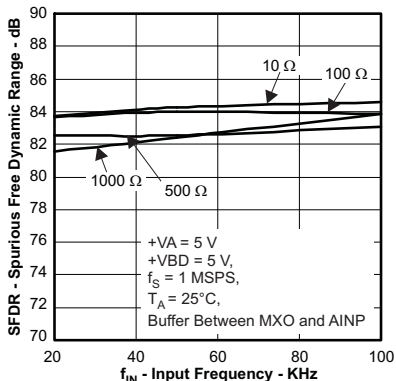


Figure 35. Spurious Free Dynamic Range vs Input Frequency (Across Different Source Resistance Values)

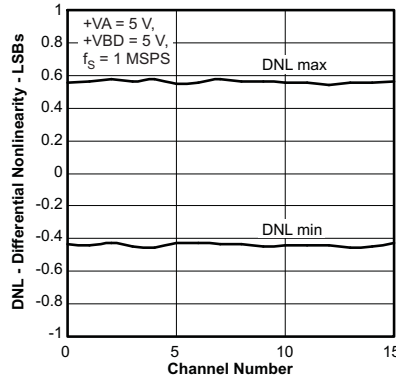


Figure 36. Differential Nonlinearity Variation Across Channels

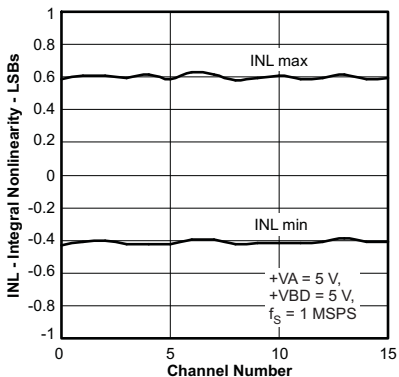


Figure 37. Integral Nonlinearity Variation Across Channels

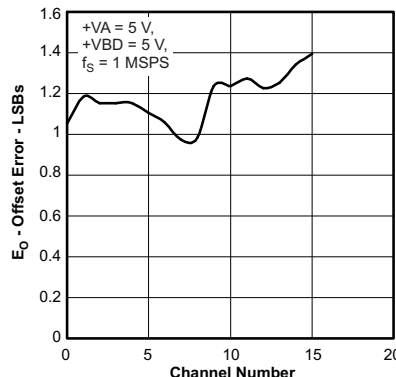


Figure 38. Offset Error Variation Across Channels

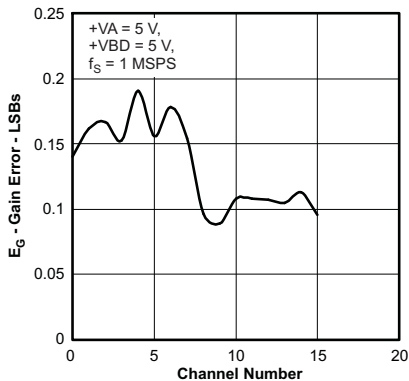


Figure 39. Gain Error Variation Across Channels

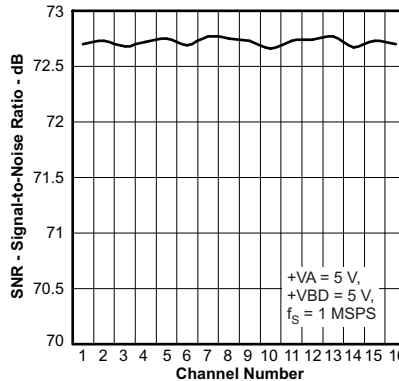


Figure 40. Signal-to-Noise Ratio Variation Across Channels

Typical Characteristics (12-Bit Devices Only) (continued)

Variations for 10-bit and 8-bit devices are too small to be illustrated through the characteristic curves

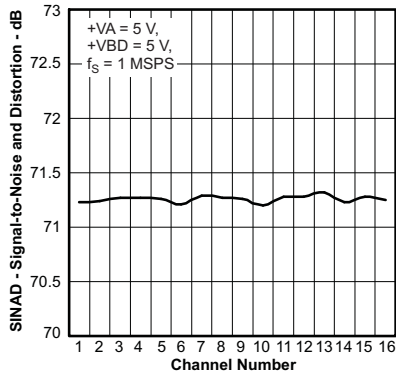


Figure 41. Signal-to-Noise + Distortion Variation Across Channels

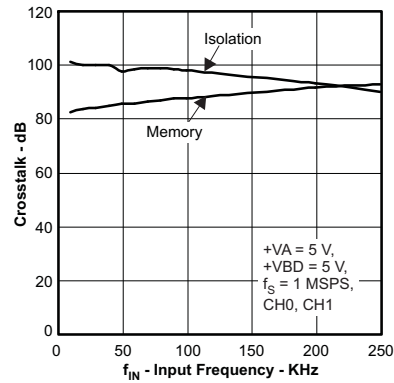


Figure 42. Crosstalk vs Input Frequency

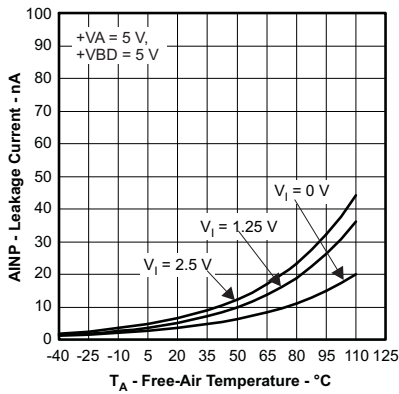


Figure 43. Input Leakage Current vs Free-Air Temperature

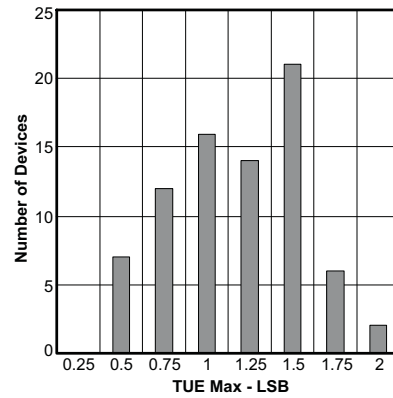


Figure 44. Total Unadjusted Error (TUE Maximum)

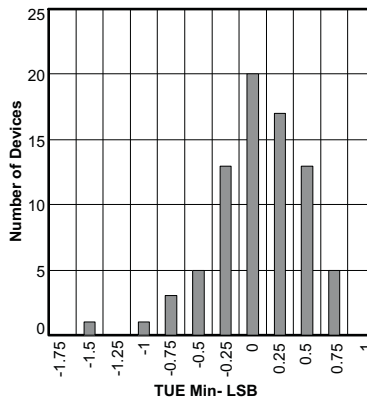
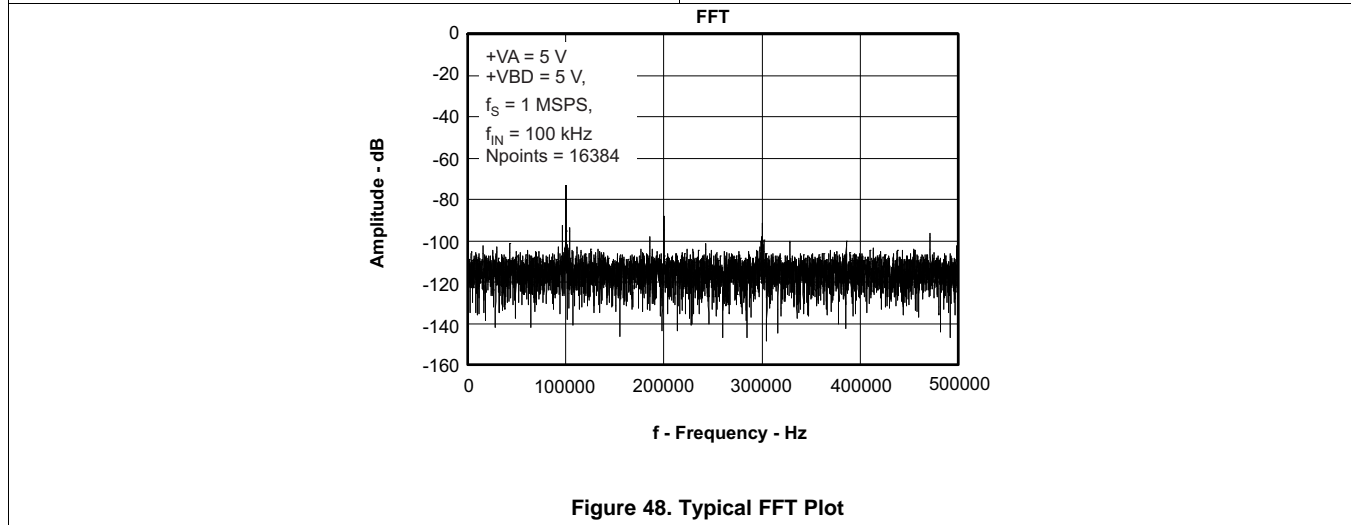
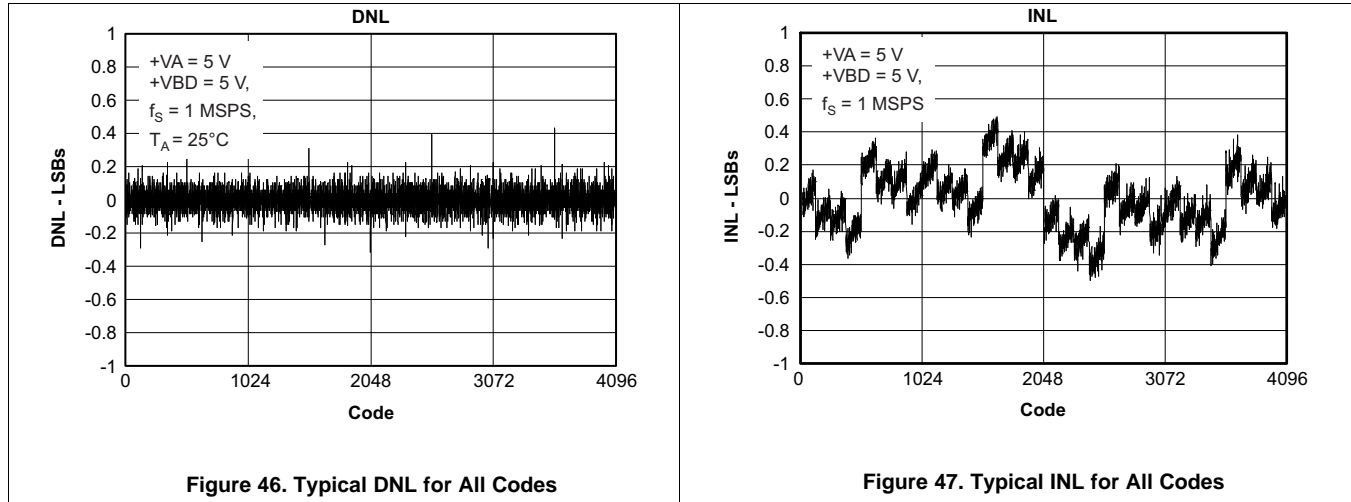


Figure 45. Total Unadjusted Error (TUE Minimum)

7.12 Typical Characteristics (12-Bit Devices Only)



8 Detailed Description

8.1 Overview

The ADS7950 to ADS7961 are 12-, 10-, 8-bit multichannel pin-compatible devices. The ADS79xx is a family of 12-, 10-, 8-bit, high-speed, low-power, successive approximation register (SAR) analog-to-digital converter (ADC) that uses an external reference. The architecture is based on charge redistribution, which inherently includes a sample/hold function. The analog inputs to the ADS79xx are provided to CHX input channels. All input channels share a common analog ground AGND. ADS79xx has multiplexer breakout feature which allows user to connect the signal conditioning circuit between multiplexer output (MXO) and ADC input (AINP). This feature enables use of common signal conditioning block for the input signal which exhibit similar performance characteristics. ADS79xx can be programmed to select a channel manually or can be programmed into the auto channel select mode to sweep through the input channels automatically.

Figure 1, Figure 2, Figure 3, and Figure 4 show device operation timing. Device operation is controlled with \overline{CS} , SCLK, and SDI. The device outputs its data on SDO.

Each frame begins with the falling edge of \overline{CS} . With the falling edge of \overline{CS} , the input signal from the selected channel is sampled, and the conversion process is initiated. The device outputs data while the conversion is in progress. The 16-bit data word contains a 4-bit channel address, followed by a 12-bit conversion result in MSB first format. There is an option to read the GPIO status instead of the channel address. (Refer to Table 1, Table 2, and Table 5 for more details.)

The device selects a new multiplexer channel on the second SCLK falling edge. The acquisition phase starts on the fourteenth SCLK rising edge. On the next \overline{CS} falling edge the acquisition phase will end, and the device starts a new frame.

The TSSOP packaged devices have four *General Purpose IO* (GPIO) pins while QFN versions have only one GPIO. These four pins can be individually programmed as GPO or GPI. It is also possible to use them for preassigned functions, refer to Table 11. GPO data can be written into the device through the SDI line. The device refreshes the GPO data on the \overline{CS} falling edge as per the SDI data written in previous frame.

Similarly the device latches GPI status on the \overline{CS} falling edge and outputs the GPI data on the SDO line (if GPI read is enabled by writing DI04=1 in the previous frame) in the same frame starting with the \overline{CS} falling edge.

The falling edge of \overline{CS} clocks out DO15 (first bit of the four bit channel address), and remaining address bits are clocked out on every falling edge of SCLK until the third falling edge. The conversion result MSB is clocked out on the 4th SCLK falling edge and LSB on the 15th/13th/11th falling edge respectively for 12/10/8-bit devices. On the 16th falling edge of SCLK, SDO goes to the 3-state condition. The conversion ends on the 16th falling edge of SCLK. \overline{CS} can be asserted (pulled high) only after 16 clocks have elapsed.

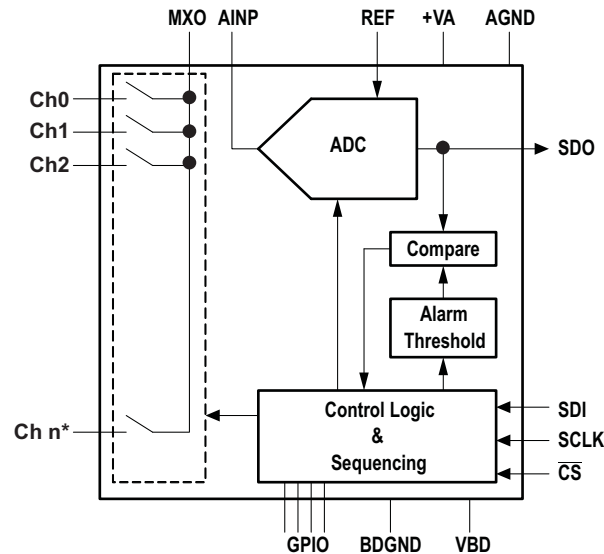
The device reads a sixteen bit word on the SDI pin while it outputs the data on the SDO pin. SDI data is latched on every rising edge of SCLK starting with the 1st clock as shown in Figure 2, Figure 3, and Figure 4.

\overline{CS} can be asserted (pulled high) only after 16 clocks have elapsed.

The device has two (high and low) programmable alarm thresholds per channel. If the input crosses these limits; the device flags out an alarm on GPIO0/GPIO1 depending on the GPIO program register settings (refer to Table 11). The alarm is asserted (under the alarm conditions) on the 12th falling edge of SCLK in the same frame when a data conversion is in progress. The alarm output is reset on the 10th falling edge of SCLK in the next frame.

The device offers a power-down feature to save power when not in use. There are two ways to powerdown the device. It can be powered down by writing DI05 = 1 in the mode control register (refer to Table 1, Table 2, and Table 5); in this case the device powers down on the 16th falling edge of SCLK in the next data frame. Another way to powerdown the device is through GPIO in the case of the TSSOP packaged devices. GPIO3 can act as the \overline{PD} input (refer to Table 11 to assign this functionality to GPIO3). This is an asynchronous and active low input. The device powers down instantaneously after GPIO3 (\overline{PD}) = 0. The device will power up again on the \overline{CS} falling edge with DI05 = 0 in the mode control register and GPIO3 (\overline{PD}) = 1.

8.2 Functional Block Diagram



NOTE: n^* is number of channels (16,12,8, or 4) depending on the device from the ADS79xx product family.

NOTE: There are 4 GPIOs in the TSSOP package and 1 GPIO in the QFN package..

8.3 Feature Description

8.3.1 Reference

The ADS79xx can operate with an external $2.5\text{-V} \pm 10\text{-mV}$ reference. A clean, low noise, well-decoupled reference voltage on the REFP pin is required to ensure good performance of the converter. A low noise band-gap reference like the REF5025 can be used to drive this pin. A $10\text{-}\mu\text{F}$ ceramic decoupling capacitor is required between the REFP and REFM pins of the converter. The capacitor should be placed as close as possible to the pins of the device.

8.3.2 Power Saving

The ADS79xx devices offer a power-down feature to save power when not in use. There are two ways to power down the device. It can be powered down by writing $\text{DI05} = 1$ in the Mode Control register (refer to [Table 1](#), [Table 2](#) and [Table 5](#)); in this case the device powers down on the 16th falling edge of SCLK in the next data frame. Another way to powerdown the device is through GPIO. GPIO3 can act as a PD input (refer to [Table 11](#), for assigning this functionality to GPIO3). This is an asynchronous and active low input. The device powers down instantaneously after $\text{GPIO3} (\overline{\text{PD}}) = 0$. The device will powerup again on the $\overline{\text{CS}}$ falling edge while $\text{DI05} = 0$ in the Mode Control register and $\text{GPIO3} (\overline{\text{PD}}) = 1$.

8.4 Device Functional Modes

8.4.1 Channel Sequencing Modes

There are three modes for channel sequencing, namely *Manual mode*, *Auto-1 mode*, *Auto-2 mode*. Mode selection is done by writing into the *Mode Control Register* (refer to [Table 1](#), [Table 2](#), and [Table 5](#)). A new multiplexer channel is selected on the second falling edge of SCLK (as shown in [Figure 1](#)) in all three modes.

Manual mode: When configured to operate in Manual mode, the next channel to be selected is programmed in each frame and the device selects the programmed channel in the next frame. On powerup or after reset the default channel is 'Channel-0' and the device is in Manual mode.

Auto-1 mode: In this mode the device scans pre-programmed channels in ascending order. A new multiplexer channel is selected every frame on the second falling edge of SCLK. There is a separate Program Register for pre-programming the channel sequence. [Table 3](#) and [Table 4](#) show Auto-1 'program register' settings.

Device Functional Modes (continued)

Once programmed the device retains 'Program Register settings until the device is powered down, reset, or reprogrammed. It is allowed to exit and re-enter the Auto-1 mode any number of times without disturbing 'program register' settings.

The Auto-1 program register is reset to FFFF/FFF/FF/F hex for the 16-, 12-, 8-, 4 channel devices respectively upon device powerup or reset; implying the device scans all channels in ascending order.

Auto-2 mode: In this mode the user can configure the program register to select the last channel in the scan sequence. The device scans all channels from channel 0 up to and including the last channel in ascending order. The multiplexer channel is selected every frame on the second falling edge of SCLK. There is a separate 'program register' for pre-programming of the last channel in the sequence (multiplexer depth). [Table 6](#) lists the 'Auto-2 prog' register settings for selection of the last channel in the sequence.

Once programmed the device retains program register settings until the device is powered down, reset, or reprogrammed. It is allowed to exit and re-enter Auto-2 mode any number of times, without disturbing the 'program register' settings.

On powerup or reset the bits D9-D6 of the Auto-2 program register are reset to F/B/7/3 hex for the 16/12/8/4 channel devices respectively; implying the device scans all channels in ascending order.

8.4.2 Device Programming and Mode Control

The following section describes device programming and mode control. These devices feature two types of registers to configure and operate the devices in different modes. These registers are referred as 'Configuration Registers'. There are two types of 'Configuration Registers' namely 'Mode Control Registers' and 'Program Registers'.

8.4.2.1 Mode Control Register

A 'Mode Control Register' is configured to operate the device in one of three channel sequencing modes, namely Manual mode, Auto-1 Mode, Auto-2 Mode. It is also used to control user programmable features like range selection, device power-down control, GPIO read control, and writing output data into the GPIO.

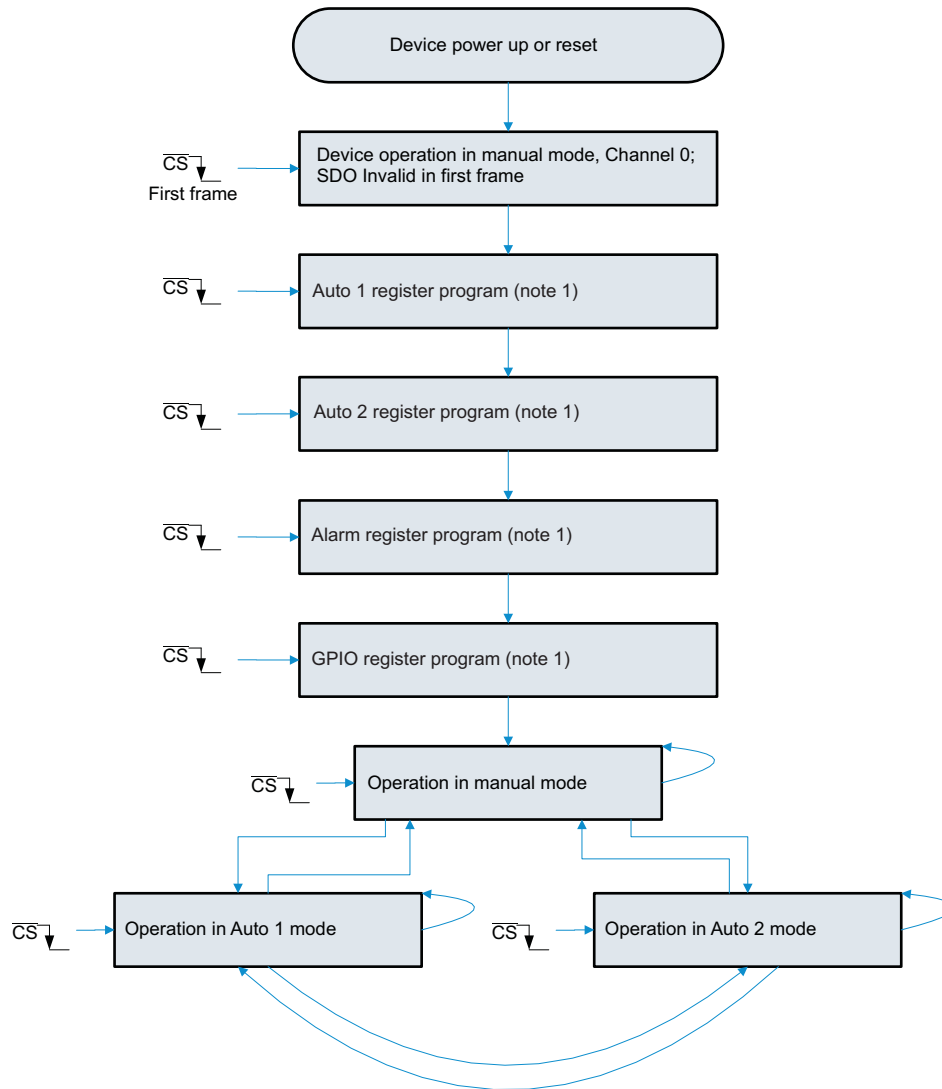
8.4.2.2 Program Registers

The 'Program Registers' are used for device configuration settings and are typically programmed once on powerup or after device reset. There are different program registers such as 'Auto-1 mode programming' for pre-programming the channel sequence, 'Auto-2 mode programming' for selection of the last channel in the sequence, 'Alarm programming' for all 16 channels (or 12, 8, 4 channels depending on the device) and GPIO for individual pin configuration as GPI or GPO or a pre-assigned function.

8.4.3 Device Power-Up Sequence

The device power-up sequence is shown in [Figure 49](#). By default, the Mode Control Register is configured for manual mode and the default channel is channel 0. As explained previously, these devices offer Program Registers to configure user programmable features like GPIOs, Alarms, and to pre-program the channel sequence for Auto modes. At 'power up or on reset' these registers are set to the default values listed in [Table 1](#) to [Table 11](#). On power up or after reset it is required to program Mode Control Register and Program Register to required mode of operation. Once configured; the device is ready to use in any of the three channel sequencing modes namely Manual, Auto-1, and Auto-2.

Device Functional Modes (continued)



- (1) The device continues its operation in manual mode channel 0 throughout the programming sequence and outputs valid conversion results. It is possible to change channel, range, GPIO by inserting extra frames in between two programming blocks. It is also possible to bypass any programming block if the user does not intend to use that feature.
- (2) It is possible to reprogram the device at any time during operation, regardless of what mode the device is in. During programming the device continues its operation in whatever mode it is in and outputs valid data.

Figure 49. Device Power-Up Sequence

8.4.4 Operating in Manual Mode

The flowchart in [Figure 50](#) illustrates the steps involved in operating in manual channel sequencing mode. [Table 1](#) lists the mode control register settings for manual mode. There are no program registers in manual mode.

Device Functional Modes (continued)

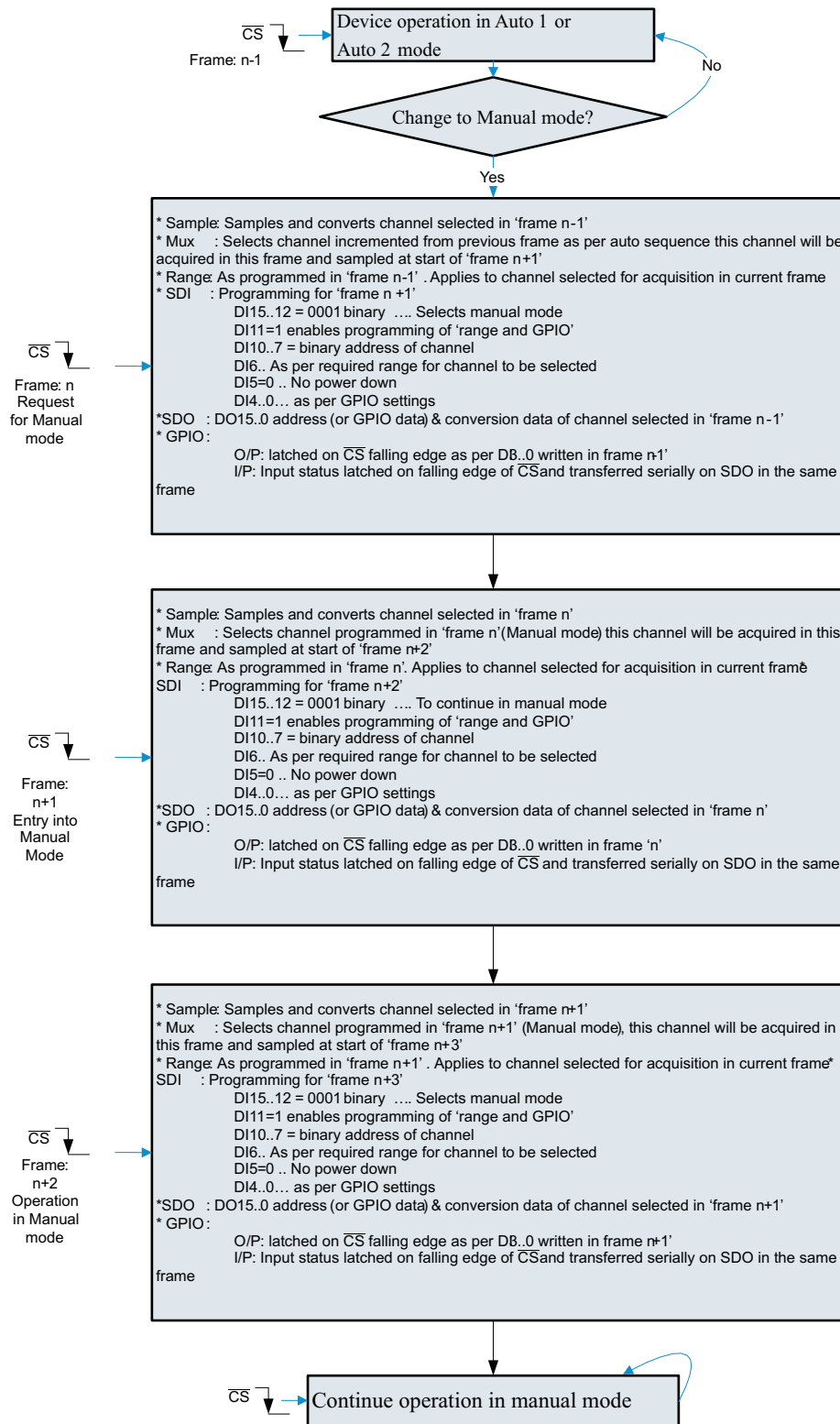


Figure 50. Entering and Running in Manual Channel Sequencing Mode

Device Functional Modes (continued)

Figure 51 shows an example in which manual mode is used to scan channels 4, 7, and 9. The command to select channel 4 (CH4) is issued in the Nth frame and the data corresponding to CH4 is available in the (N + 2)th frame. Internally, the SDI command is parsed and on the rising edge of CS of the (N+1)th frame and the MUX switches accordingly on the second falling edge of SCLK in this frame. On the rising edge of CS of the (N+2)th frame, the input signal for CH4 is sampled and the ADC sends the conversion data in this third frame. The device follows the same steps and the ADC sends the conversion data for CH7 and CH9 in the subsequent two frames.

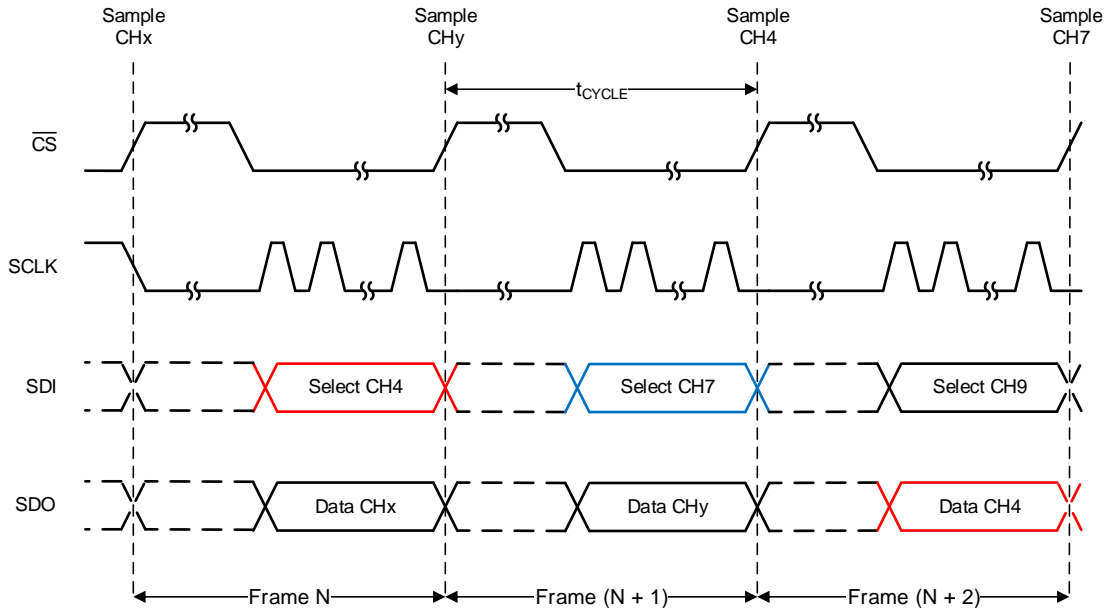


Figure 51. Example Manual Mode Timing Diagram

Table 1. Mode Control Register Settings for Manual Mode

| BITS | RESET STATE | LOGIC STATE | FUNCTION | | |
|---------|-------------|---|--|----------------------|----------------------|
| DI15-12 | 0001 | 0001 | Selects Manual Mode | | |
| DI11 | 0 | 1 | Enables programming of bits DI06-00. | | |
| | | 0 | Device retains values of DI06-00 from the previous frame. | | |
| DI10-07 | 0000 | This four bit data represents the address of the next channel to be selected in the next frame. DI10: MSB and DI07: LSB. For example, 0000 represents channel- 0, 0001 represents channel-1 and so forth. | | | |
| DI06 | 0 | 0 | Selects 0 to V _{REF} input range (Range 1) | | |
| | | 1 | Selects 0 to 2xV _{REF} input range (Range 2) | | |
| DI05 | 0 | 0 | Device normal operation (no powerdown) | | |
| | | 1 | Device powers down on 16th SCLK falling edge | | |
| DI04 | 0 | 0 | SDO outputs current channel address of the channel on DO15..12 followed by 12 bit conversion result on DO11..00. | | |
| | | 1 | GPIO3-GPIO0 data (both input and output) is mapped onto DO15-DO12 in the order shown below. Lower data bits DO11-DO00 represent 12-bit conversion result of the current channel. | | |
| | | DO15 | DO14 | DO13 | DO12 |
| | | GPIO3 ⁽¹⁾ | GPIO2 ⁽¹⁾ | GPIO1 ⁽¹⁾ | GPIO0 ⁽¹⁾ |
| DI03-00 | 0000 | GPIO data for the channels configured as output. Device will ignore the data for the channel which is configured as input. SDI bit and corresponding GPIO information is given below | | | |
| | | DI03 | DI02 | DI01 | DI00 |
| | | GPIO3 ⁽¹⁾ | GPIO2 ⁽¹⁾ | GPIO1 ⁽¹⁾ | GPIO0 ⁽¹⁾ |

(1) GPIO 1 to 3 are available only in TSSOP packaged devices. QFN device offers GPIO 0 only.

8.4.5 Operating in Auto-1 Mode

Figure 52 illustrates the steps involved in entering and operating in Auto-1 Channel Sequencing mode. Table 2 lists the Mode Control Register settings for Auto-1 mode.

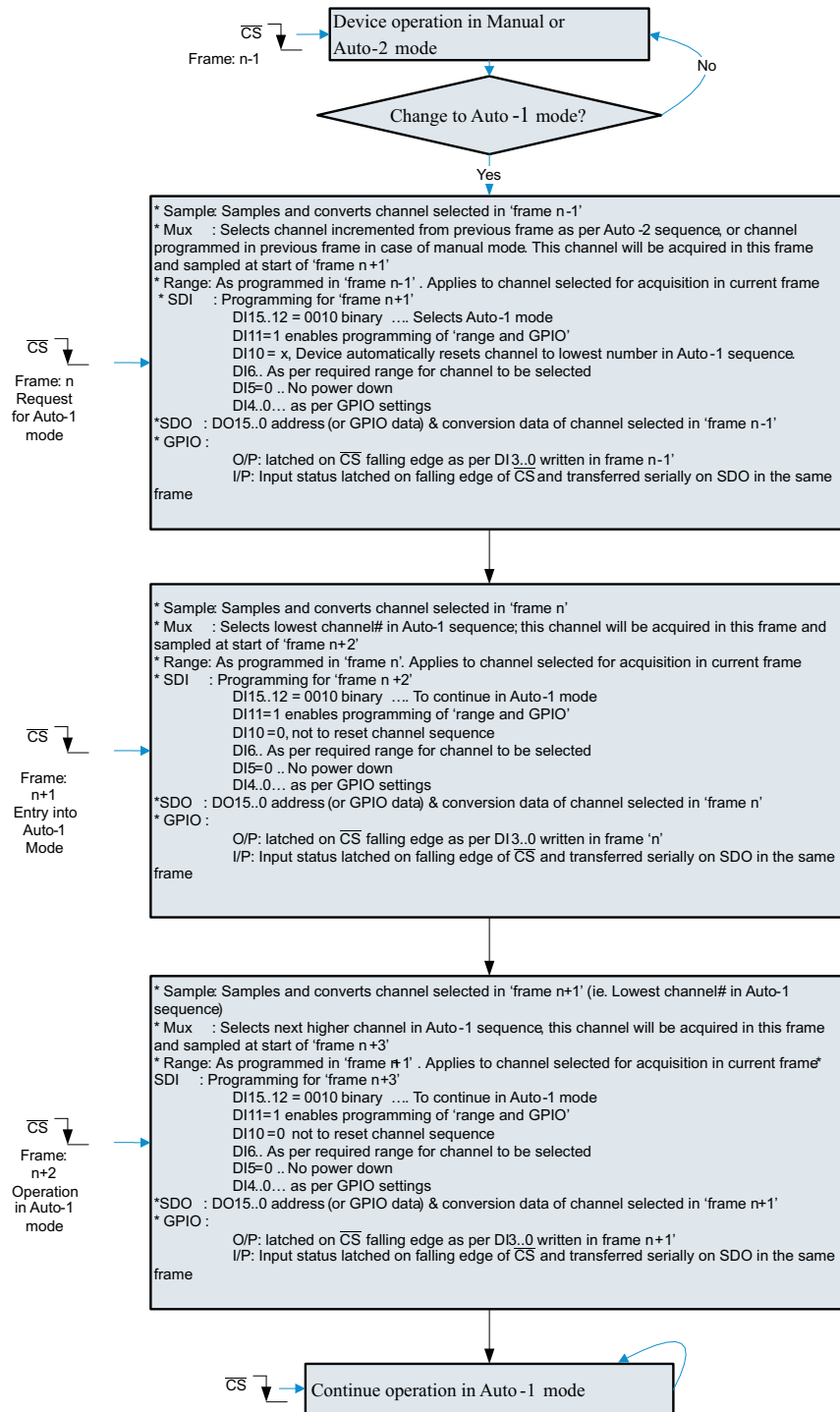


Figure 52. Entering and Running in Auto-1 Channel Sequencing Mode

Consider a case where Auto-1 mode is selected to scan channels 2 (CH2), 5 (CH5), and 6 (CH6) as represented in Figure 53. The program register for Auto-1 mode must be programmed as described in Figure 53 before entering into this auto sequencing mode. The device enters into Auto-1 mode on receiving the Auto-1 mode command in the Nth frame. This step causes the device to find the first enabled channel in ascending order and switch the MUX for CH2 in the (N+1)th frame. In the (N+2)th frame, the ADC samples the signal on CH2, shifts out the conversion results, and the MUX also internally switches to CH5. In the (N+3)th frame, the ADC samples and shifts out the conversion result for CH5 and the MUX also internally switches to CH6. This process repeats until the last enabled channel is reached, in which case the process loops back to the first enabled channel. Entering Auto-1 mode from any other mode also causes the device to restart from the first enabled channel. However, modifying the contents of the Auto-1 mode program register while operating in Auto-1 mode causes the device to scan for the next enabled channel.

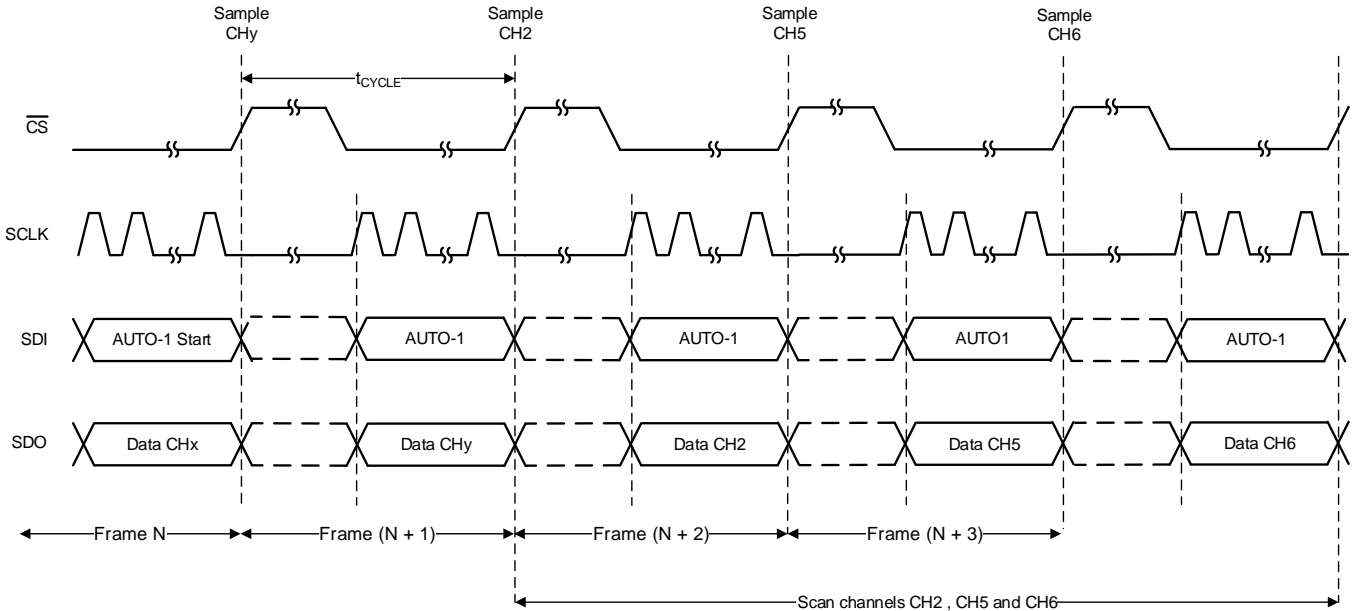


Figure 53. Example Auto-1 Mode Timing Diagram

**ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955
ADS7956, ADS7957, ADS7958, ADS7959, ADS7960, ADS7961**

SLAS605C –JUNE 2008–REVISED JULY 2018

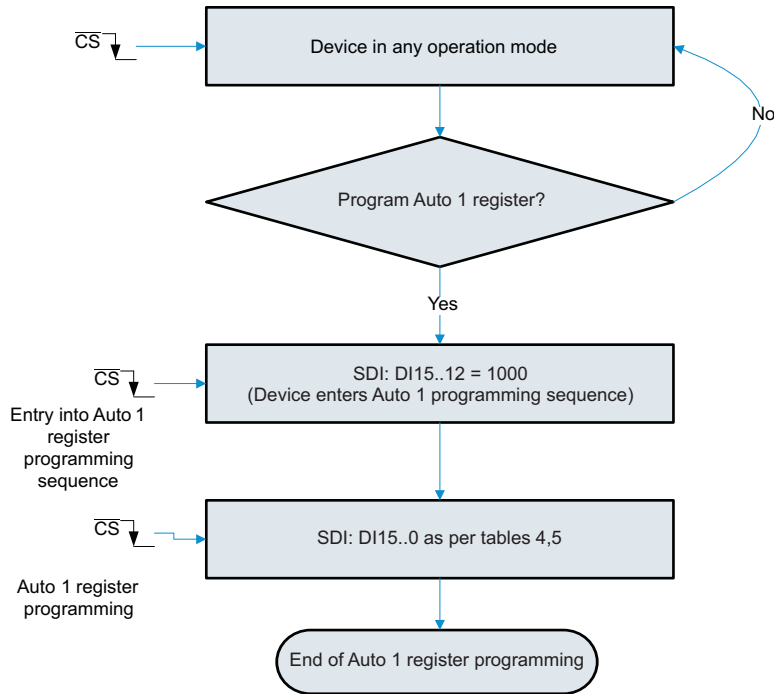
www.ti.com

Table 2. Mode Control Register Settings for Auto-1 Mode

| BITS | RESET STATE | LOGIC STATE | FUNCTION | | |
|-------------|--------------------|--|--|----------------------|----------------------|
| DI15-12 | 0001 | 0010 | Selects Auto-1 Mode | | |
| DI11 | 0 | 1 | Enables programming of bits DI10-00. | | |
| | | 0 | Device retains values of DI10-00 from previous frame. | | |
| DI10 | 0 | 1 | The channel counter is reset to the lowest programmed channel in the Auto-1 Program Register | | |
| | | 0 | The channel counter increments every conversion (No reset) | | |
| DI09-07 | 000 | xxx | Do not care | | |
| DI06 | 0 | 0 | Selects 0 to V_{REF} input range (Range 1) | | |
| | | 1 | Selects 0 to $2xV_{REF}$ input range (Range 2) | | |
| DI05 | 0 | 0 | Device normal operation (no powerdown) | | |
| | | 1 | Device powers down on the 16th SCLK falling edge | | |
| DI04 | 0 | 0 | SDO outputs current channel address of the channel on DO15..12 followed by 12-bit conversion result on DO11..00. | | |
| | | 1 | GPIO3-GPIO0 data (both input and output) is mapped onto DO15-DO12 in the order shown below. Lower data bits DO11-DO00 represent 12-bit conversion result of the current channel. | | |
| | | DO15 | DO14 | DO13 | DO12 |
| | | GPIO3 ⁽¹⁾ | GPIO2 ⁽¹⁾ | GPIO1 ⁽¹⁾ | GPIO0 ⁽¹⁾ |
| DI03-00 | 0000 | GPIO data for the channels configured as output. Device will ignore the data for the channel which is configured as input. SDI bit and corresponding GPIO information is given below | | | |
| | | DI03 | DI02 | DI01 | DI00 |
| | | GPIO3 ⁽¹⁾ | GPIO2 ⁽¹⁾ | GPIO1 ⁽¹⁾ | GPIO0 ⁽¹⁾ |

(1) GPIO 1 to 3 are available only in TSSOP packaged devices. QFN device offers GPIO 0 only.

The Auto-1 Program Register is programmed (once on powerup or reset) to pre-select the channels for the Auto-1 sequence. Auto-1 Program Register programming requires two \overline{CS} frames for complete programming. In the first \overline{CS} frame the device enters the Auto-1 register programming sequence and in the second frame it programs the Auto-1 Program Register. Refer to [Table 2](#), [Table 3](#), and [Table 4](#) for complete details.



NOTE: The device continues its operation in selected mode during programming. SDO is valid, however it is not possible to change the range or write GPIO data into the device during programming.

Figure 54. Auto-1 Register Programming Flowchart

Table 3. Program Register Settings for Auto-1 Mode

| BITS | RESET STATE | LOGIC STATE | FUNCTION |
|----------------|-------------|--------------------|---|
| FRAME 1 | | | |
| DI15-12 | NA | 1000 | Device enters Auto-1 program sequence. Device programming is done in the next frame. |
| DI11-00 | NA | Do not care | |
| FRAME 2 | | | |
| DI15-00 | All 1s | 1 (individual bit) | A particular channel is programmed to be selected in the channel scanning sequence. The channel numbers are mapped one-to-one with respect to the SDI bits; for example, DI15 → Ch15, DI14 → Ch14 ... DI00 → Ch00 |
| | | 0 (individual bit) | A particular channel is programmed to be skipped in the channel scanning sequence. The channel numbers are mapped one-to-one with respect to the SDI bits; for example DI15 → Ch15, DI14 → Ch14 ... DI00 → Ch00 |

Table 4. Mapping of Channels to SDI Bits for 16, 12, 8, 4 Channel Devices

| Device ⁽¹⁾ | SDI BITS | | | | | | | | | | | | | | | |
|-----------------------|----------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| | DI15 | DI14 | DI13 | DI12 | DI11 | DI10 | DI09 | DI08 | DI07 | DI06 | DI05 | DI04 | DI03 | DI02 | DI01 | DI00 |
| 16 Chan | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 |
| 12 Chan | X | X | X | X | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 |
| 8 Chan | X | X | X | X | X | X | X | X | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 | 1/0 |
| 4 Chan | X | X | X | X | X | X | X | X | X | X | X | X | 1/0 | 1/0 | 1/0 | 1/0 |

(1) When operating in Auto-1 mode, the device only scans the channels programmed to be selected.

8.4.6 Operating in Auto-2 Mode

Figure 55 illustrates the steps involved in entering and operating in Auto-2 channel sequencing mode. Table 5 lists the mode control register settings for Auto-2 mode.

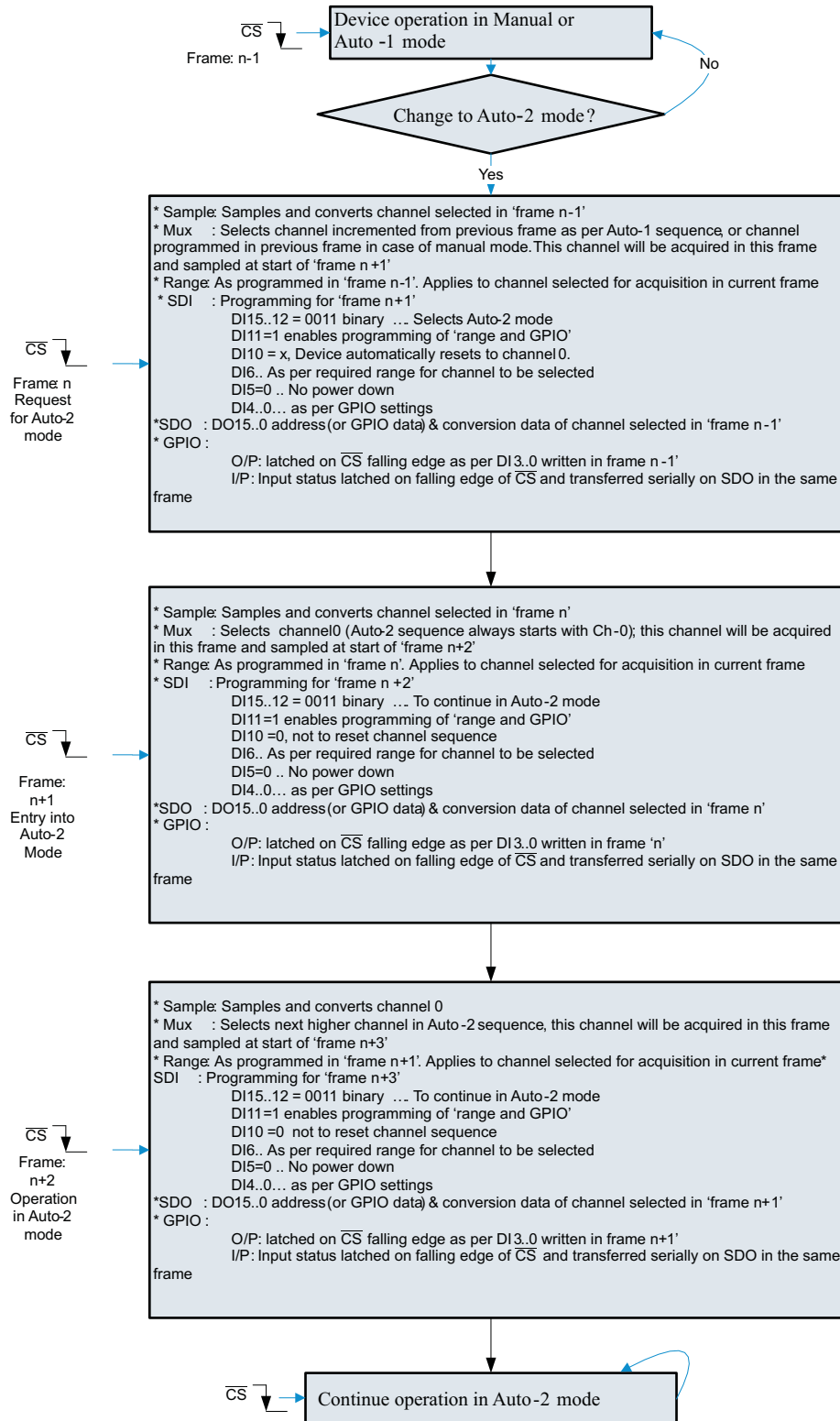


Figure 55. Entering and Running in Auto-2 Channel Sequencing Mode

Figure 56 shows an example in which Auto-2 mode is used to scan channels 0, 1, and 2. Auto-2 mode is selected to scan all channels until channel 2 (CH2) in ascending order by programming the Auto-2 register as described in Figure 56. The device enters Auto-2 mode on receiving the Auto-2 mode command in the Nth frame. This step causes the MUX to switch to CH0 in the (N+1)th frame. In the (N+2)th frame, the ADC samples and shifts out the conversion results for CH0 because the MUX internally switches to CH1. In the (N+3)th frame, the ADC samples and shifts out the conversion result for CH1 and the MUX also switches to CH2, and so on. When this process reaches the maximum selected channel, CH2 in this case, the device returns to CH0 and repeats the cycle as long as the device remains in Auto-2 mode. Entering Auto-2 mode from any other mode also causes the device to restart from CH0. Additionally, modifying the contents of the for Auto-2 program register while operating in Auto-2 also causes the device to scan for restart from CH0.

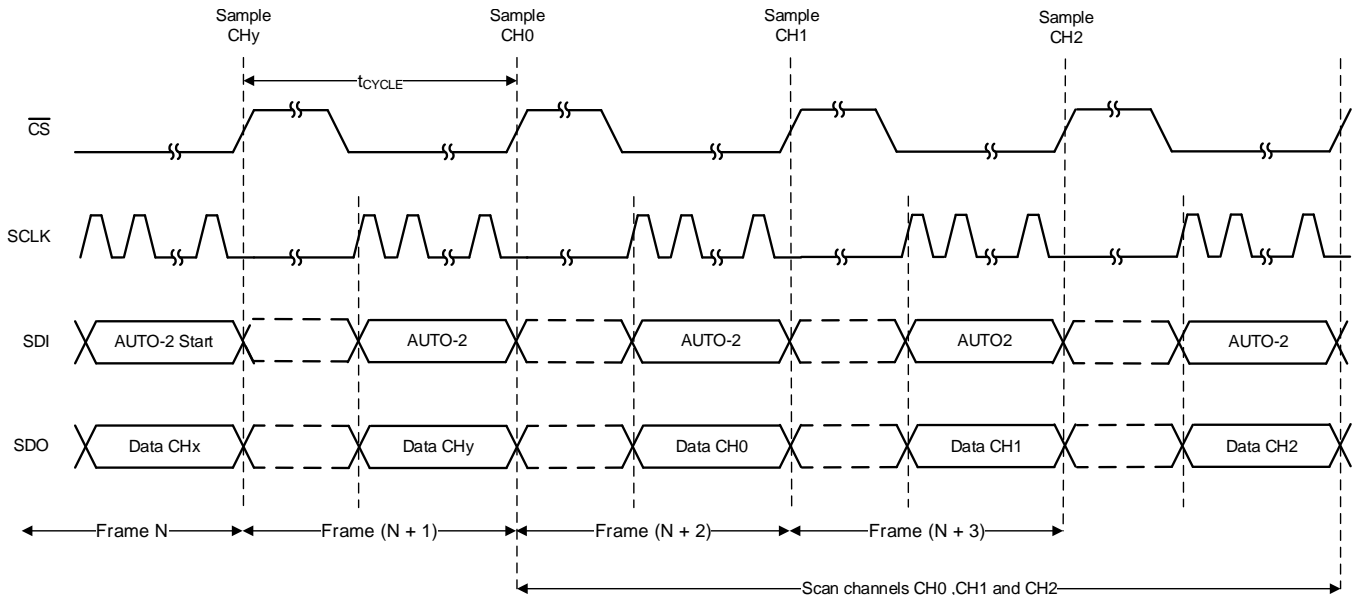


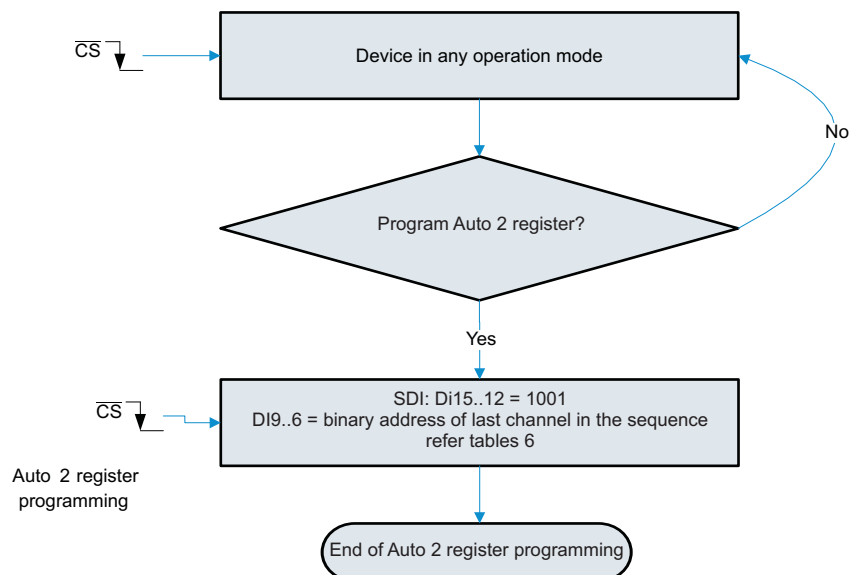
Figure 56. Example Auto-2 Mode Timing Diagram

Table 5. Mode Control Register Settings for Auto-2 Mode

| BITS | RESET STATE | LOGIC STATE | FUNCTION | | |
|---------|-------------|--|--|--|----------------------|
| DI15-12 | 0001 | 0011 | Selects Auto-2 Mode | | |
| DI11 | 0 | 1 | Enables programming of bits DI10-00. | | |
| | | 0 | Device retains values of DI10-00 from the previous frame. | | |
| DI10 | 0 | 1 | Channel number is reset to Ch-00. | | |
| | | 0 | Channel counter increments every conversion.(No reset). | | |
| DI09-07 | 000 | xxx | Do not care | | |
| DI06 | 0 | 0 | Selects V_{REF} i/p range (Range 1) | | |
| | | 1 | Selects $2xV_{REF}$ i/p range (Range 2) | | |
| DI05 | 0 | 0 | Device normal operation (no powerdown) | | |
| | | 1 | Device powers down on the 16th SCLK falling edge | | |
| DI04 | 0 | 0 | SDO outputs the current channel address of the channel on DO15..12 followed by the 12-bit conversion result on DO11..00. | | |
| | | | 1 | GPIO3-GPIO0 data (both input and output) is mapped onto DO15-DO12 in the order shown below. Lower data bits DO11-DO00 represent the 12-bit conversion result of the current channel. | |
| | | DO15 | DO14 | DO13 | DO12 |
| | | GPIO3 ⁽¹⁾ | GPIO2 ⁽¹⁾ | GPIO1 ⁽¹⁾ | GPIO0 ⁽¹⁾ |
| DI03-00 | 0000 | GPIO data for the channels configured as output. Device ignores data for the channel which is configured as input. SDI bit and corresponding GPIO information is given below | | | |
| | | DI03 | DI02 | DI01 | DI00 |
| | | GPIO3 ⁽¹⁾ | GPIO2 ⁽¹⁾ | GPIO1 ⁽¹⁾ | GPIO0 ⁽¹⁾ |

(1) GPIO 1 to 3 are available only in TSSOP packaged devices. QFN device offers GPIO 0 only.

The Auto-2 Program Register is programmed (once on powerup or reset) to pre-select the last channel (or sequence depth) in the Auto-2 sequence. Unlike Auto-1 Program Register programming, Auto-2 Program Register programming requires only 1 CS frame for complete programming. See Figure 57 and Table 6 for complete details.



NOTE: The device continues its operation in the selected mode during programming. SDO is valid, however it is not possible to change the range or write GPIO data into the device during programming.

Figure 57. Auto-2 Register Programming Flowchart

Table 6. Program Register Settings for Auto-2 Mode

| BITS | RESET STATE | LOGIC STATE | FUNCTION |
|---------|-------------|-------------|--|
| DI15-12 | NA | 1001 | Auto-2 program register is selected for programming |
| DI11-10 | NA | Do not care | |
| DI09-06 | NA | aaaa | This 4-bit data represents the address of the last channel in the scanning sequence. During device operation in Auto-2 mode, the channel counter starts at CH-00 and increments every frame until it equals "aaaa". The channel counter rolls over to CH-00 in the next frame. |
| DI05-00 | NA | Do not care | |

8.4.7 Continued Operation in a Selected Mode

Once a device is programmed to operate in one of the modes, the user may want to continue operating in the same mode. Mode Control Register settings to continue operating in a selected mode are detailed in [Table 7](#).

Table 7. Continued Operation in a Selected Mode

| BITS | RESET STATE | LOGIC STATE | FUNCTION |
|---------|-------------|-------------|---|
| DI15-12 | 0001 | 0000 | The device continues to operate in the selected mode. In Auto-1 and Auto-2 modes the channel counter increments normally, whereas in the Manual mode it continues with the last selected channel. The device ignores data on DI11-DI00 and continues operating as per the previous settings. This feature is provided so that SDI can be held low when no changes are required in the Mode Control Register settings. |
| DI11-00 | All '0' | | Device ignores these bits when DI15-12 is set to 0000 logic state |

8.5 Programming

8.5.1 Digital Output

As discussed previously in [Overview](#), the digital output of the ADS79xx devices is SPI compatible. The following tables list the output codes corresponding to various analog input voltages.

Table 8. Ideal Input Voltages for 12-Bit Devices and Output Codes for 12-Bit Devices (ADS7950/51/52/53)

| DESCRIPTION | | ANALOG VALUE | DIGITAL OUTPUT STRAIGHT BINARY | |
|-----------------------------|-------------------------------|------------------------------|-----------------------------------|-----------------|
| Full scale range | Range 1 → V_{REF} | Range 2 → $2 \times V_{REF}$ | | |
| Least significant bit (LSB) | $V_{REF} / 4096$ | $2V_{REF} / 4096$ | BINARY CODE | HEX CODE |
| Full scale | $V_{REF} - 1 \text{ LSB}$ | $2V_{REF} - 1 \text{ LSB}$ | 1111 1111 1111 | FFF |
| Midscale | $V_{REF} / 2$ | V_{REF} | 1000 0000 0000 | 800 |
| Midscale – 1 LSB | $V_{REF} / 2 - 1 \text{ LSB}$ | $V_{REF} - 1 \text{ LSB}$ | 0111 1111 1111 | 7FF |
| Zero | 0 V | 0 V | 0000 0000 0000 | 000 |

Table 9. Ideal Input Voltages for 10-Bit Devices and Digital Output Codes for 10-Bit Devices (ADS7954/55/56/57)

| DESCRIPTION | | ANALOG VALUE | DIGITAL OUTPUT STRAIGHT BINARY | |
|-----------------------------|-------------------------------|------------------------------|-----------------------------------|-----------------|
| Full scale range | Range 1 → V_{REF} | Range 2 → $2 \times V_{REF}$ | | |
| Least significant bit (LSB) | $V_{REF} / 1024$ | $2V_{REF} / 1024$ | BINARY CODE | HEX CODE |
| Full scale | $V_{REF} - 1 \text{ LSB}$ | $2V_{REF} - 1 \text{ LSB}$ | 0011 1111 1111 | 3FF |
| Midscale | $V_{REF} / 2$ | V_{REF} | 0010 0000 0000 | 200 |
| Midscale – 1 LSB | $V_{REF} / 2 - 1 \text{ LSB}$ | $V_{REF} - 1 \text{ LSB}$ | 0001 1111 1111 | 1FF |
| Zero | 0 V | 0 V | 0000 0000 0000 | 000 |

**Table 10. Ideal Input Voltages for 8-Bit Devices and Digital Output Codes for 8-Bit Devices
(ADS7958/59/60/61)**

| DESCRIPTION | ANALOG VALUE | | DIGITAL OUTPUT STRAIGHT BINARY | |
|-----------------------------|-------------------------------|------------------------------|-----------------------------------|----------|
| | Range 1 → V_{REF} | Range 2 → $2 \times V_{REF}$ | BINARY CODE | HEX CODE |
| Full scale range | Range 1 → V_{REF} | Range 2 → $2 \times V_{REF}$ | | |
| Least significant bit (LSB) | $V_{REF} / 256$ | $2V_{REF} / 256$ | | |
| Full scale | $V_{REF} - 1 \text{ LSB}$ | $2V_{REF} - 1 \text{ LSB}$ | 1111 1111 | FF |
| Midscale | $V_{REF} / 2$ | V_{REF} | 1000 0000 | 80 |
| Midscale – 1 LSB | $V_{REF} / 2 - 1 \text{ LSB}$ | $V_{REF} - 1 \text{ LSB}$ | 0111 1111 | 7F |
| Zero | 0 V | 0 V | 0000 0000 | 00 |

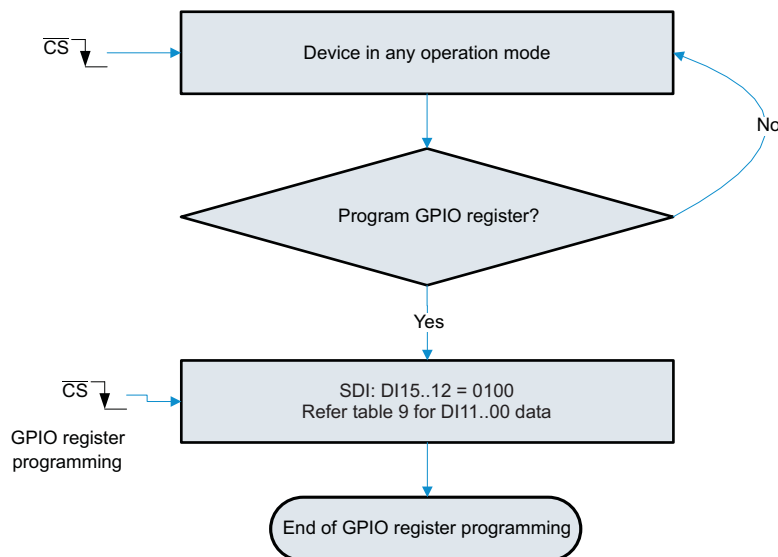
8.5.2 GPIO Registers

NOTE

GPIO 0, 1, 2, and 3 are available in the TSSOP packages. Only GPIO 0 is available in the VQFN packages.

The device has four general purpose input and output (GPIO) pins. Each of the four pins can be independently programmed as general purpose output (GPO) or general purpose input (GPI). It is also possible to use the GPIOs for some pre-assigned functions (refer to [Table 11](#) for details). GPO data can be written into the device through the SDI line. The device refreshes the GPO data on every \overline{CS} falling edge as per the SDI data written in the previous frame. Similarly, the device latches GPI status on the \overline{CS} falling edge and outputs it on SDO (if GPI is read enabled by writing $DI04 = 1$ during the previous frame) in the same frame starting on the \overline{CS} falling edge.

The details regarding programming the GPIO registers are illustrated in the flowchart in [Figure 58](#). [Table 11](#) lists the details regarding GPIO Register programming settings.



NOTE: The device continues its operation in selected mode during programming. SDO is valid, however it is not possible to change the range or write GPIO data into the device during programming.

Figure 58. GPIO Program Register Programming Flowchart

Table 11. GPIO Program Register Settings

| BITS | RESET STATE | LOGIC STATE | FUNCTION |
|--|-------------|-------------|---|
| DI15-12 | NA | 0100 | Device selects GPIO Program Registers for programming. |
| DI11-10 | 00 | 00 | Do not program these bits to any logic state other than '00' |
| DI09 | 0 | 1 | Device resets all registers in the next \overline{CS} frame to the reset state shown in the corresponding tables (it also resets itself). |
| | | 0 | Device normal operation |
| DI08 | 0 | 1 | Device configures GPIO3 as the device power-down input. |
| | | 0 | GPIO3 remains general purpose I or O. Program 0 for QFN packaged devices. |
| DI07 | 0 | 1 | Device configures GPIO2 as device range input. |
| | | 0 | GPIO2 remains general purpose I or O. Program 0 for QFN packaged devices. |
| DI06-04 | 000 | 000 | GPIO1 and GPIO0 remain general purpose I or O. Valid setting for QFN packaged devices. |
| | | xx1 | Device configures GPIO0 as 'high or low' alarm output. This is an active high output. GPIO1 remains general purpose I or O. Valid setting for QFN packaged devices. |
| | | 010 | Device configures GPIO0 as high alarm output. This is an active high output. GPIO1 remains general purpose I or O. Valid setting for QFN packaged devices. |
| | | 100 | Device configures GPIO1 as low alarm output. This is an active high output. GPIO0 remains general purpose I or O. Setting not allowed for QFN packaged devices. |
| | | 110 | Device configures GPIO1 as low alarm output and GPIO0 as a high alarm output. These are active high outputs. Setting not allowed for QFN packaged devices. |
| Note: The following settings are valid for GPIO which are not assigned a specific function through bits DI08..04 | | | |
| DI03 | 0 | 1 | GPIO3 pin is configured as general purpose output. Program 1 for QFN packaged devices. |
| | | 0 | GPIO3 pin is configured as general purpose input. Setting not allowed for QFN packaged devices. |
| DI02 | 0 | 1 | GPIO2 pin is configured as general purpose output. Program 1 for QFN packaged devices. |
| | | 0 | GPIO2 pin is configured as general purpose input. Setting not allowed for QFN packaged devices. |
| DI01 | 0 | 1 | GPIO1 pin is configured as general purpose output. Program 1 for QFN packaged devices. |
| | | 0 | GPIO1 pin is configured as general purpose input. Setting not allowed for QFN packaged devices. |
| DI00 | 0 | 1 | GPIO0 pin is configured as general purpose output. Valid setting for QFN packaged devices. |
| | | 0 | GPIO0 pin is configured as general purpose input. Valid setting for QFN packaged devices. |

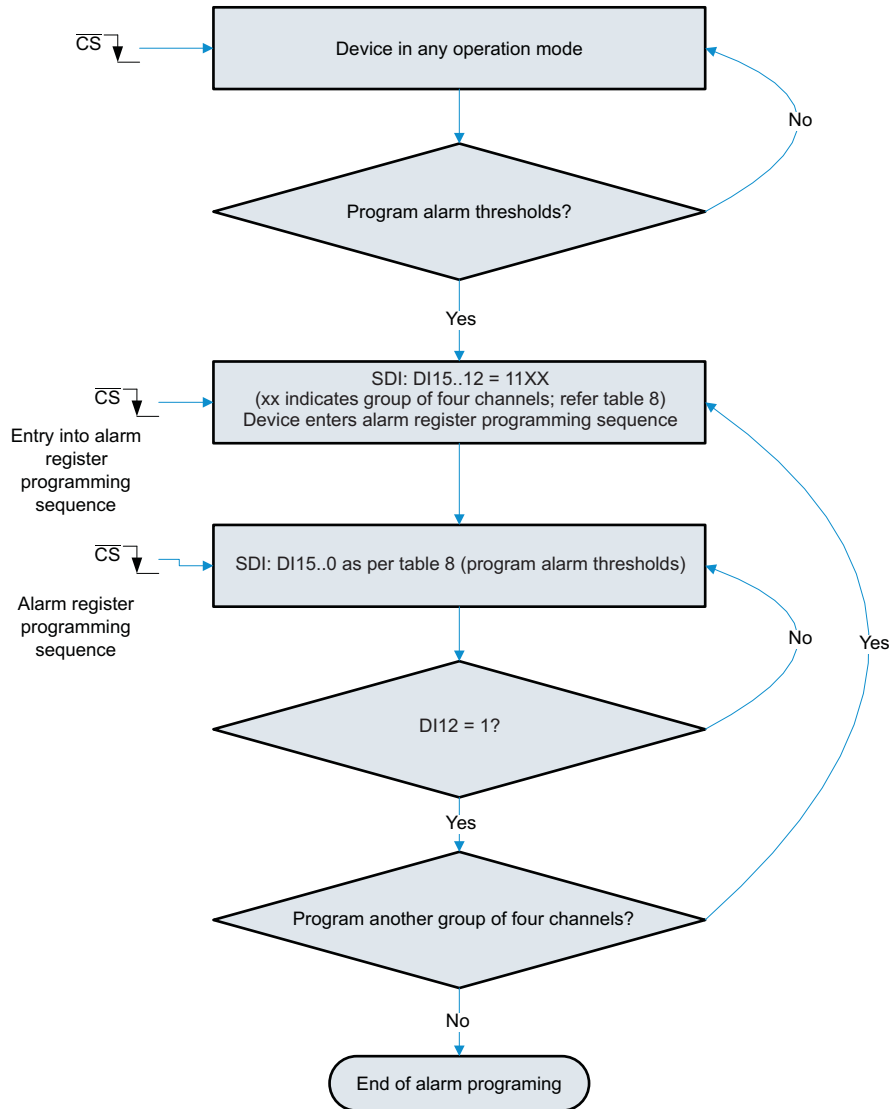
8.5.3 Alarm Thresholds for GPIO Pins

Each channel has two alarm program registers, one for setting the high alarm threshold and the other for setting the low alarm threshold. For ease of programming, two alarm programming registers per channel, corresponding to four consecutive channels, are assembled into one group (a total eight registers). There are four such groups for 16 channel devices and 3/2/1 such groups for 12/8/4 channel devices respectively. The details regarding the grouping of the various channels for each device in the ADS79xx family is listed in [Table 12](#). The details regarding programming the alarm thresholds are illustrated in the flowchart in [Figure 59](#). [Table 13](#) lists the details regarding the Alarm Program Register settings.

Table 12. Grouping of Alarm Program Registers

| GROUP NO. | REGISTERS | APPLICABLE FOR DEVICE |
|-----------|---|--|
| 0 | High and low alarm for channel 0, 1, 2, and 3 | ADS7953..50, ADS7957..54, ADS7961..58 |
| 1 | High and low alarm for channel 4, 5, 6, and 7 | ADS7953..51, ADS7957..55, ADS7961..59 |
| 2 | High and low alarm for channel 8, 9, 10, and 11 | ADS7953 and 52, ADS7957 and 56, ADS7961 and 60 |
| 3 | High and low alarm for channel 12, 13, 14, and 15 | ADS7953, ADS7957, ADS7961 |

Each alarm group requires 9 \overline{CS} frames for programming their respective alarm thresholds. In the first frame the device enters the programming sequence and in each subsequent frame it programs one of the registers from the group. The device offers a feature to program less than eight registers in one programming sequence. The device exits the alarm threshold programming sequence in the next frame after it encounters the first 'Exit Alarm Program' bit high.



NOTE: The device continues its operation in selected mode during programming. SDO is valid, however it is not possible to change the range or write GPIO data into the device during programming.

Figure 59. Alarm Program Register Programming Flowchart

Table 13. Alarm Program Register Settings

| BITS | RESET STATE | LOGIC STATE | FUNCTION |
|---|---|---|--|
| FRAME 1 | | | |
| DI15-12 | NA | 1100 | Device enters 'alarm programming sequence' for group 0 |
| | | 1101 | Device enters 'alarm programming sequence' for group 1 |
| | | 1110 | Device enters 'alarm programming sequence' for group 2 |
| | | 1111 | Device enters 'alarm programming sequence' for group 3 |
| Note: DI15-12 = 11bb is the alarm programming request for group bb. Here 'bb' represents the alarm programming group number in binary format. | | | |
| DI11-14 | NA | Do not care | |
| FRAME 2 AND ONWARDS | | | |
| DI15-14 | NA | cc | Where "cc" represents the lower two bits of the channel number in binary format. The device programs the alarm for the channel represented by the binary number "bcc". "bb" is programmed in the first frame. |
| DI13 | NA | 1 | High alarm register selection |
| | | 0 | Low alarm register selection |
| DI12 | NA | 0 | Continue alarm programming sequence in next frame |
| | | 1 | Exit Alarm Programming in the next frame. Note: If the alarm programming sequence is not terminated using this feature then the device will remain in the alarm programming sequence state and all SDI data will be treated as alarm thresholds. |
| DI11-10 | NA | xx | Do not care |
| DI09-00 | All ones for high alarm register and all zeros for low alarm register | This 10-bit data represents the alarm threshold. The 10-bit alarm threshold is compared with the upper 10-bit word of the 12-bit conversion result. The device sets off an alarm when the conversion result is higher (High Alarm) or lower (Low Alarm) than this number. For 10-bit devices, all 10 bits of the conversion result are compared with the set threshold. For 8-bit devices, all 8 bits of the conversion result are compared with DI09 to DI02 and DI00, 01 are 'do not care'. | |

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

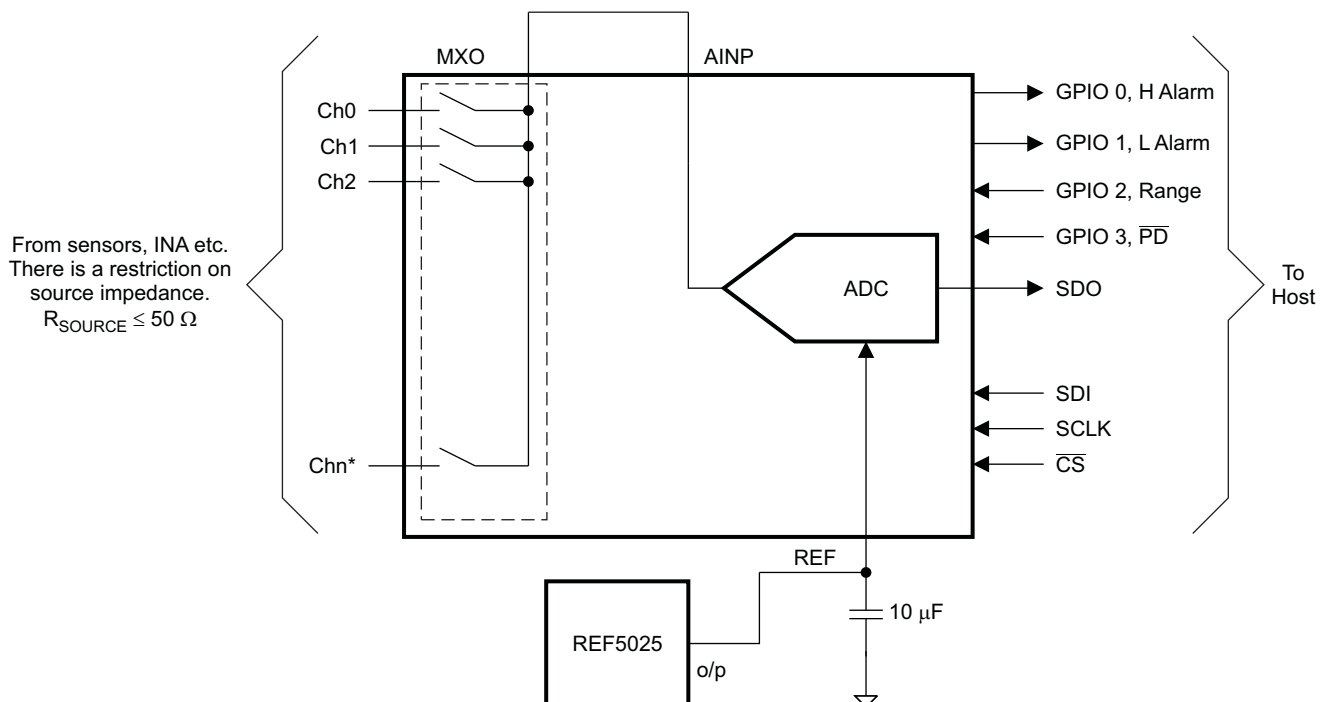
9.1 Application Information

In general applications, when the internal multiplexer is updated, the previously converted channel charge is stored in the 15-pF internal input capacitance that disturbs the voltage at the newly selected channel. This disturbance is expected to settle to 1 LSB during sampling (acquisition) time to avoid degrading converter performance. The initial absolute disturbance error at the channel input must be less than 0.5 V to prevent source current saturation or slewing that causes significantly long settling times. Fortunately, significantly reducing disturbance error is easy to accomplish by simply placing a large enough capacitor at the input of each channel. Specifically, with a 150-pF capacitor, instantaneous charge distribution keeps disturbance error less than 0.46 V because the internal input capacitance can only hold up to 75 pC (or $5\text{ V} \times 15\text{ pF}$). The remaining error must be corrected by the voltage source at each input, with impedance low enough to settle within 1 LSB. The following application examples explain the considerations for the input source impedance (R_{SOURCE}).

9.1.1 Analog Input

The ADS79xx device family offers 12/10/8-bit ADCs with 16/12/8/4 channel multiplexers for analog input. The multiplexer output is available on the MXO pin. AINP is the ADC input pin. The device offers flexibility for a system designer as both signals are accessible externally.

Typically it is convenient to short MXO to the AINP pin so that signal input to each multiplexer channel can be processed independently. In this condition, TI recommends limiting source impedance to $50\ \Omega$ or less. Higher source impedance may affect the signal settling time after a multiplexer channel change. This condition can affect linearity and total harmonic distortion.



GPIO 0,1,2 and 3 are available only in TSSOP packaged devices. QFN device offers 'GPIO 0' only. As a result all references related to 'GPIO 0' only are valid in case of QFN package devices.

Figure 60. Typical Application Diagram Showing MXO Shorted to AINP

Application Information (continued)

Another option is to add a common ADC driver buffer between the MXO and AINP pins. This relaxes the restriction on source impedance to a large extent. Refer to [Typical Characteristics \(All ADS79xx Family Devices\)](#) for the effect of source impedance on device performance. The typical characteristics show that the device has respectable performance with up to 1k Ω source impedance. This topology (including a common ADC driver) is useful when all channel signals are within the acceptable range of the ADC. In this case the user can save on signal conditioning circuit for each channel.

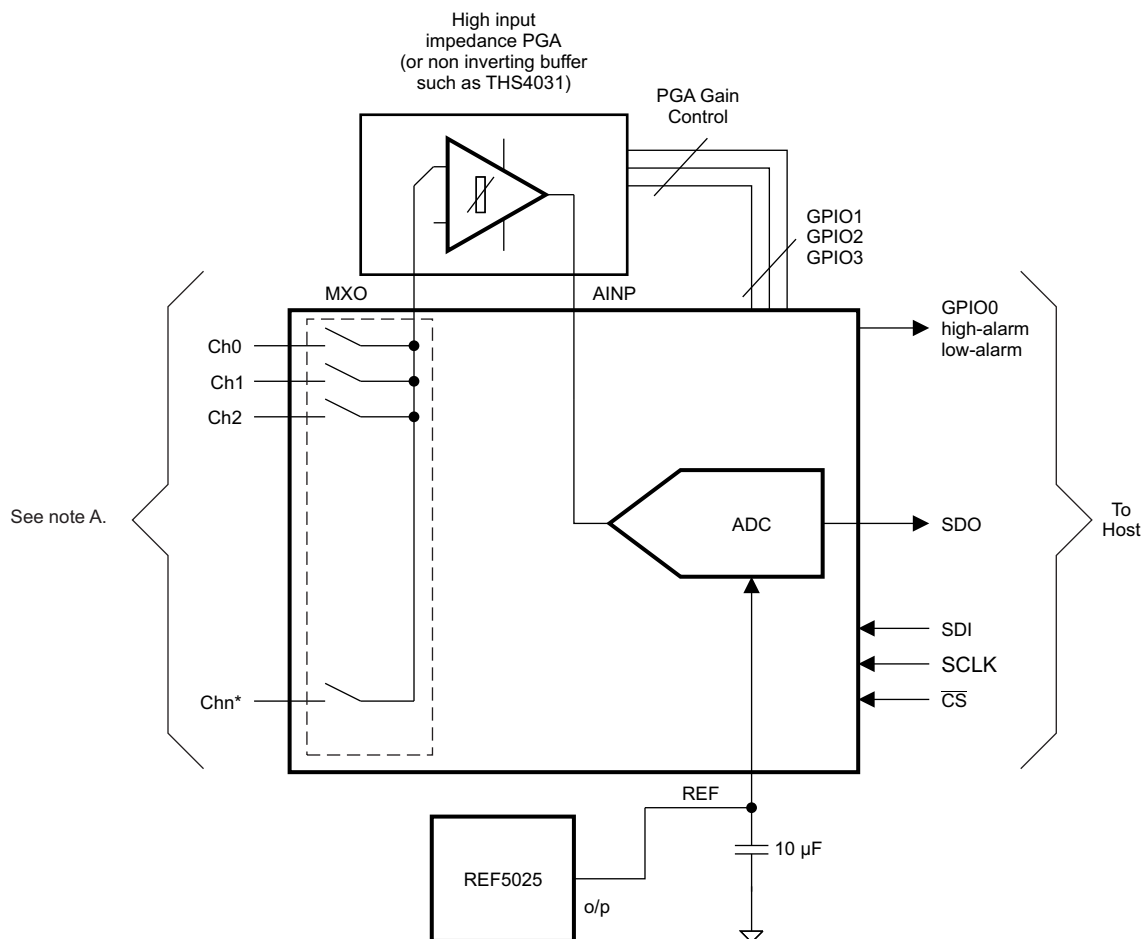


Figure 61. Typical Application Diagram Showing Common Buffer/PGA for All Channels

When the converter samples an input, the voltage difference between AINP and AGND is captured on the internal capacitor array. The (peak) input current through the analog inputs depends upon a number of factors: sample rate, input voltage, and source impedance. The current into the ADS79xx charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. When the converter goes into hold mode, the input impedance is greater than 1 G Ω .

Care must be taken regarding the absolute analog input voltage. To maintain linearity of the converter, the Ch0 .. Chn and AINP inputs should be within the limits specified. Outside of these ranges, converter linearity may not meet specifications.

Application Information (continued)

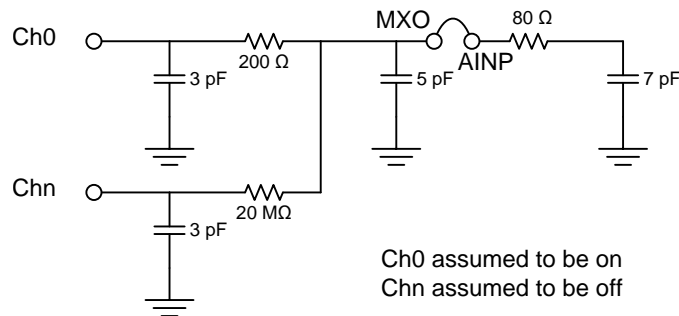
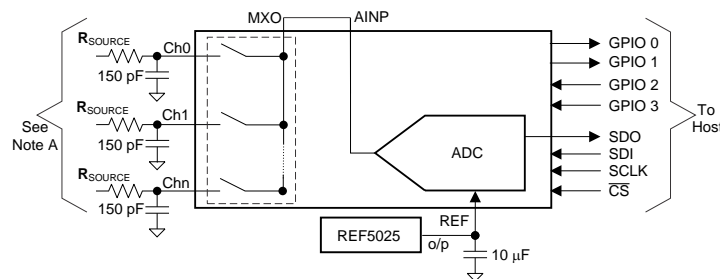


Figure 62. ADC and MUX Equivalent Circuit

9.2 Typical Applications

9.2.1 Unbuffered Multiplexer Output (MXO)

This application is the most typical application, but requires the lowest R_{SOURCE} for good performance. In this configuration, the $2xV_{REF}$ range allows larger source impedance than the $1xV_{REF}$ range because the $1xV_{REF}$ range LSB size is smaller, thus making it more sensitive to settling error.



- A. A restriction on the source impedance exists. $R_{SOURCE} \leq 100 \Omega$ for the $1xV_{REF}$ 12-bit settling at 1 MSPS or $R_{SOURCE} \leq 250 \Omega$ for the $2xV_{REF}$ 12-bit settling at 1 MSPS.

Figure 63. Application Diagram for an Unbuffered MXO

9.2.1.1 Design Requirements

The design is optimized to show the input source impedance (R_{SOURCE}) from the 100Ω to 10000Ω required to meet the 1-LSB settling at 12-bit, 10-bit, and 8-bit resolutions at different throughput in $1xV_{REF}$ (2.5-V) and $2xV_{REF}$ (5-V) input ranges.

9.2.1.2 Detailed Design Procedure

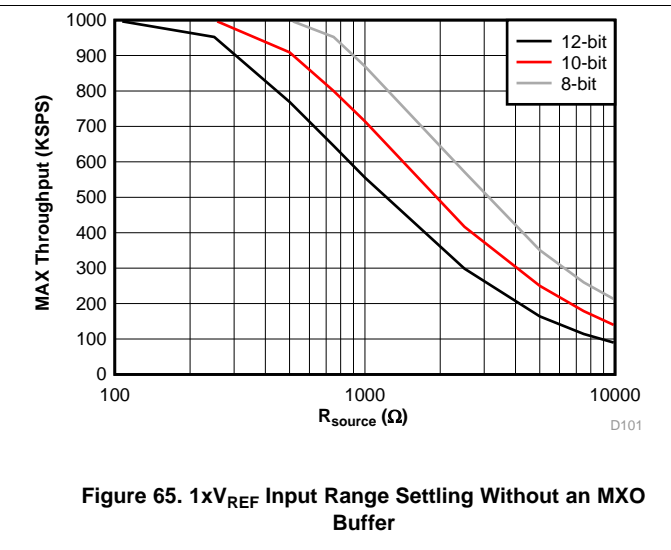
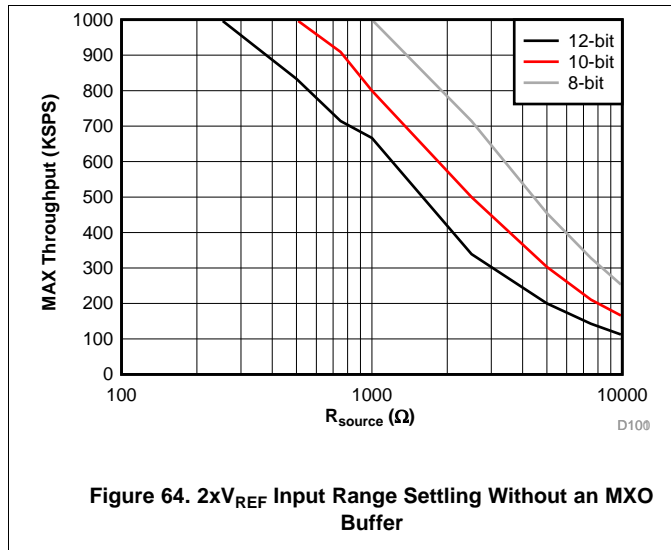
Although the required input source impedance can be estimated assuming a 0.5-V initial error and exponential recovery during sampling (acquisition) time, this estimation over-simplifies the complex interaction between the converter and source, thus yielding inaccurate estimates. Thus, this design uses an iterative approach with the converter itself to provide reliable impedance values.

To determine the actual maximum source impedance for a particular resolution and sampling rate, two subsequent channels are set at least 95% of the full-scale range apart. With a $1xV_{REF}$ range and $2.5 V_{REF}$, the channel difference is at least 2.375 V. With $2xV_{REF}$ and $2.5 V_{REF}$, the difference is at least 4.75 V. With a source impedance from 100Ω to $10,000 \Omega$, the conversion runs at a constant rate and a channel update is issued that captures the first couple samples after the update. This process is repeated at least 100 times to remove any noise and to show a clear settling error. The first sample after the channel update is then compared against the second one. If the first and second samples are more than 1 LSB apart, throughput rate is reduced until the settling error becomes 1 LSB, which then sets the maximum throughput for the selected impedance. The whole process is repeated for nine different impedances from 100Ω to 10000Ω .

Typical Applications (continued)

9.2.1.3 Application Curves

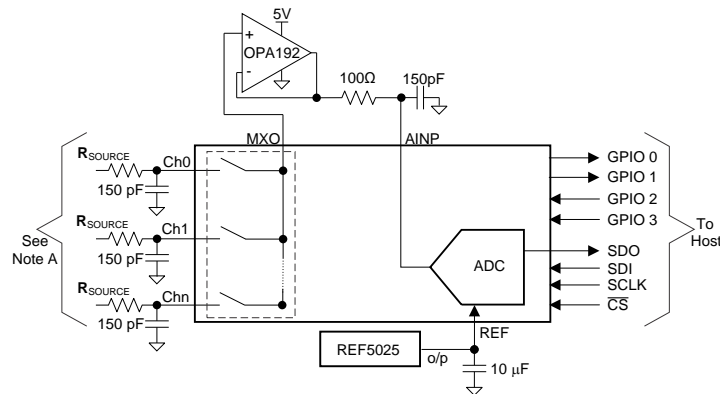
These curves show the R_{SOURCE} for an unbuffered MXO.



Typical Applications (continued)

9.2.2 OPA192 Buffered Multiplexer Output (MXO)

The use of a buffer relaxes the R_{SOURCE} requirements to an extent. Charge from the sample-and-hold capacitor no longer dominates as a residual charge from a previous channel. Although having good performance is possible with a larger impedance using the OPA192, the output capacitance of the MXO also holds the previous channel charge and cannot be isolated, which limits how large the input impedance can finally be for good performance. In this configuration, the $1xV_{REF}$ range allows slightly higher impedance because the OPA192 ($20\text{ V}/\mu\text{s}$) slews approximately 2.5 V in contrast to the $2xV_{REF}$ range that requires the OPA192 to slew approximately 5 V .



- A. Restriction on the source impedance exists. $R_{(SOURCE)} \leq 500\ \Omega$ for a 12-bit settling at 1 MSPS with both $1xV_{REF}$ and $2xV_{REF}$ ranges.

Figure 66. Application Diagram for an OPA192 Buffered MXO

9.2.2.1 Design Requirements

The design is optimized to show the input source impedance (R_{SOURCE}) from the $100\ \Omega$ to $10000\ \Omega$ required to meet a 1-LSB settling at 12-bit, 10-bit, and 8-bit resolutions at different throughput in $1xV_{REF}$ (2.5 V) and $2xV_{REF}$ (5 V) input ranges.

9.2.2.2 Detailed Design Procedure

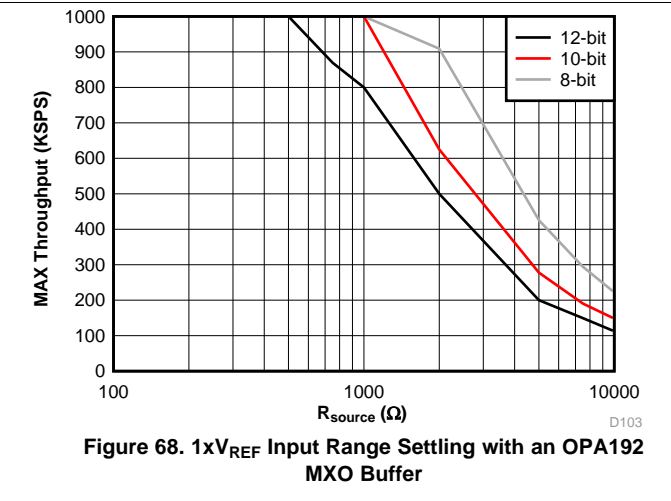
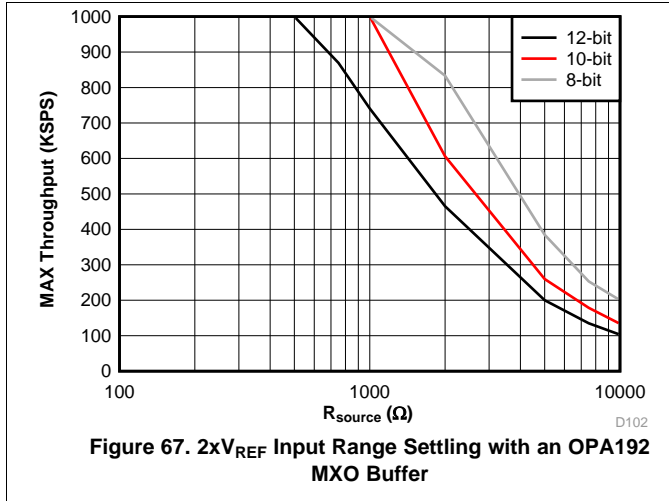
The design procedure is similar to the unbuffered-MXO application, but includes an operation amplifier in unity gain as a buffer. The most important parameter for multiplexer buffering is slew rate. The amplifier must finish slewing before the start of sampling (acquisition) to keep the buffer operating in small-signal mode during sampling (acquisition) time. Also, between the buffer output and converter input (INP), there must be a capacitor large enough to keep the buffer in small-signal operation during sampling (acquisition) time. Because 150 pF is large enough to protect the buffer from hold charge from internal capacitors, this value selected along with the lowest impedance that allows the op amp to remain stable.

The converter allows the MXO to settle approximately 600 ns before sampling. During this time, the buffer slews and then enters small-signal operation. For a 5-V step change, slew rate stays constant during the first 4 V . The last 1 V includes a transition from slewing and non-slewing. Thus, the buffer cannot be assumed to keep a constant slew during the 600 ns available for MXO settling. Assuming that the last 1-V slew is reduced to half is recommended. For this reason, slew is $10\text{ V}/\mu\text{s}$ or $(5\text{ V}_{ref} + 1\text{ V}) / 0.6\ \mu\text{s}$ to account for the 1-V slow slew. The OPA192 has a $20\text{-V}/\mu\text{s}$ slew, and is capable of driving 150 pF with more than a 50° phase margin with a $50\text{-}\Omega$ or $100\text{-}\Omega$ R_{iso} , making the OPA192 an ideal selection for the ADS79xx-Q1 family of converters.

Typical Applications (continued)

9.2.2.3 Application Curves

These curves show the R_{SOURCE} for an OPA192 buffered MXO.



10 Power Supply Recommendations

The devices are designed to operate from an analog supply voltage (+VA) range from 2.7 V to 5.25 V and a digital supply voltage (+VBD) range from 1.7 V to 5.25 V. Both supplies must be well regulated. The analog supply is always greater than or equal to the digital supply. A 1- μ F ceramic decoupling capacitor is required at each supply pin and must be placed as close as possible to the device.

11 Layout

11.1 Layout Guidelines

- A copper fill area underneath the device ties the AGND, BDGND, AINM, and REFM pins together. This copper fill area must also be connected to the analog ground plane of the PCB using at least four vias.
- The power sources must be clean and properly decoupled by placing a capacitor close to each of the three supply pins, as shown in Figure 69 and Figure 70. To minimize ground inductance, ensure that each capacitor ground pin is connected to a grounding via by a very short and thick trace.
- The REFP pin requires a 10- μF ceramic capacitor to meet performance specifications. Place the capacitor directly next to the device. This capacitor ground pin must be routed to the REFM pin by a very short trace, as shown in Figure 69 and Figure 70.
- Do not place any vias between a capacitor pin and a device pin.

NOTE

The full-power bandwidth of the converter makes the ADC sensitive to high frequencies in digital lines. Organize components in the PCB by keeping digital lines apart from the analog signal paths. This design configuration is critical to minimize crosstalk. For example, in Figure 69, input drivers are expected to be on the left of the converter and the microcontroller on the right.

11.2 Layout Examples

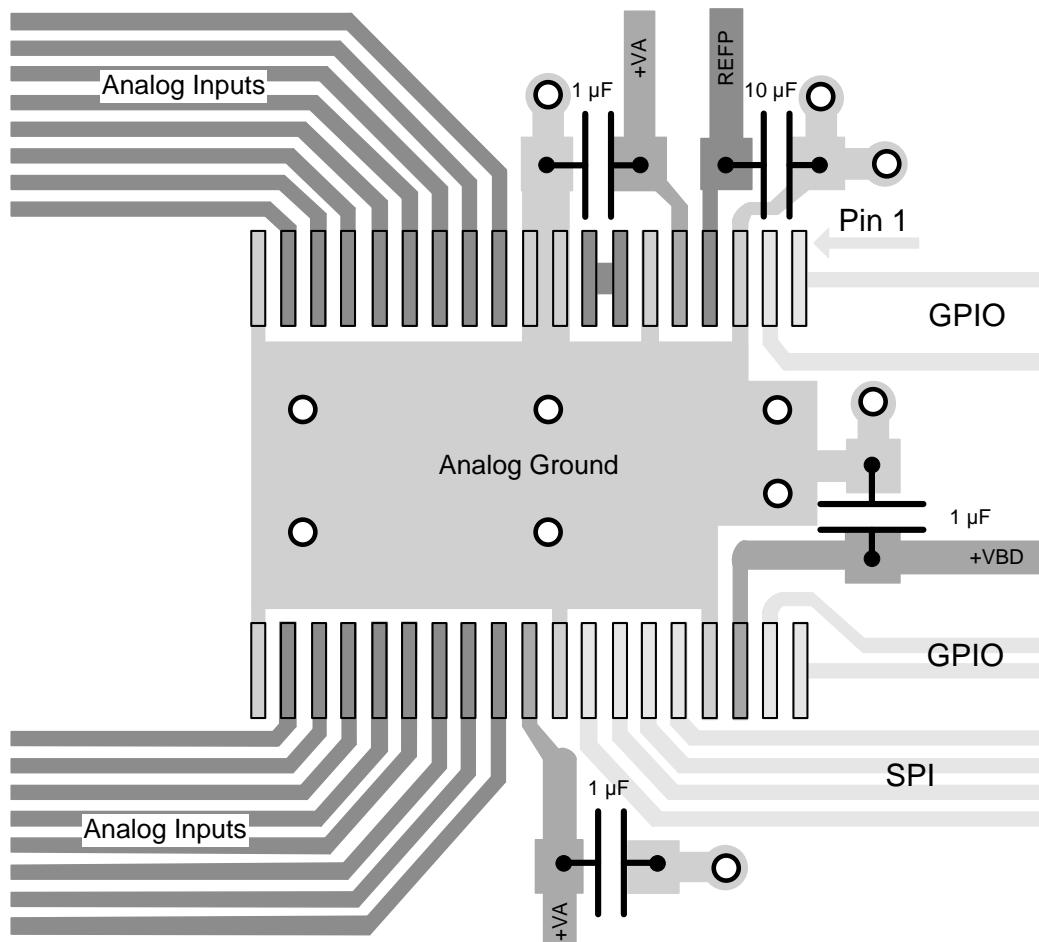


Figure 69. Recommended Layout for the TSSOP Packaged Device

Layout Examples (continued)

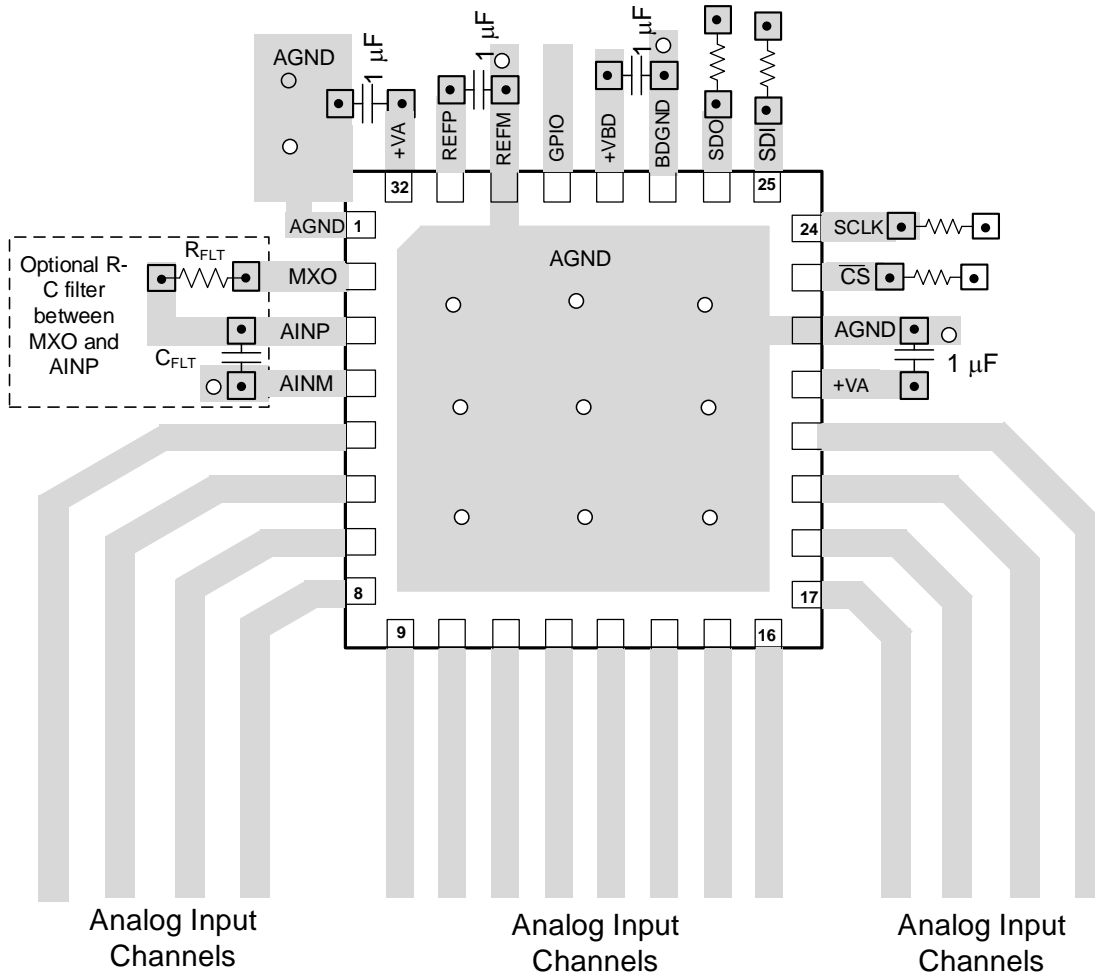


Figure 70. Recommended Layout for the VQFN Packaged Device

12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

- [REF50xx Low-Noise, Very Low Drift, Precision Voltage Reference](#)
- [OPAx192 36-V, Precision, Rail-to-Rail Input/Output, Low Offset Voltage, Low Input Bias Current Op Amp with e-trim™](#)

12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

Table 14. Related Links

| PARTS | PRODUCT FOLDER | ORDER NOW | TECHNICAL DOCUMENTS | TOOLS & SOFTWARE | SUPPORT & COMMUNITY |
|---------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| ADS7950 | Click here | Click here | Click here | Click here | Click here |
| ADS7951 | Click here | Click here | Click here | Click here | Click here |
| ADS7952 | Click here | Click here | Click here | Click here | Click here |
| ADS7953 | Click here | Click here | Click here | Click here | Click here |
| ADS7954 | Click here | Click here | Click here | Click here | Click here |
| ADS7955 | Click here | Click here | Click here | Click here | Click here |
| ADS7956 | Click here | Click here | Click here | Click here | Click here |
| ADS7957 | Click here | Click here | Click here | Click here | Click here |
| ADS7958 | Click here | Click here | Click here | Click here | Click here |
| ADS7959 | Click here | Click here | Click here | Click here | Click here |
| ADS7960 | Click here | Click here | Click here | Click here | Click here |
| ADS7961 | Click here | Click here | Click here | Click here | Click here |

12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

12.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7950SBDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SBDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SBDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SBDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SBDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SBDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SBRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7950 |
| ADS7950SBRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7950 |
| ADS7950SBRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7950 |
| ADS7950SBRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7950 |
| ADS7950SBRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7950 |
| ADS7950SBRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7950 |
| ADS7950SDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7950SDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7950 |
| ADS7951SBDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SBDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SBDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SBDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SBDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SBDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7951SBRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SBRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SBRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SBRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SBRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SBRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SDBTG4 | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7951 |
| ADS7951SRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7951SRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS 7951 |
| ADS7952SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7952SDBBTG4 | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 B |
| ADS7952SDBBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 B |
| ADS7952SDBBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 B |
| ADS7952SDBBTRG4 | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 B |
| ADS7952SDBBTRG4.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 B |
| ADS7952SDBBTRG4.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 B |
| ADS7952SBRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SBRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SBRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SBRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SBRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SBRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBTG4 | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | Call TI | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7952 |
| ADS7952SRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7952SRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7952SRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7952 |
| ADS7953SBDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SBDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SBDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SBDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SBDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SBDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SBRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SBRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SBRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SBRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SBRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SBRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |
| ADS7953SDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7953 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7953SRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7953SRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | Call TI | Level-3-260C-168 HR | -40 to 125 | ADS 7953 |
| ADS7954SDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7954 |
| ADS7954SDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7954 |
| ADS7954SDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7954 |
| ADS7954SDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7954 |
| ADS7954SDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7954 |
| ADS7954SDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7954 |
| ADS7954SRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7954 |
| ADS7954SRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7954 |
| ADS7954SRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7954 |
| ADS7954SRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7954 |
| ADS7954SRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7954 |
| ADS7954SRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7954 |
| ADS7955SDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7955 |
| ADS7955SDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7955 |
| ADS7955SDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7955 |
| ADS7955SDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7955 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7955SDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7955 |
| ADS7955SDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7955 |
| ADS7955SRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7955 |
| ADS7955SRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7955 |
| ADS7955SRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7955 |
| ADS7955SRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7955 |
| ADS7955SRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7955 |
| ADS7955SRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7955 |
| ADS7956SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBTG4 | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBTG4.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBTG4.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7956 |
| ADS7956SRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7956SRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBTG4 | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBTG4.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7956SRHBTG4.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7956 |
| ADS7957SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBTG4 | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBTG4.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBTG4.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7957 |
| ADS7957SRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBRG4 | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBRG4.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBRG4.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7957SRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7957SRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7957 |
| ADS7958SDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7958 |
| ADS7958SDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7958 |
| ADS7958SDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7958 |
| ADS7958SDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7958 |
| ADS7958SDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7958 |
| ADS7958SDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7958 |
| ADS7958SRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGERG4 | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGERG4.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGERG4.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7958SRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7958 |
| ADS7959SDBT | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7959 |
| ADS7959SDBT.A | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7959 |
| ADS7959SDBT.B | Active | Production | TSSOP (DBT) 30 | 60 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7959 |
| ADS7959SDBTR | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7959 |
| ADS7959SDBTR.A | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7959 |
| ADS7959SDBTR.B | Active | Production | TSSOP (DBT) 30 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7959 |
| ADS7959SRGER | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7959 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7959SRGER.A | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7959 |
| ADS7959SRGER.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7959 |
| ADS7959SRGET | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7959 |
| ADS7959SRGET.A | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7959 |
| ADS7959SRGET.B | Active | Production | VQFN (RGE) 24 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7959 |
| ADS7960SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBTG4 | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBTG4.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBTG4.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7960 |
| ADS7960SRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7960 |
| ADS7960SRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7960 |
| ADS7960SRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7960 |
| ADS7960SRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7960 |
| ADS7960SRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7960 |
| ADS7960SRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7960 |
| ADS7961SDBT | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7961 |
| ADS7961SDBT.A | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7961 |
| ADS7961SDBT.B | Active | Production | TSSOP (DBT) 38 | 50 TUBE | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7961 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| ADS7961SDBTR | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7961 |
| ADS7961SDBTR.A | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7961 |
| ADS7961SDBTR.B | Active | Production | TSSOP (DBT) 38 | 2000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | ADS7961 |
| ADS7961SRHBR | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBR.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBR.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBRG4 | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBRG4.A | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBRG4.B | Active | Production | VQFN (RHB) 32 | 3000 LARGE T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBT | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBT.A | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |
| ADS7961SRHBT.B | Active | Production | VQFN (RHB) 32 | 250 SMALL T&R | Yes | NIPDAU | Level-3-260C-168 HR | -40 to 125 | ADS 7961 |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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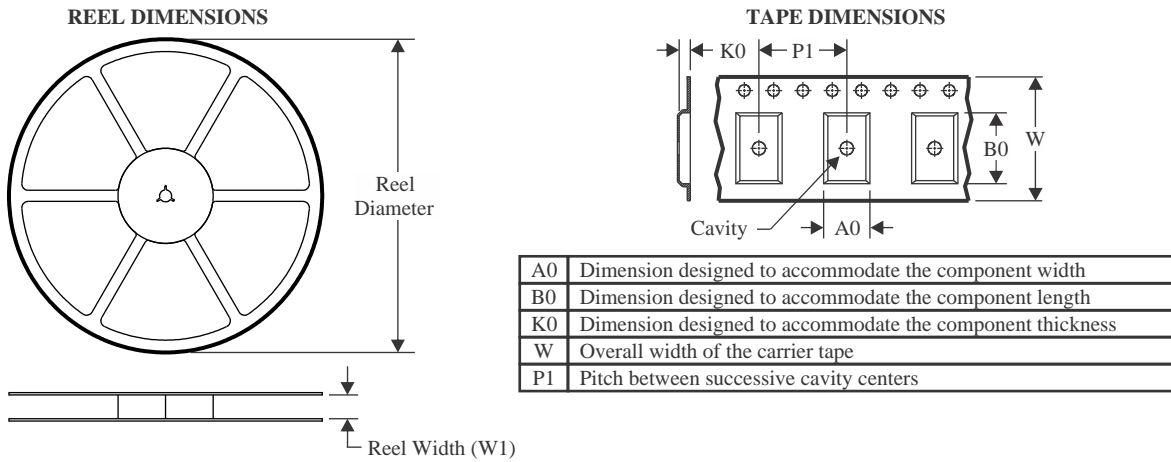
OTHER QUALIFIED VERSIONS OF ADS7950, ADS7951, ADS7952, ADS7953, ADS7954, ADS7955, ADS7956, ADS7957, ADS7958, ADS7959, ADS7960, ADS7961 :

- Automotive : [ADS7950-Q1](#), [ADS7951-Q1](#), [ADS7952-Q1](#), [ADS7953-Q1](#), [ADS7954-Q1](#), [ADS7955-Q1](#), [ADS7956-Q1](#), [ADS7957-Q1](#), [ADS7958-Q1](#), [ADS7959-Q1](#), [ADS7960-Q1](#), [ADS7961-Q1](#)

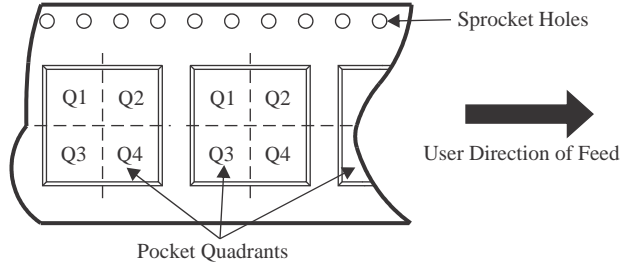
NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS7950SDBTTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7950SBRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7950SBRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7950SDBTTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7951SDBTTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7951SBRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7951SBRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7951SDBTTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7951SRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7951SRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7952SDBTTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7952SDBTRG4 | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7952SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7952SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7952SDBTTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7952SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |



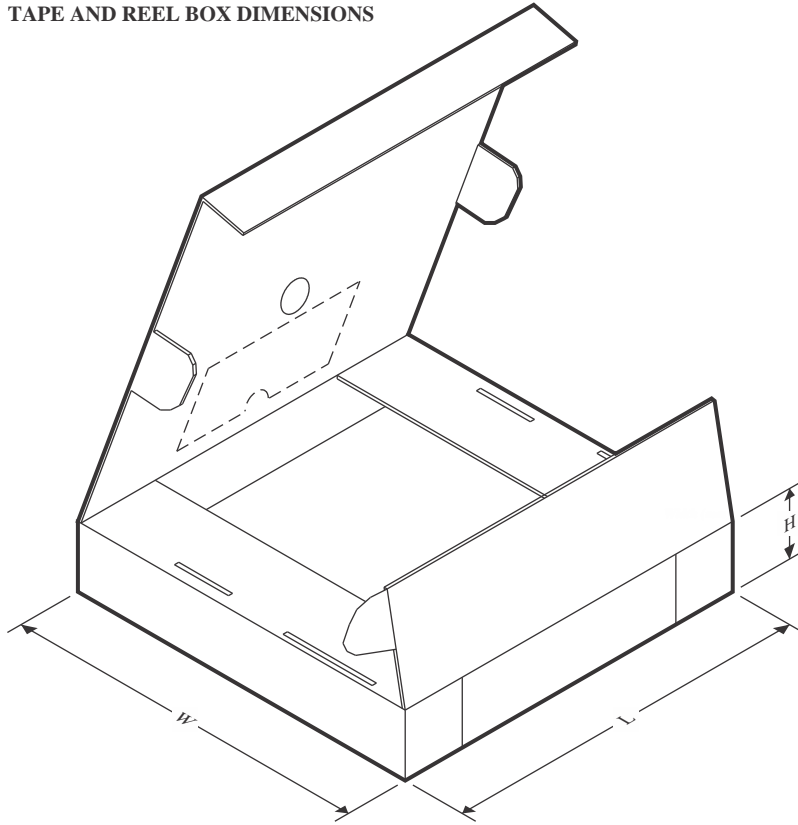
PACKAGE MATERIALS INFORMATION

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| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS7952SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7953SDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7953SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7953SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7953SDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7953SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7953SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7954SDBTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7954SRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7954SRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7955SDBTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7955SRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7955SRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7956SDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7956SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7956SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7956SRHBTG4 | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7957SDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7957SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7957SRHBRG4 | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7957SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7958SDBTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7958SRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7958SRGERG4 | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7958SRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7959SDBTR | TSSOP | DBT | 30 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS7959SRGER | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7959SRGET | VQFN | RGE | 24 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS7960SDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7960SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7960SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7961SDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.75 | 10.1 | 1.8 | 12.0 | 16.0 | Q1 |
| ADS7961SRHBR | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7961SRHBRG4 | VQFN | RHB | 32 | 3000 | 330.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |
| ADS7961SRHBT | VQFN | RHB | 32 | 250 | 180.0 | 12.4 | 5.3 | 5.3 | 1.5 | 8.0 | 12.0 | Q2 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS7950SBDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7950SBRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7950SBRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7950SDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7951SBDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7951SBRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7951SBRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7951SDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7951SRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7951SRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7952SBDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7952SBDBTRG4 | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7952SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7952SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7952SDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7952SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7952SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7953SBDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |



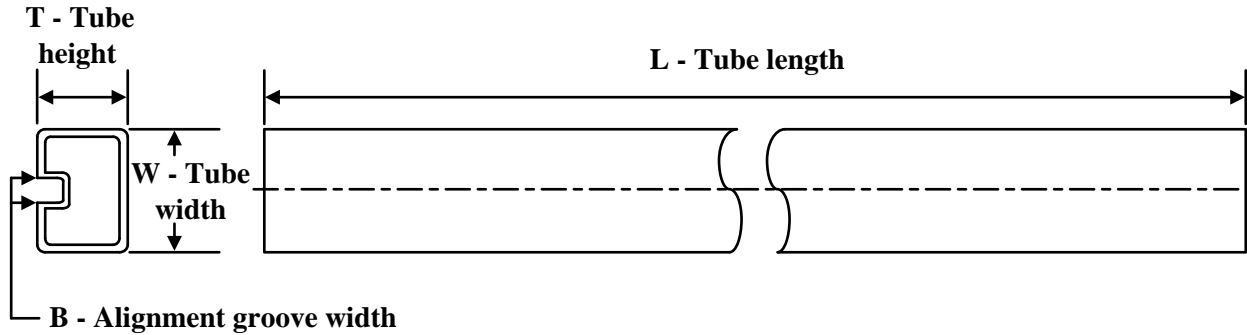
PACKAGE MATERIALS INFORMATION

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9-Oct-2025

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS7953SBRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7953SBRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7953SDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7953SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7953SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7954SDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7954SRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7954SRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7955SDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7955SRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7955SRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7956SDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7956SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7956SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7956SRHBTG4 | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7957SDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7957SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7957SRHBRG4 | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7957SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7958SDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7958SRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7958SRGERG4 | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7958SRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7959SDBTR | TSSOP | DBT | 30 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7959SRGER | VQFN | RGE | 24 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7959SRGET | VQFN | RGE | 24 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7960SDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7960SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7960SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |
| ADS7961SDBTR | TSSOP | DBT | 38 | 2000 | 353.0 | 353.0 | 32.0 |
| ADS7961SRHBR | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7961SRHBRG4 | VQFN | RHB | 32 | 3000 | 353.0 | 353.0 | 32.0 |
| ADS7961SRHBT | VQFN | RHB | 32 | 250 | 213.0 | 191.0 | 35.0 |

TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| ADS7950SBDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7950SBDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7950SBDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7950SDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7950SDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7950SDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SBDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SBDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SBDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7951SDBTG4 | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SBDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SBDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SBDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SBDBTG4 | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7952SDBTG4 | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7953SBDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7953SBDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7953SBDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7953SDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7953SDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7953SDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7954SDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7954SDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |



PACKAGE MATERIALS INFORMATION

www.ti.com

9-Oct-2025

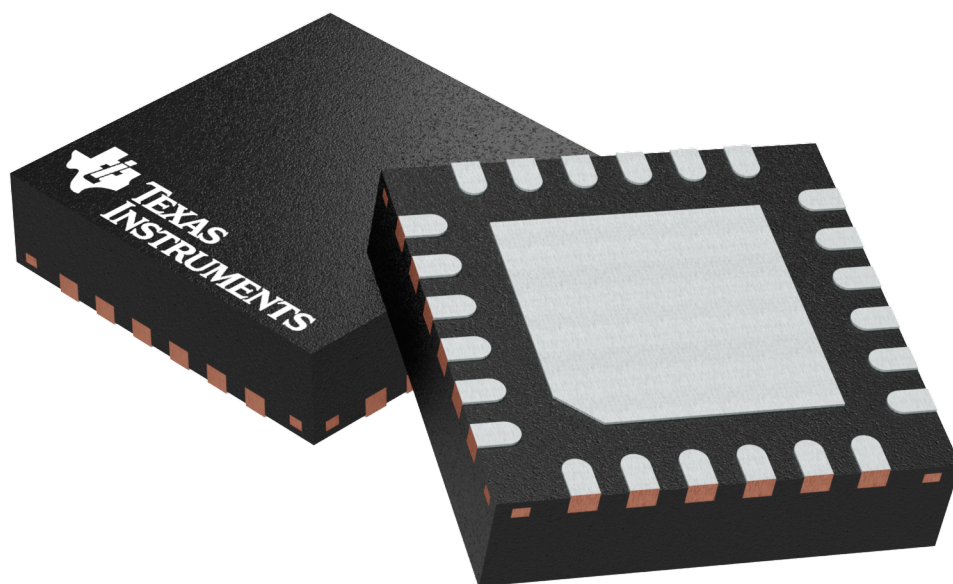
| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| ADS7954SDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7955SDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7955SDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7955SDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7956SDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7956SDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7956SDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7956SDBTG4 | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7956SDBTG4.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7956SDBTG4.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7957SDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7957SDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7957SDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7957SDBTG4 | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7957SDBTG4.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7957SDBTG4.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7958SDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7958SDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7958SDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7959SDBT | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7959SDBT.A | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7959SDBT.B | DBT | TSSOP | 30 | 60 | 530 | 10.2 | 3600 | 3.5 |
| ADS7960SDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7960SDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7960SDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7960SDBTG4 | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7960SDBTG4.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7960SDBTG4.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7961SDBT | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7961SDBT.A | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |
| ADS7961SDBT.B | DBT | TSSOP | 38 | 50 | 530 | 10.2 | 3600 | 3.5 |

GENERIC PACKAGE VIEW

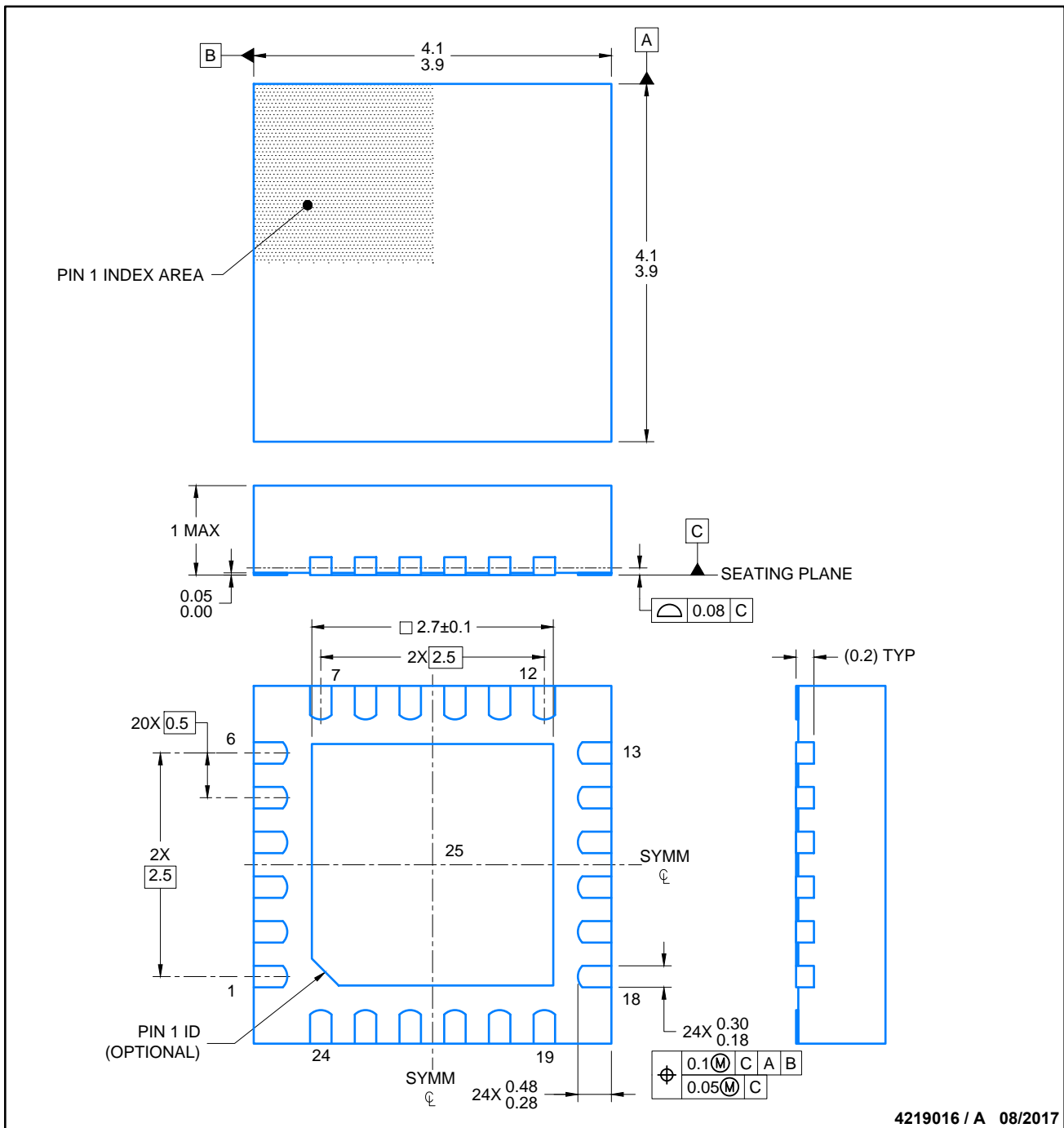
RGE 24

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

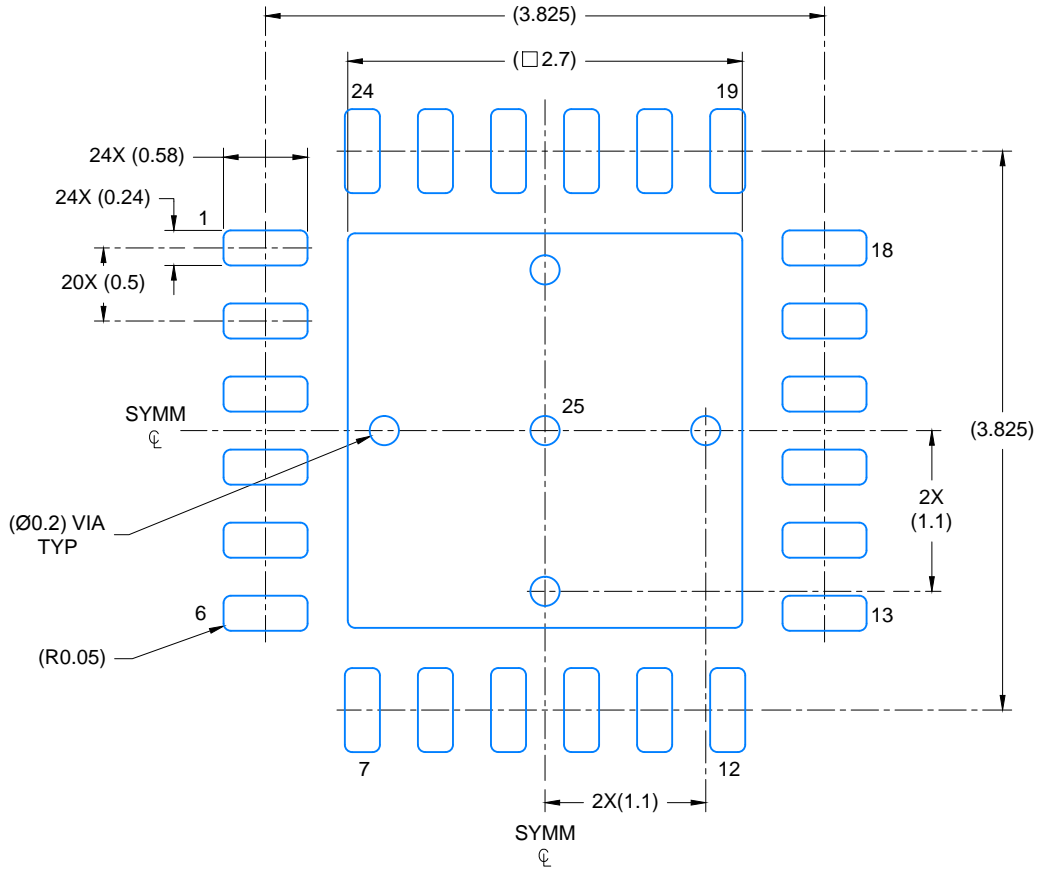


Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

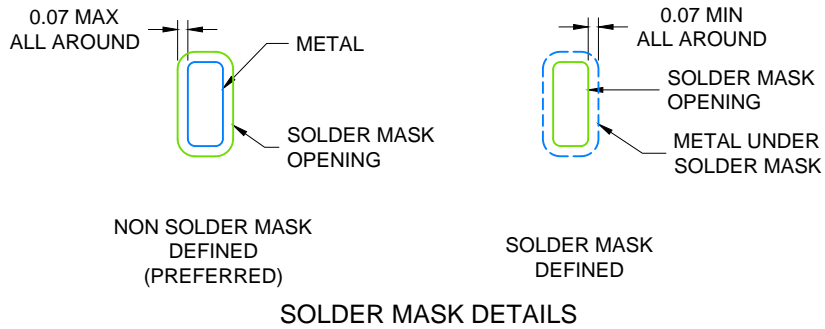


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



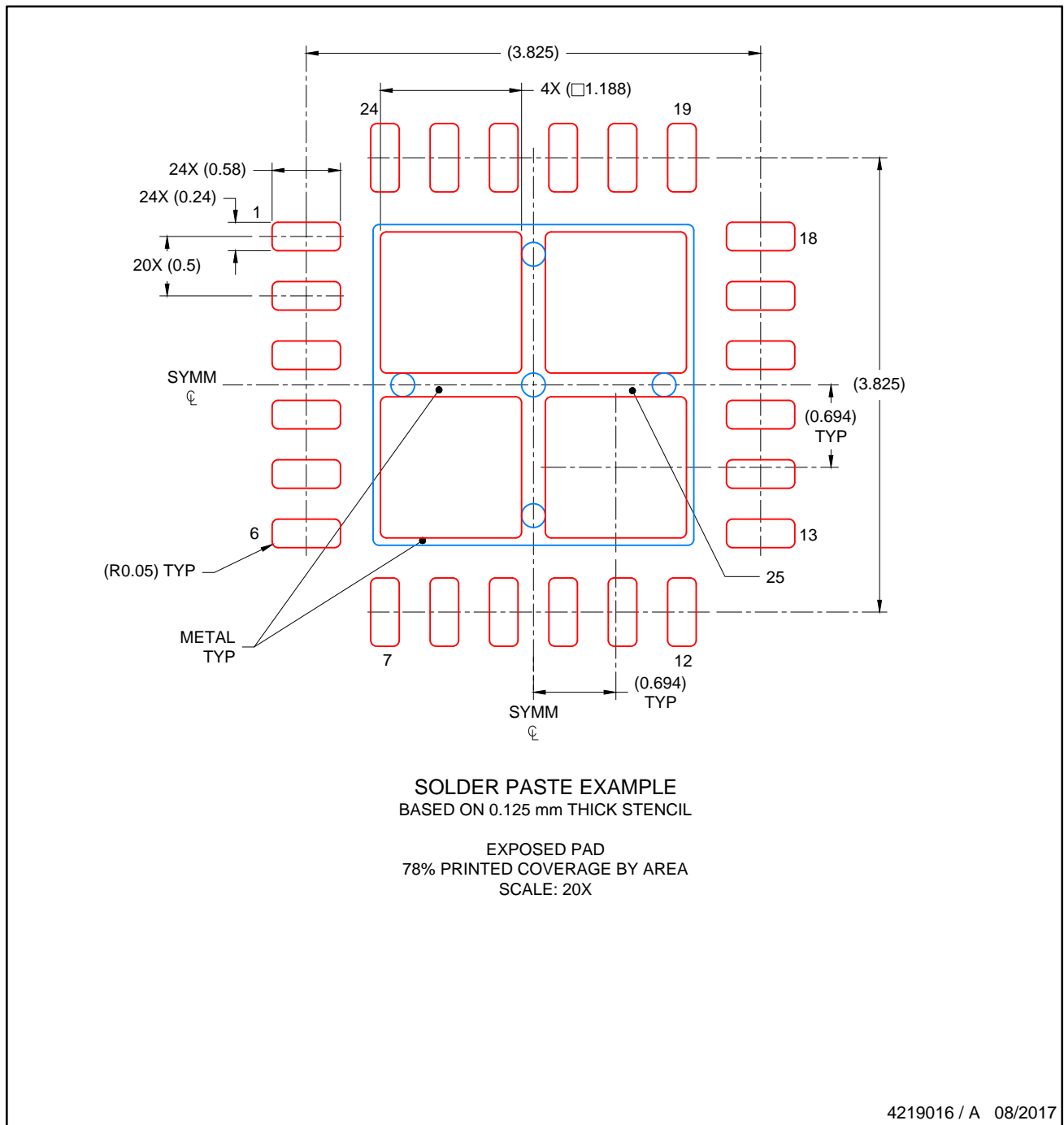
LAND PATTERN EXAMPLE
SCALE: 20X



4219016 / A 08/2017

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations..

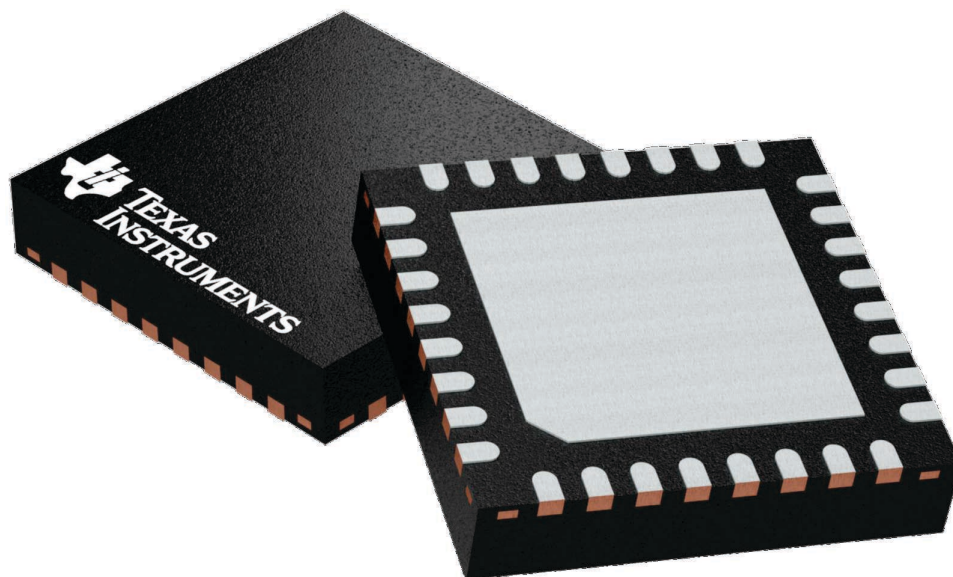
GENERIC PACKAGE VIEW

RHB 32

VQFN - 1 mm max height

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

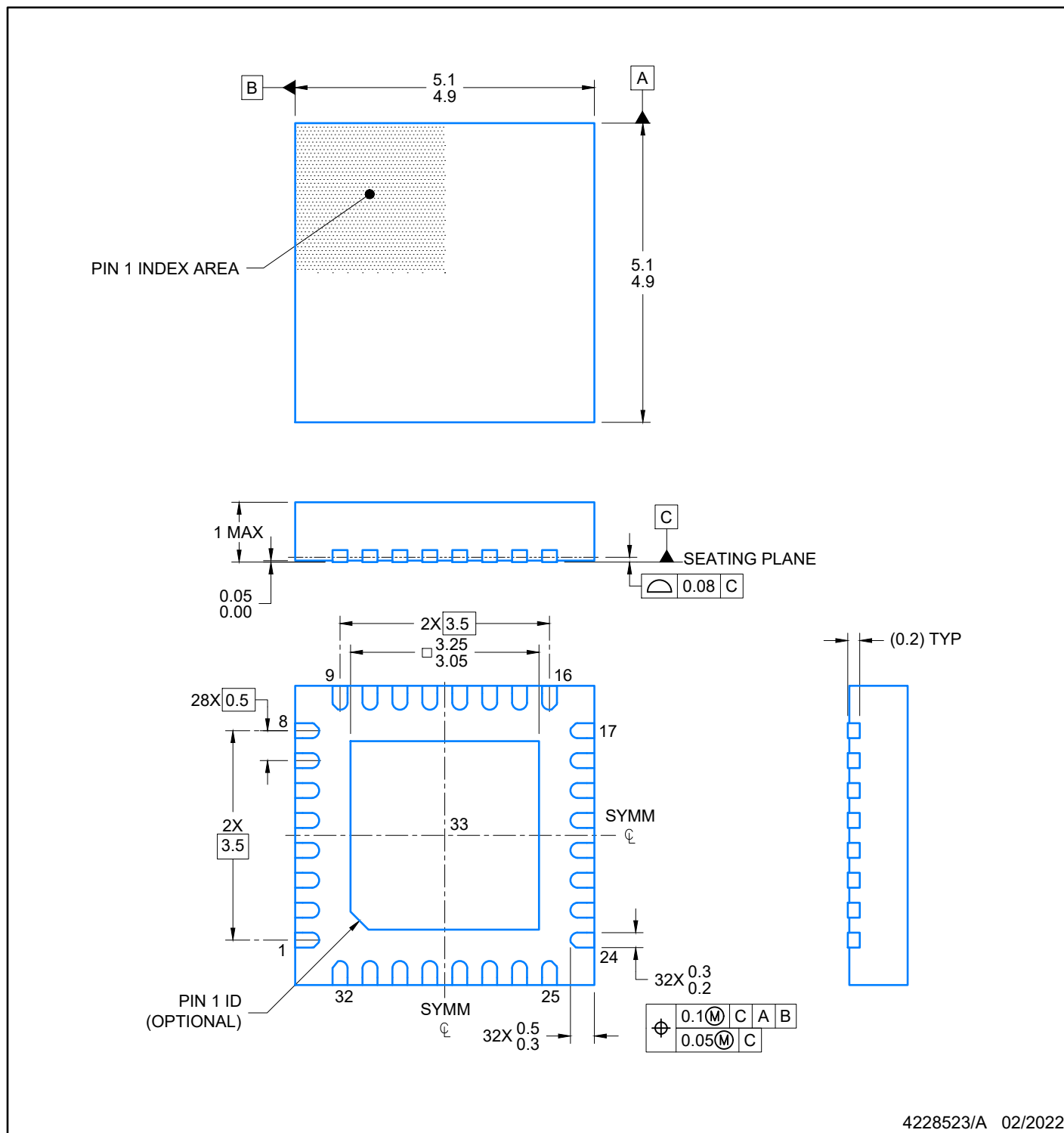


Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

RHB0032D

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK-NO LEAD



4228523/A 02/2022

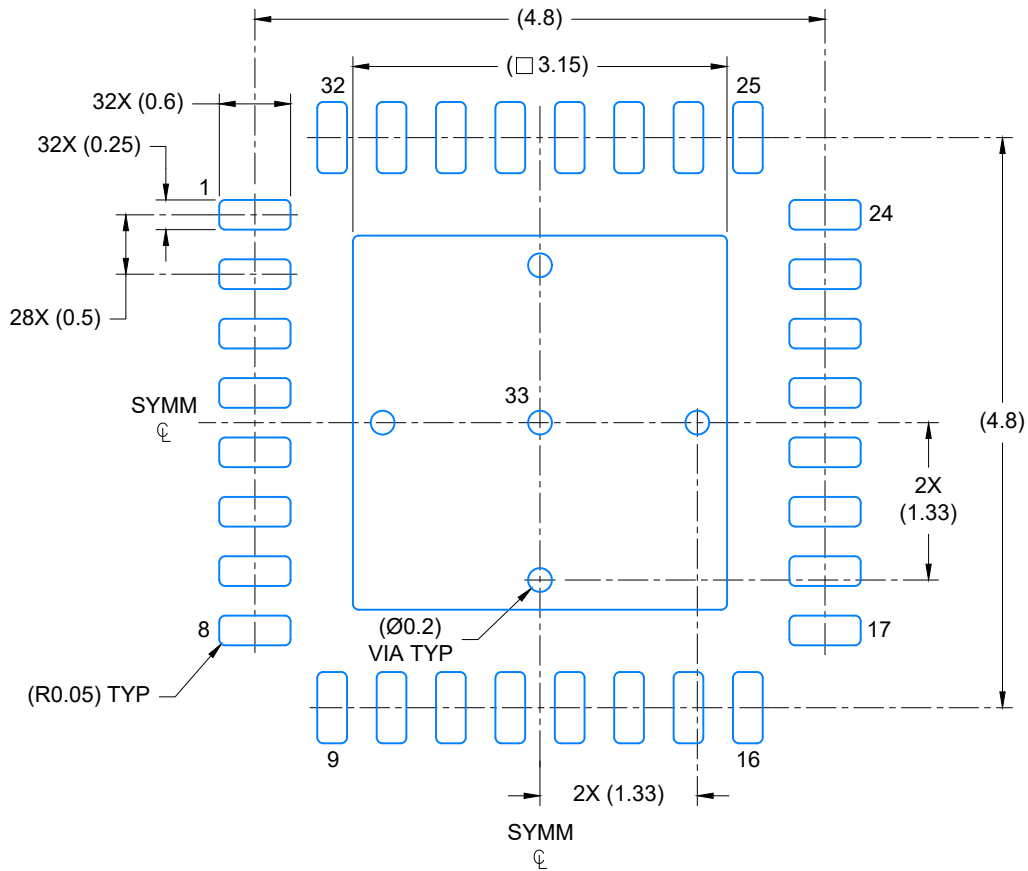
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

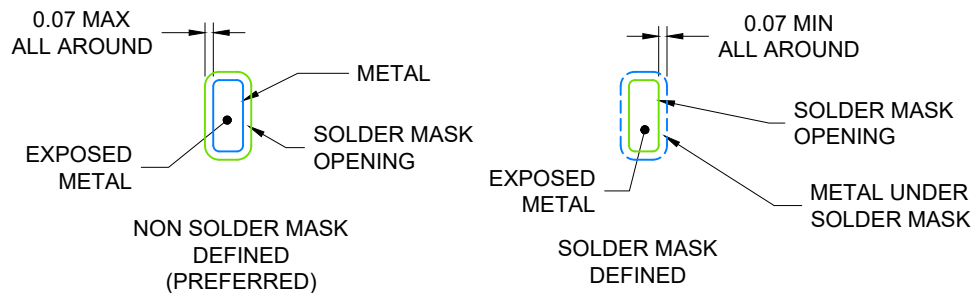
RHB0032D

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK-NO LEAD



LAND PATTERN EXAMPLE
 EXPOSED METAL SHOWN
 SCALE: 15X



SOLDER MASK DETAILS

4228523/A 02/2022

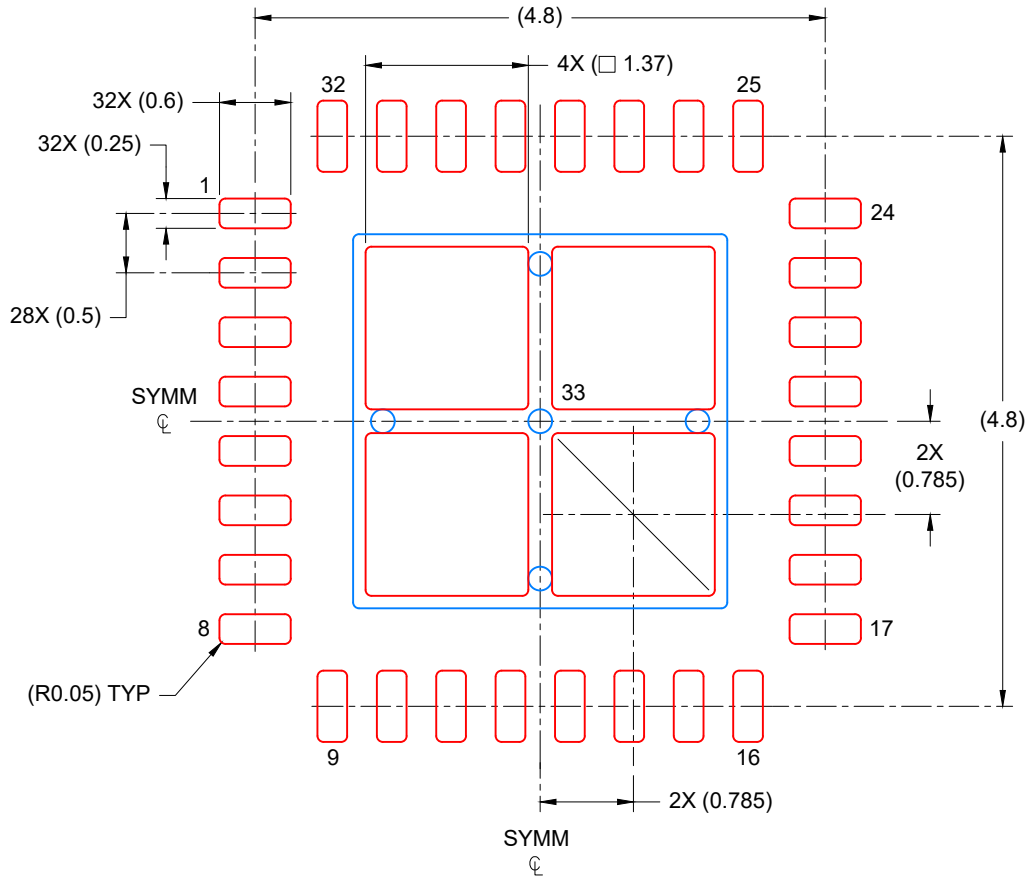
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sl原因271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

RHB0032D

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK-NO LEAD



SOLDER PASTE EXAMPLE
 BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD
 75% PRINTED COVERAGE BY AREA
 SCALE: 15X

4228523/A 02/2022

NOTES: (continued)

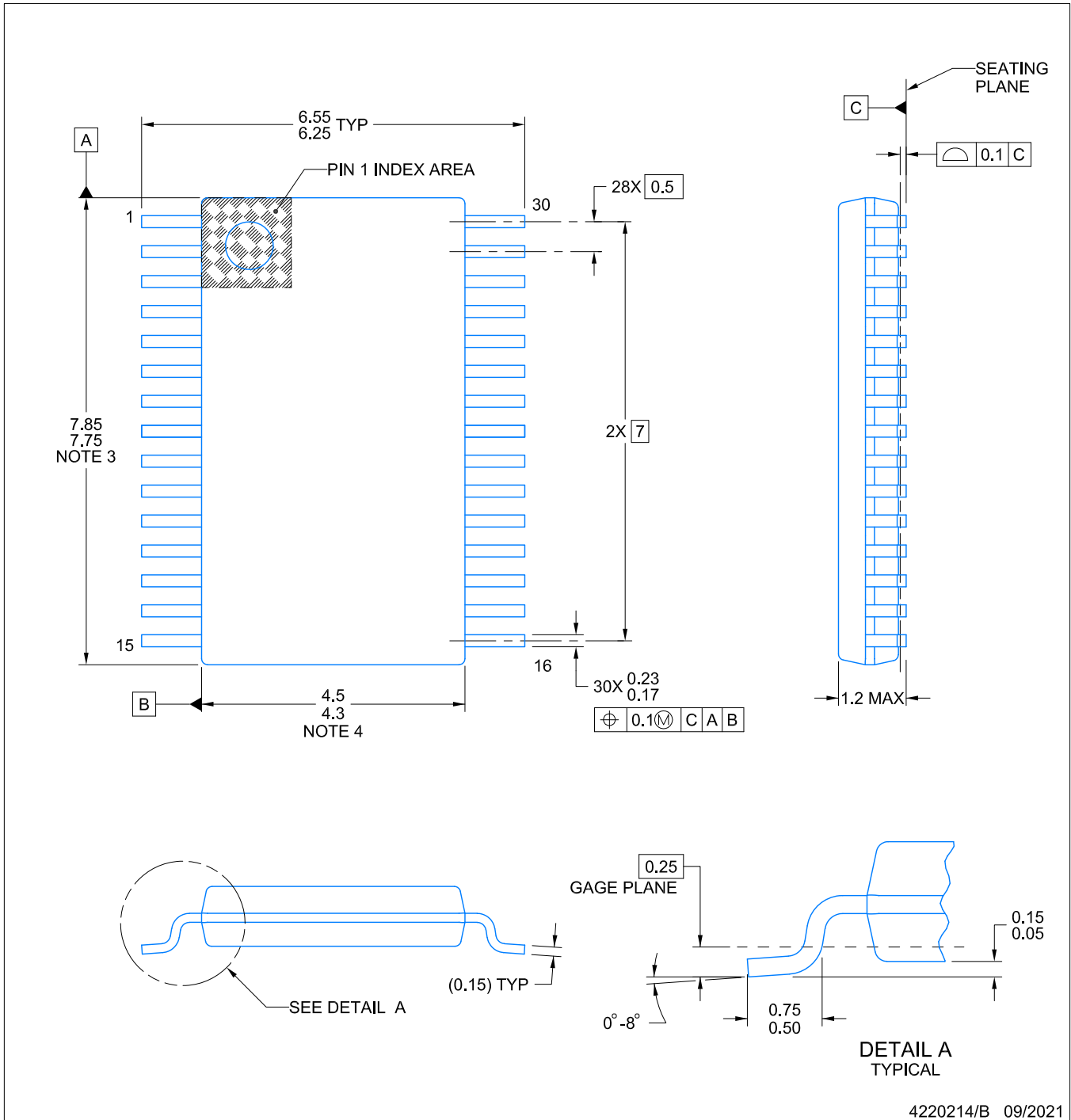
- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

PACKAGE OUTLINE

DBT0030A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



4220214/B 09/2021

NOTES:

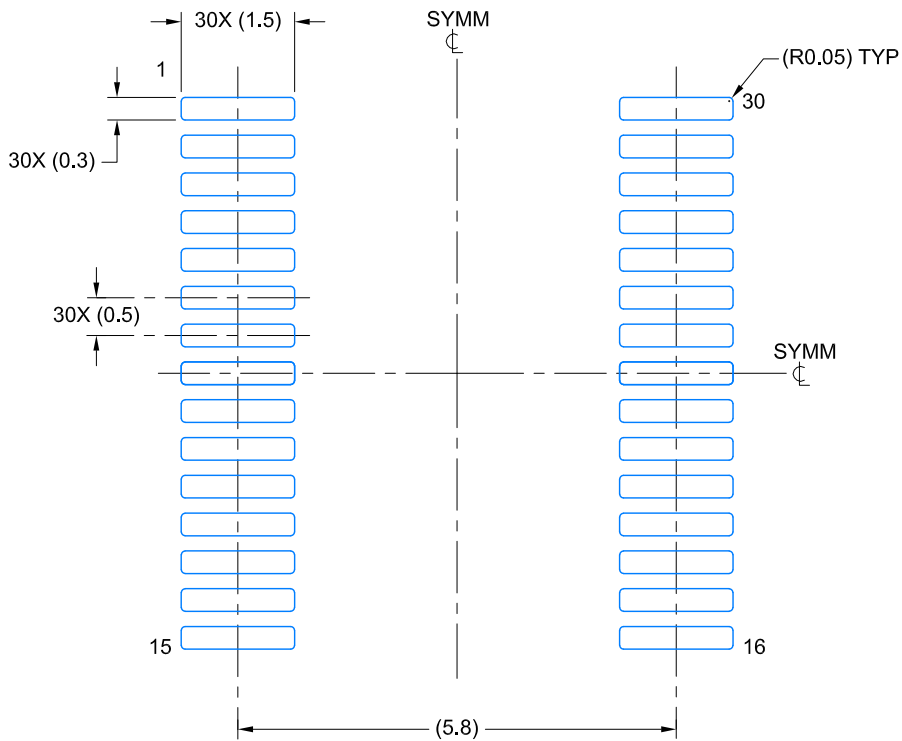
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

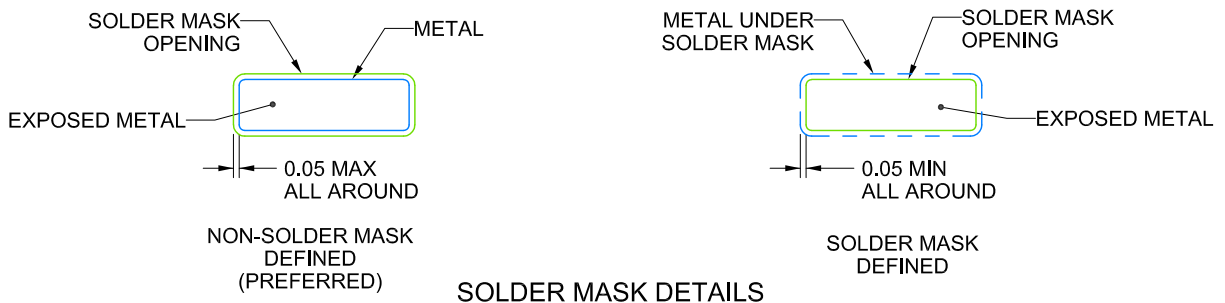
DBT0030A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



SOLDER MASK DETAILS

4220214/B 09/2021

NOTES: (continued)

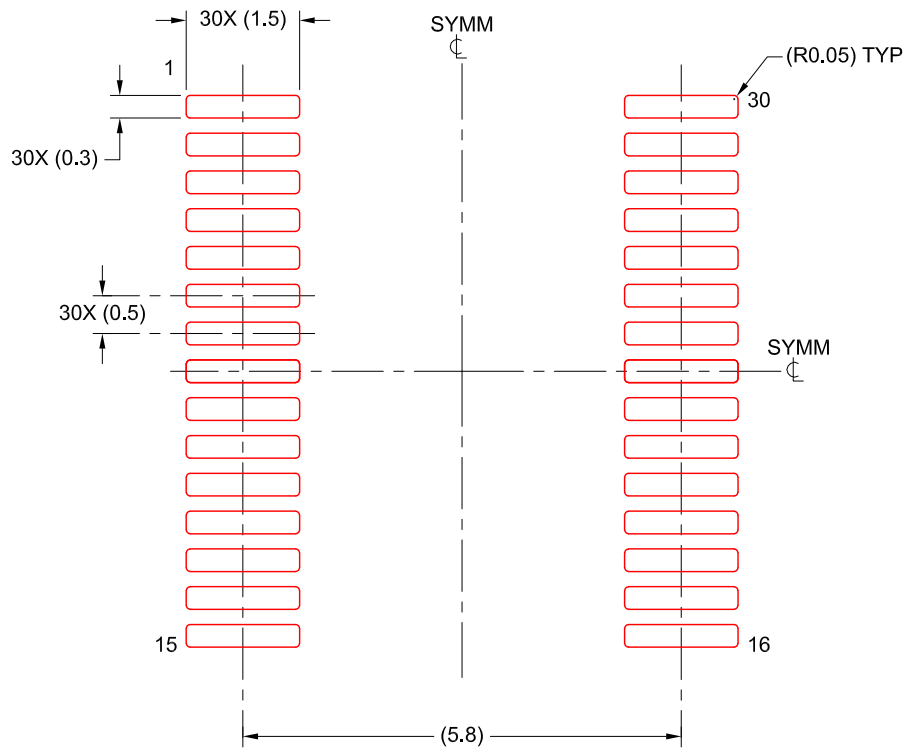
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBT0030A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
 BASED ON 0.125 mm THICK STENCIL
 SCALE: 10X

4220214/B 09/2021

NOTES: (continued)

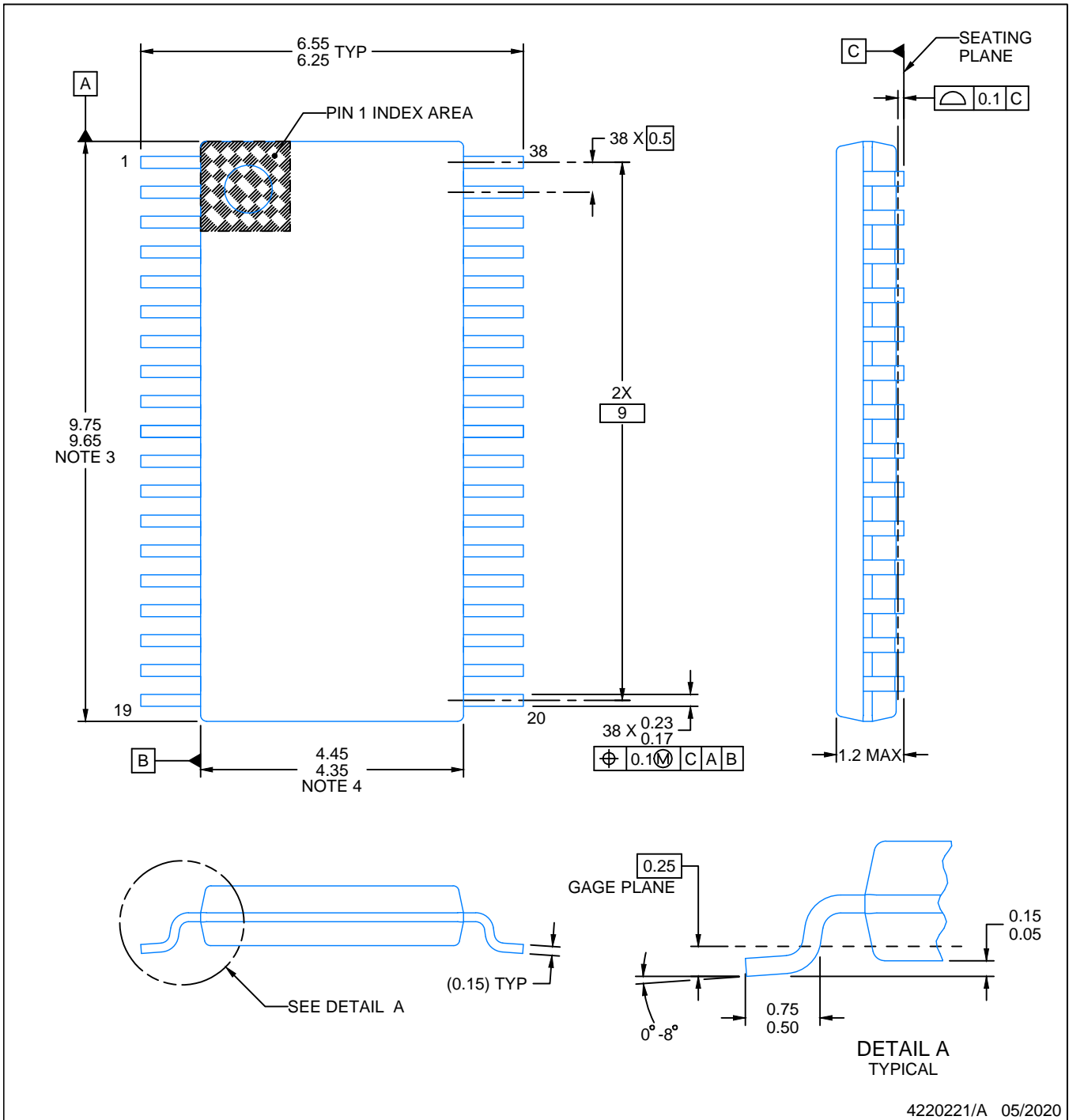
- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

PACKAGE OUTLINE

DBT0038A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



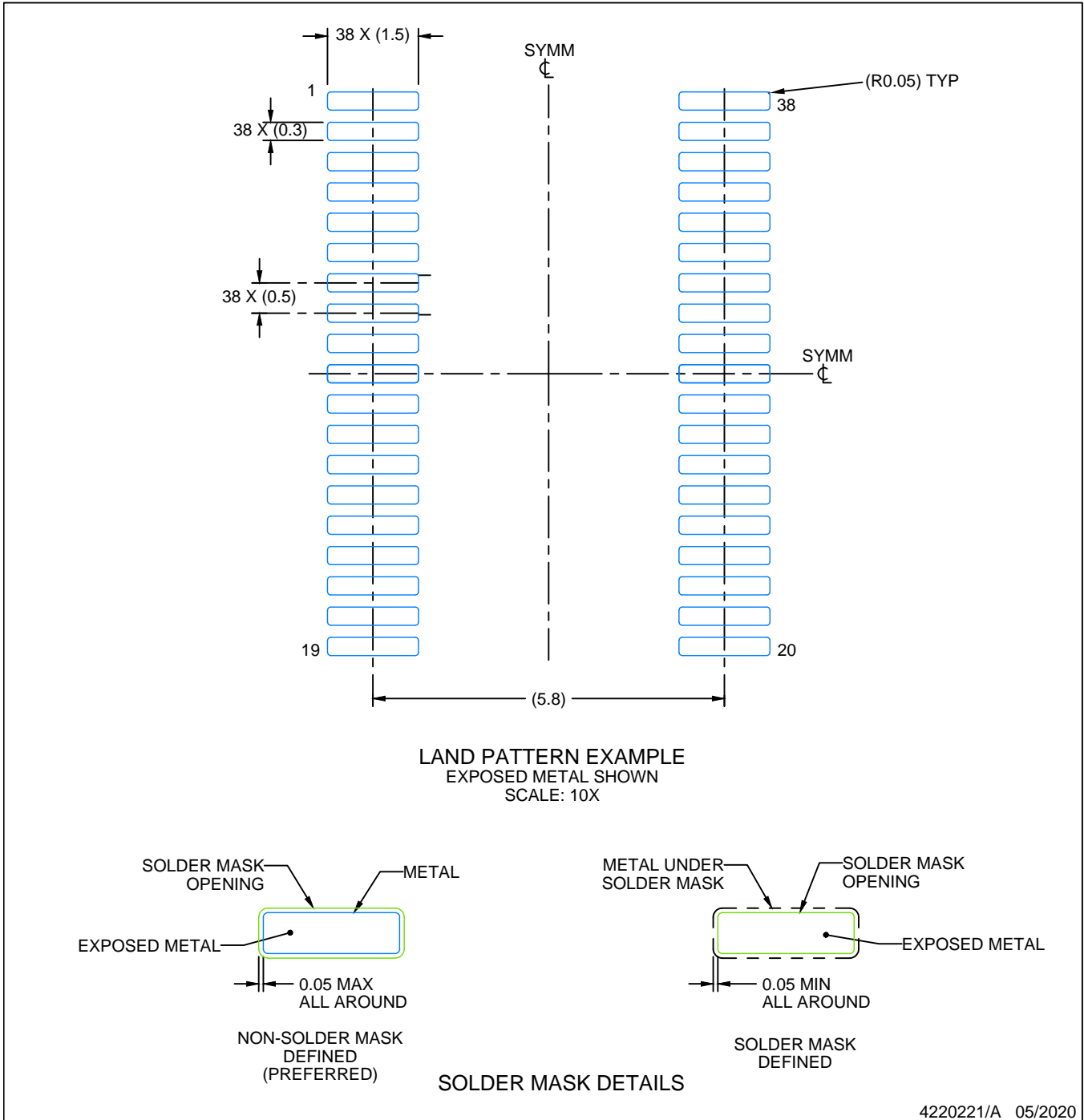
4220221/A 05/2020

EXAMPLE BOARD LAYOUT

DBT0038A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



4220221/A 05/2020

NOTES: (continued)

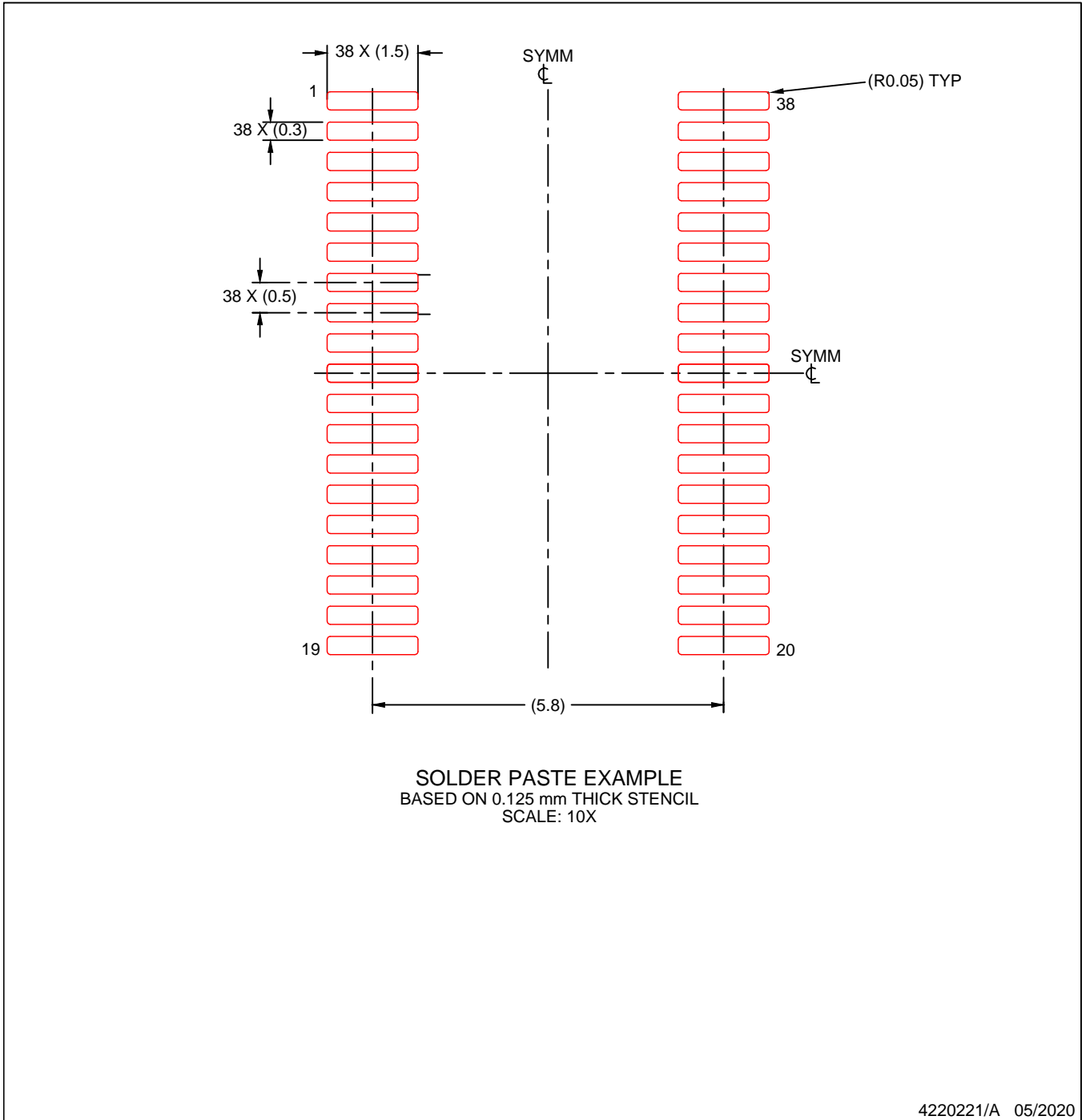
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBT0038A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.

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Last updated 10/2025

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